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# VEX / ASPERA-4 **INSTRUMENT MANUAL**

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## **CHANGE RECORD**

Version Date		Date	Changed Paragraphs	Remarks
Issue	Rev			
1	0	2006-04-02	All	New document
1	1	2006-06-17	Appendix 9 and 10	Two appendixes added







# **1 INTRODUCTION**

The document provides the information on the ASPERA-4 experiment (Analyzer of Space Plasma and Energetic Atoms) on the ESA Venus Express mission necessary for the data archiving.

# **2** DOCUMENT STRUCTURE AND REFERENCES

The document consists of the reference part and Appendixes. The appendixes contain the documents referred in the reference part. The list of provided documents, references to Appendixes, and respective references are given in Table 1.

Section	Appendix No.	Reference	
Team structure	1	VE-ASP-TN-020312, Issue 1.3	
ASPERA-4 instrument description	2	N/A	
ASPERA-4 scanner	3	N/A	
Main Unit TM / TC description	4	VE-ASP-MA-0005, Issue 1.0	
NPD raw data structure	5	NPD_description1_0	
HK channel conversion factors	6	N/A	
ASPERA-4 sensor numbering	7	N/A	
ASPERA-4 calibration report	8	VE-ASP-CR-050530, Issue 1.1	
IMA TM / TC description	9	ICA-IMA-VIA TC/TM data	
		formats and related software aspects	
		Issue 1.8, 2004-10-28	
IMA: conversion to physics units	10	Venus Express ASPERA-4 IMA	
(IMA "bible")		BIBLE V.1.0 January 26, 2006	





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# **APPENDIX 1. TEAM STRUCTURE**





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# VEX ASPERA-4 TEAM STRUCTURE

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Issue 1, Rev 0	2003-02-12	All	New document
Issue 1, Rev 1	2003-02-27	3	Team responsibilities extended
Issue 1, Rev. 2	2003-03-04	All	Prof Baumjohann och Dr. Zhang added to Co-I list
Issue 1, Rev. 3	2003-03-05	4	A. Muro, A. Milillo, M. Maggi are added to address list





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S. Barabash (PI),	Swedish Institute of	PI institute
H. Andersson (EM),	Space Physics, Kiruna,	Sensors subsystems:
R. Lundin,	Sweden	NPI - entire sensor
M. Yamauchi,		NPD – development, integration, tests
M. Holmström,		IMA sensor: mechanics, integration, HV supply
A. Grigoriev		IMA DPU – mechanics, sensor interface, s/w
		MU HV board – design and manufacturing
		MU DPU – mechanics
		Scanner – design, manufacturing, tests
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# APPENDIX 2. ASPERA-4 INSTRUMENT DESCRIPTION

### I. THE SCIENCE

### A. Scientific objectives for plasma measurements at Venus

Venus, Earth and Mars, the three largest terrestrial planets, have undergone much different thermal and atmospheric evolution. Mars has evolved rapidly. Initially, we now believe, Mars had a strong internally driven magnetic shield over an atmosphere much denser than present, one possibly supporting rain and flowing water on the surface. But the interior cooled rapidly, the dynamo stopped and much of the atmosphere escaped (Acuña et al., 1998; Schubert et al., 2000). Earth in contrast still has its magnetic field, a substantial atmosphere and abundant water. Venus may be the least evolved of the three planets. A thick crust has kept the interior hot but at the same time stifled the heat flow needed to drive convection in the fluid iron core. Thus Venus has no magnetic shield against the solar wind and perhaps never had (Russell et al., 1980). Venus has a very dense atmosphere but very little water. Clearly the Venus atmosphere has evolved greatly since the planet accreted, yet still much atmosphere remains. Possibly the escape mechanism is very selective favouring the escape of water, or perhaps hydrogen, leaving the oxygen to combine with the soil. We do not know because no mission to Venus was instrumented to address this objective. Therefore, the main scientific objective of the ASPERA-4 (Analyzer of Space Plasmas and Energetic Atoms) experiment is to study solar wind induced atmospheric escape. The specific scientific questions to be addressed are:

- How is the Venus atmosphere coupled with the solar wind? How is mass added to and removed from the atmosphere due to this coupling?
- What is the structure of the interaction region?
- The previous question is connected to the issue of "where did the water go?" The early atmosphere must have contained water equivalent to a few metres deep global ocean as follows from the H/D ratio consideration (*Donahue and Hartle*, 1992). Could the solar wind interaction have contributed to the water escape (mainly increasing H escape)? Is the process the same as for the water escape from Mars?
- What is the mass composition of the escaping plasma? To what degree are the outflow processes mass dependent, and can this explain the Venus loss of water and greenhouse effect?

- What is the neutral-plasma interaction on Venus? How does the presence of the neutral gas affect plasma dynamics?
- What are similarities and differences in the solar wind interaction with the other terrestrial planets, Earth and Mars?

None of the previous missions to Venus covered such a wide range of scientific objectives. The other uniqueness of the instrument is that ASPERA-4 is a replica of the ASPERA-3 experiment orbiting Mars on board the ESA Mars Express mission (*Barabash et al.*, 2004). Combination of the observations made by two identical instruments at two non-magnetised planets exhibiting the similar type of the solar wind interaction but differing significantly in terms of interplanetary conditions, atmospheric characteristics, and size and mass opens completely new perspective for comparative magnetospheric studies.

### **B.** Required measurements

In order to study the escape of the present day Venus atmosphere one must measure the incident solar wind flux, and the escaping ions whose thermal and bulk velocities will range from about 10 to 1000 km s<sup>-1</sup>, depending on the mechanism at work. Since  $O_2^+$  ions dissociatively recombine forming a hot oxygen corona out to 4000 km altitude, oxygen ions will be picked up in the solar wind as well as accelerated down the wake or tail of Venus on the night side. Charge exchange between the solar wind and the neutral Venus atmosphere should be an important process because of the Venus dense upper atmosphere. Thus energetic neutral atoms (ENA) (Gunell et al., 2005c) and, possibly X-rays (Holmström et al., 2001) will be generated. This opens up the possibility to image the interaction region in order to obtained instantaneous images of the global distribution of the solar wind and planetary plasmas and qualify the instantaneous escape induced by the solar wind. These measurements should be designed to detect both hydrogen and oxygen atoms at velocities near 400 km s<sup>-1</sup>. Estimates of the ion loss rate are around  $10^{24}$  ions/s (*Moore et al.*, 1991). Ion and ENA measurements should be supported by the electron measurements to characterised the local plasma conditions and identify the main plasma domains. Therefore, the ASPERA-4 experiment includes four sensors: the Electron Spectrometer (ELS); the Ion Mass Analyzer (IMA); the Neutral Particle Imager (NPI); and the Neutral Particle detector (NPD).

In order to characterise the environment of the picked up ions and understand the mechanism

involved in their acceleration the magnetic field must be measured. The ambient magnetic field encountered will range from about 1 nT to 200 nT and typically range from 10 nT to 30 nT. Since some spacecraft magnetic field will be present, a range of up to 1000 nT is recommended with gradiometer sensors along a modest (0.5 m) boom with monitoring of current levels of critical sources of stray magnetic fields. The magnetometer MAG (Venus Express Magnetometer) is included in the Venus Express payload (*Zhang et al.*, 2005).

### C. The Solar Wind - Atmosphere Interaction

Near-Venus space is strikingly different from Earth-space because of the absence of a substantial intrinsic magnetic field of Venus. Without the magnetic cavity of a magnetosphere to shield the upper atmosphere from the on-coming solar wind, Venus is subject to comet-like atmosphere erosion processes and solar-wind-induced current systems that have no terrestrial counterparts. From experience gained in orbit around Venus on the Pioneer Venus Orbiter (PVO), we have developed ideas of how the upper atmosphere and solar wind interact and the consequences for the planet. In particular, we have observed that the scavenging of planetary ions removes heavy constituents such as oxygen, which plays an important role in the atmosphere's hydration and surface oxidation history. A cartoon showing some of the relevant processes can be found in Fig. 1.

The current atmospheric conditions on Venus indicate that water is present in only trace amounts ( $\sim$  a few precipitable micrometres), much less than expected if Venus' early atmosphere was Earth-like. In contrast to the Martian water story (*McKay and Stoker*, 1989) it is unlikely to be frozen and buried or sequestered in polar ice caps. Thus the alternative of escape to space in the form of water's constituents is most likely. It is relatively easy to lose light hydrogen, but oxygen loss is problematic. Small amounts can escape via the production of a hot atomic oxygen corona from ionospheric photochemistry (*Nagy et al.*, 1981), but the bulk of the O<sub>2</sub> and O are gravitationally bound. Independent analyses of surface oxidation on the planet indicates that most of the oxygen left over from photo-dissociation over the history of Venus did not become incorporated into the exposed rocks and soil. What could produce such an effective oxygen escape mechanism? Could the processes associated with the solar-wind interaction account for the escape of sufficient quantities of oxygen to have made an Earth-like water budget for Venus ~ 4 Gyr ago?

ASPERA-4 includes four sensors: NPI, NPD, IMA, and ELS each of which contributes, both alone and in combination, to understanding the different consequences of direct solar wind inter-



FIG. 1 Cartoon of the Venus solar-wind interaction, highlighting the atmosphere escape processes related to the generation of  $O^+$  pickup ions. Solar radiation ionises the Venus atmosphere producing an ionosphere whose thermal pressure is sufficient to standoff the solar wind flow bounding the ionosphere with an ionopause. The deflection of the supersonic solar wind leads to the formation of a bow shock. The hydrogen and hot oxygen exospheres extend into the shocked solar wind of the magnetosheath where they are photoionised and impact ionised and picked up in cycloidal trajectories gyrating around the magnetic field out of the page here.

action with a planetary atmosphere/ionosphere. Because Venus does not have the complication of the Martian remanent magnetic fields, and has the initial comprehensive reconnaissance provided by PVO, the ASPERA-4 measurements that fill in the knowledge gaps left by PVO will make progress in our understanding far exceeding its own coverage of the Venus solar wind interaction physics. In particular, the IMA puts a definitive composition label on the atmospheric pickup ions produced at Venus and detect them over a much greater (up to 36 keV as opposed to PVO's  $\sim 8$  keV) energy range. The ELS measures both low energy escaping plasma and high energy electrons that contribute to the ion production through electron impact ionisation. The ENAs detected by NPD and NPI provides a measure of solar wind energy deposited in the atmosphere that cannot be estimated from the plasma and field measurements alone, as described below.

A combination of PVO results led to our current picture of atmospheric oxygen escape from

Venus, reproduced in Fig. 1. The UV spectrometer (Stewart, 1980) confirmed the existence of an atomic oxygen upper atmosphere extending well into the magnetosheath. This hot O "corona" was shown by Nagy et al. (1981) to agree with models of photochemical exospheres produced by dissociative recombination in the  $O_2^+$  ionosphere. Combined magnetometer (*Russell et al.*, 1980) and plasma analyser (Intriligator et al., 1980; Mihalov et al., 1980) measurements were then used to construct a scenario of both direct  $O^+$  pickup ion escape (*Moore et al.*, 1990) and additional sputtering of O from the atmosphere by impacting O<sup>+</sup> pickup ions not on direct escape trajectories (Luhmann and Kozyra, 1991). The pickup ions can be created by any ionisation mechanism - photoionisation, solar wind electron impact, or charge exchange with solar wind protons, in all atmospheric regions above the exobase ( $\sim 200$  km altitude) penetrated by the solar wind convection electric field. There are also suggestions of other possible ion removal processes in the thermal plasma (below a few eV) energy range at work at the ionopause boundary layer (Brace et al., 1982) and in the low altitude wake (Hartle and Grebowsky, 1990), distinct from the pickup ion-related mechanisms, which we do not discuss here. In any case, the limited capabilities of the PVO instruments for measuring both solar wind electrons and magnetosheath protons (where the upper atmosphere penetration occurs), as well as solid identification of the pickup ions composition, made it difficult to quantify the details of the escape scenario in Fig. 1. The ASPERA-4 IMA, with the added magnetometer MAG, on Venus Express should finally allow the evaluation of escape rates for oxygen ions as well as other species, their variation with interplanetary conditions, and their implications for related sputtering losses.

Another problem of the solar wind - atmosphere coupling that has not been explored experimentally concerns the energetic consequences for the Venusian atmosphere of the lack of a planetary dipole field of any importance. Kinetic and test-particle models of the Mars-solar wind interaction (*Brecht*, 1997; *Kallio et al.*, 1997) suggest that solar wind absorption by the Martian atmosphere may be an important energy source for the upper atmosphere at that planet. However, at Venus the much smaller relative solar wind proton gyroradii greatly limit the numbers of protons that can reach the exobase which is well below the ionopause ( $\sim 200$  km exobase altitude compared to  $\sim 300$  km ionopause altitude. A solar wind proton gyroradius in the inner magnetosheath is typically  $\sim 10$  km). ENA production in the magnetosheath by charge exchange between solar wind protons and the exosphere/thermosphere near the solar wind/ionosphere boundary decouples the energetic neutralised protons from the magnetic field in the sheath, leaving them free to impact the exobase (e.g. *Kallio et al.* (1997)). The ENAs generated as a product of the solar - wind interaction can thus greatly enhance the deposition of solar wind energy into the upper atmosphere (*Kallio and Barabash*, 2000) and, at the same time, provide a means of "imaging" the solar wind interaction. *Fok et al.* (2004) and *Gunell et al.* (2005c) have modelled the ENA production at Venus using MHD simulations. The NPD will provide tests of the predicted fluxes and composition of the ENAs, while imaging these particles with NPI will show the spots or regions of the most intense ENA precipitation, and give information on their variation with solar wind conditions.

While the energy transfer associated with the ENA precipitation can be important, for the thermal structure of the upper atmosphere, it is the  $O^+$  pickup ion precipitation that causes significant sputtering-induced loss of the atmosphere. *Luhmann and Kozyra* (1991) estimated that  $O^+$  sputtering results in the escape of oxygen atoms from Venus at rates comparable to sputtering losses from the much smaller planet Mars (*Luhmann and Bauer*, 1992). Comparisons of ASPERA-3 results from Mars Express with ASPERA-4 results will provide an invaluable look at the processes and rates by which unmagnetised terrestrial planet atmospheres evolve due to their solar wind interactions.

### **D.** Pickup Ions at Venus

Observations of oxygen pickup ions by the plasma analyser on PVO sparked broad interest in solar wind erosion of unmagnetised planet atmospheres with its first-order picture of the spatial distribution and energies of  $O^+$  pickup ions. These results, collected during PVO's ~ 14 year, ~ 5000 orbit tour, provide an idea of what is to be expected from IMA measurements on Venus Express.

The PVO Plasma Analyzer (PV OPA) has been described in the literature a number of times (*Intriligator et al.*, 1980; *Mihalov and Barnes*, 1982; *Moore et al.*, 1990). Its key features included its ~ 8 keV/q energy per charge upper limit for detection and a directional sampling scheme, providing approximately  $15^{\circ}$  azimuthal and  $20^{\circ} - 30^{\circ}$  polar angle resolution with respect to the PVO spin axis. The time resolution for a full angle and energy scan was about 9 minutes, which gave only a few samples during each periapsis pass. Thus the best observations of pickup ions were generally obtained during apoapsis at about twelve planetary radii downstream. A sample of a spectrogram constructed from the PV OPA measurements during one orbit in which picked up ions were observed in the wake is shown in Fig. 2. O<sup>+</sup> ions are inferred to be present in the PV OPA energy scans when a second peak is visible at high E/q. The energy and angular coverage



FIG. 2 Sample Energy spectrogram obtained from the PV OPA plasma analyser data. The inferred  $O^+$  is seen as the higher energy peak coexisting with the main proton peak.

limitation implies that a significant amount of the O<sup>+</sup> present was not detected on PVO.

The energies and orbital locations of the oxygen peaks differ from orbit to orbit due to the variability of the solar wind and especially the cross-flow interplanetary magnetic field orientation. The cross-flow interplanetary field orientation creates changing asymmetries in the O<sup>+</sup> spatial distribution due to the large gyroradii of O<sup>+</sup> ions ( $\sim 0.5 - 1.0R_{\nu}$ ) relative to the size of the planet and the solar wind interaction region, as illustrated in Fig. 1. Because the direction of the interplanetary magnetic field is usually eastward or westward, the convection electric field  $\vec{E} = -\vec{v} \times \vec{B}$  (where  $\vec{v}$  is the solar wind plasma velocity and  $\vec{B}$  the local magnetic field) produces pickup ion trajectories that are initially either northward or southward as well as anti-sunward. If the ion trajectory does not intersect the exobase at a few hundred kilometres altitude, the trajectory continues down the wake, forming a one-sided ion stream. Thus near the planet terminator and in the near-planet wake, one typically observes O<sup>+</sup> detection locations organised into northern or southern spatial clusters (*Intriligator et al.*, 1979; *Moore et al.*, 1990).

The energies at which the inferred  $O^+$  ions were detected on PVO are compared with their accompanying proton peak energies in Fig. 3. Here, a zero proton peak energy identifies those inferred  $O^+$  detections not accompanied by a proton peak in the same spectrum. At 16 times the proton mass, co-moving  $O^+$  ions have 16 times the proton energies. The statistics suggest the detected  $O^+$  peaks are at roughly these energies up to the 8 keV limit of the PVO plasma analyser.  $O^+$  moving at greater than ~ 310 km/s is outside of this range. In the upstream solar wind, outer magnetosheath, and distant wake the solar wind plasma often moves at speeds of 350 to over 600 km/s. IMA on Venus Express will be able to not only detect, but also verify the composition of many of these additional  $O^+$  (and other) pickup ions.

The PVO results suggest the extent to which ASPERA-4 on Venus Express with its energy



FIG. 3 Relative energies of the detected proton peaks and oxygen peaks in the PV OPA E/Q spectra. A zero proton peak energy implies the presence of only an inferred O<sup>+</sup> peak, based on its proximity to other O<sup>+</sup> peaks or location in the wake proton void. PV OPA has an ~ 8 keV detector E/q limit for O<sup>+</sup> detection.

range of 10 eV to 36 keV, scanning field of view, and ability to separate ion masses, will greatly improve our view of the pickup ion environment around Venus. The currently planned Venus Express orbit is similar to that of PVO, but with periapsis at  $\sim 65^{\circ}$  N Latitude and a periapsis of 250 - 400 km, compared to PVO's  $15^{\circ}$  N Latitude initial periapsis and nominal  $\sim 160$  km periapsis. The sampling of the pickup ion cloud in an orbit with this geometry, compared to the PVO orbit geometry that produced the spectrogram in Fig. 2, is illustrated in Fig. 4. The Venus Express orbit thus provides a somewhat different perspective, focusing on the magnetosheath, near-terminator, and low altitude wake pickup ion characteristics rather than on the distant pickup ion wake characteristics. This is in fact highly complementary to the PVO orbit geometry sampling which did not allow coverage of the low altitude wake. If the orbit is allowed to evolve so that the sampling region circularises, a broader sampling will be obtained.

### E. ENA production at Venus

ENAs are produced in charge exchange collisions between solar wind protons and neutral atoms in the upper part of the atmospheres of the planets. The ASPERA-4 instrument provides ENA



FIG. 4 (a) Illustration of the expected Venus Express orbit with its periapsis at  $\sim 65^{\circ}$  N latitude, relative to O<sup>+</sup> ion test particle trajectories for a particular interplanetary field orientation. The sampling of the pickup ion population is advantageous for near-planet pickup studies. (b) The comparable illustration for a PVO orbit that in contrast sampled the deep ion wake.

images of the Venus-solar wind interaction region. Such images have been simulated through the integration of the ENA production along lines of sight to a virtual ENA instrument (*Fok et al.*, 2004; *Gunell et al.*, 2005c). Some of the results from these simulation studies are reviewed here.

Venus Express arrives at Venus during solar minimum conditions. Due to the scarcity of in situ measurements the ionopause altitude at Venus is not well known for solar minimum conditions (*Luhmann*, 1992) It is thought to vary with the solar cycle, but since all in situ measurements were made during solar maximum conditions this variation is still unconfirmed. *Gunell et al.* (2005c) have investigated the ENA emissions as a function of ionopause distance by scaling the ionopause altitude in the plasma model. The ENA flux from the local emission maximum near the planet decreases with increasing ionopause altitude, since with a higher ionopause altitude the protons pass through a region with lower neutral density. This also affects the ENA production and escape rates. The ionopause is thought to be close to the lower end of that range at solar minimum because of the lower ionospheric pressure (*Luhmann*, 1992). The ENA images are then generated by evaluating line of sight integrals in the same way as it has previously been done to simulate ENA images of the Martian environment (*Gunell et al.*, 2005b; *Holmström et al.*, 2002). *Gunell et al.* 



FIG. 5 ENA images of Venus from vantage points  $3R_{\nu}$  from Venus (planetocentric distance) and solar zenith angles  $\theta = 100^{\circ}$ ,  $140^{\circ}$ , and  $180^{\circ}$ . The ENA flux is shown in units of sr<sup>-1</sup>m<sup>-2</sup>s<sup>-1</sup>, and the axes show the polar angle in degrees.

(2005c) have used a semi-analytical MHD model (*Biernat et al.*, 1999, 2000, 2001) to describe the plasma flow around Venus, and a neutral gas density model that is based on published data from measurements. The input parameters were the following: solar wind density  $n_{sw} = 1.5 \times 10^7 \text{m}^{-3}$ ; solar wind speed  $v_{sw} = 4.4 \times 10^5 \text{m/s}$ ; solar wind temperature  $T_{sw} = 2 \times 10^5 \text{K}$ ; and solar wind magnetic field  $B_{sw} = 1.2 \times 10^{-8}$ T. Three ENA images from vantage points in the *xz*-plane at different solar zenith angles are shown in Fig. 5. The vantage points are located three Venus radii from the centre of Venus, and the solar zenith angles are  $100^{\circ}$ ,  $140^{\circ}$ , and  $180^{\circ}$  for the three images respectively. The ENA flux is shown in units of  $sr^{-1}m^{-2}s^{-1}$ . The centre of each image corresponds to the direction looking straight toward the centre of Venus. The white circle shows the location of Venus' surface. For all three images the ionopause altitude is 250 km at the subsolar point. In the images from solar zenith angles  $100^{\circ}$  and  $140^{\circ}$  the ENA flux has two local maxima: one on the dayside of Venus and the other in the direction of the sun. The latter maximum is produced upstream of the bow shock by charge exchange collisions between the protons in the unperturbed solar wind and atoms in the exosphere of Venus. At  $\theta = 180^{\circ}$  the Sun is occulted by Venus. Fig. 6 shows the ENA production rate per unit volume in cylindrical coordinates for an ionopause altitude of 400 km in units of  $m^{-3}s^{-1}$ . The total hydrogen ENA production rate integrated over the whole region shown in Fig. 6 is  $5.6 \times 10^{24}$  s<sup>-1</sup>. For an ionopause altitude of 250 km the total production rate is  $8.1 \times 10^{24}$  s<sup>-1</sup>.

The ENA production, escape and precipitation rates were calculated for ionopause altitudes of 250 km and 400 km. These numbers together with the corresponding numbers for Mars are found in table I. For Mars both the numbers obtained by *Holmström et al.* (2002) using an empirical



FIG. 6 ENA production rate for an ionopause altitude of 400 km. The cylindrical coordinate  $\rho = \sqrt{y^2 + z^2}$  is the distance to the Venus-sun line. The production rate is shown in units of m<sup>-3</sup>s<sup>-1</sup>.

TABLE I A comparison of some aspects of the results from Venus and Mars. Values for Venus are given for ionopause altitudes 250 km and 400 km respectively. Venus' upper atmosphere is approximately the same independent of the solar cycle. The values for Mars from *Holmström et al.* (2002) are all for solar minimum conditions. Values from the MHD simulation of Mars were taken from *Gunell et al.* (2005b). "Max. flux" refers to the maximum flux in an ENA image of the interaction region downstream of the bow shock. Solar minimum and maximum conditions are denoted by "min" and "max" respectively.

	Venus	Venus	Mars	Mars	
	IP 250 km	IP 400 km	Holmström	MHD (Gunell)	unit
Production rate	$7.8 \cdot 10^{24}$	5.6 · 10 <sup>24</sup>	$1.7 \cdot 10^{25}$	$\begin{cases} 2.4 \cdot 10^{25}, & \min \\ 5.1 \cdot 10^{24}, & \max \end{cases}$	s <sup>-1</sup>
Escape rate	$5.3 \cdot 10^{24}$	$4.0 \cdot 10^{24}$	$1.5 \cdot 10^{25}$		$s^{-1}$
Precip. rate	$2.2 \cdot 10^{24}$	$1.2 \cdot 10^{24}$	$1.4 \cdot 10^{24}$		$s^{-1}$
Max. flux	$5.8\cdot10^{10}$	$3.8\cdot10^{10}$	$3\cdot 10^{11}$	$1.1 \cdot 10^{11}$ , min	$sr^{-1}m^{-2}s^{-1}$

plasma flow model and those obtained by *Gunell et al.* (2005b) using an MHD model are reported. The precipitation rate at Venus is higher than at Mars. This is not unexpected because Venus is a larger planet, and the Venusian ENA production region is located closer to Venus than the Martian ENA production region is to Mars, which is seen in Fig. 7. The left panel of Fig. 7 shows an ENA image of Mars (*Gunell et al.*, 2005b), that is based on an MHD model for the plasma flow (*Ma et al.*, 2002). The right panel of Fig. 7 shows an ENA image of Venus. Both images are



FIG. 7 ENA images from Mars (left) and Venus (right) from vantage points with solar zenith angles of  $120^{\circ}$  and planetocentric distance three radii of the respective planet. The image of the Martian environment (*Gunell et al.*, 2005b) is based on an MHD model of the plasma flow around Mars.

from vantage points at solar zenith angle  $120^{\circ}$  and a planetocentric distance of three radii of the respective planet.

The ENA flux and production rates at Venus are lower than at Mars even though the solar wind flux is greater at Venus. The reason for this is that the neutral gas density at relevant heights is lower in Venus' than Mars' exosphere. The neutral density falls off more rapidly with altitude at Venus, because of the larger mass of that planet, which is 7.5 times greater than the mass of Mars. The dominant contribution to the neutral density at high altitudes at Mars during solar minimum conditions is the large hydrogen corona (*Krasnopolsky and Gladstone*, 1996). The hydrogen density at Mars is greater than that at Venus everywhere above the exobase, and hydrogen is by far the most important species for ENA production at Mars (*Holmström et al.*, 2002).

To show the contributions from different regions, and to illustrate the differences between Venus and Mars, we examine the contributions from different positions along a line of sight. Fig. 8 shows, in the three panels on the left side, from top to bottom, the total neutral gas density, the plasma flux, and the rate of ENA production in the direction toward the vantage point, as functions of distance along the line of sight from the vantage point. The ENA production rate, when integrated along the line of sight, gives the differential ENA flux that is shown in the ENA images. The right panel shows the lines of sight along for which the different quantities are plotted in the left panels. The filled red circle represents Mars and the yellow Venus. The vantage points are at solar zenith angle 100° and a planetocentric distance of three radii of the respective planet. The direction of the lines of sight corresponds to the direction of the pixel with the maximum flux of an ENA image from that vantage point. Because the topology of the plasma flow is different at Venus and Mars the directions of the maximum flux is also different at the two planets. The higher exospheric density at Mars is what makes the ENA flux at Mars greater than at Venus, as is seen



FIG. 8 The three panels on the left side show, from top to bottom, the total neutral gas density, the plasma flux, and the rate of ENA production in the direction toward the vantage point, as functions of distance along the line of sight from the vantage point. Solid and dashed lines represent values at Mars and Venus respectively. The right panel shows the lines of sight along for which the different quantities are plotted in the left panels. The filled red circle represents Mars and the yellow Venus.

in the top left panel. Although the solar wind density is higher at Venus, the flux in the relevant region, i.e., close to the planet, is similar to that at Mars (middle left panel). The bulk speed of the plasma is slowed down near the planet, and the line of sight that yields the highest differential flux is farther away from the planet at Mars than at Venus.

It is interesting to compare the results obtained here with the results of *Fok et al.* (2004). Although their parameters are not exactly the same as ours they are at least similar. *Fok et al.* (2004) took the effect of space craft motion into account. We do not. Since we are considering ENAs with energies above 50 eV this amounts only to a small correction in our case. Both models yield ENA fluxes of the same order of magnitude, and one can conclude that the two models are in reasonable agreement considering the uncertainties of the models. Real measurements will be required to determine between them, or indeed to say anything conclusively about the accuracy of the models.

### **II. THE INSTRUMENT**

### A. Overall configuration

The ASPERA-4 instrument is a replica of ASPERA-3 on board Mars Express mission (*Barabash et al.*, 2004). The experiment is a comprehensive plasma diagnostic package to measure ENAs, electrons, and ions with a wide angular coverage from a three axis stabilised platform. Mechanically ASPERA-4 consists of two units, the Main Unit (MU) and the Ion Mass Analyzer (IMA) (Fig. 9). The Main Unit comprises three sensors: the Neutral Particle Imager (NPI), the Neutral Particle Detector (NPD), the Electron Spectrometer (ELS), and a digital processing unit (DPU), which all are located on a turnable platform. The combination of the 360° sensor field of view (180° for the NPD) and the scans from 0° to 180° give, ideally, the required  $4\pi$  maximum coverage, but part of the field of view is blocked by the spacecraft body. The real coverage depends on the instrument location on the spacecraft. All electrical interfaces only MU. The total mass of the instrument is 9.00 kg; the main unit flight model mass without thermal hardware is 6.63 kg; and the mass of the IMA flight model is 2.37 kg without thermal hardware. The maximum power consumption is 18 W. The Main unit envelope is  $350 \times 263 \times 288$  mm<sup>3</sup> and for the IMA  $287 \times 187 \times 165$  mm<sup>3</sup>.

The ASPERA-4 two ENA sensors complement each other. The NPI is designed to provide measurements with relatively high angular resolution but no mass and energy discrimination while the NPD performs mass and energy analysis of the incoming ENAs, but the angular resolution is crude. This approach also gives the necessary redundancy as well as the independent cross-checking that is necessary for such measurements in a new environment. The charged particle sensors not only provide characterisation of the local plasma environment but also support ENA measurements in terms of charged particles background and inter-calibrations. The ELS is a standard top-hat electrostatic analyser in a very compact design and high energy resolution. The IMA is an improved version of the ion mass spectrographs TICS/Freja, IMIS/Mars-96, IMI/Planet-B (*Norberg et al.*, 1998), and an exact copy of the ICA (Ion Composition Analyzer) instrument that is flying on the Rosetta mission. Since the IMA is not accommodated on the scanner, electrostatic sweeping is used to achieve  $\pm 45^{\circ}$  elevation coverage.

The instrument design, while based on a moduled structure, demonstrates high degree of pack-



FIG. 9 The ASPERA-4 overall configuration, main unit, and ion mass analyzer

aging and sharing of internal resources. The instrument DC/DC converters are shared between all 5 units including the two identical NPD sensors. The DPU mechanical structure also serves as the carrying support for mounting the NPD sensors and the NPI which in turn is carrying the ELS. The internal walls that separate the DPU, NPI, and the two NPD sensors have been replaced by conductive kapton foils to minimise mass, while maintaining sufficient electromagnetic shielding. Because of the high radiation hardness requirement (30 krad) tantalum point shielding is used.

Parameter	NPI	NPD	ELS	IMA
Particles to be measured	ENA	ENA	electrons	ions
Energy, keV per charge	≈0.1-60	0.1-10	0.01-15	0.01-36
Energy resolution, $\Delta E/E$	-	0.8	0.07	0.07
Mass resolution	-	H, O	-	m/q=1,2,4,8,16,32,>40
Intrinsic field of view	$9  imes 344^{\circ}$	$9  imes 180^{\circ}$	$10 \times 360^{\circ}$	$90  imes 360^{\circ}$
Angular resolution, FWHM	$4.6  imes 11.5^{\circ}$	$5 imes 30^\circ$	$10  imes 22.5^{\circ}$	$4.5  imes 22.5^{\circ}$
G-factor / pixel, cm <sup>2</sup> sr	$2.7 \cdot 10^{-3}$	$6.2 \cdot 10^{-3}$	$7 \cdot 10^{-5}$	$3.5 \cdot 10^{-4}$
Efficiency, %	$\approx 1$	0.5-15	incl. in G-factor	incl. in G-factor
Time resolution (full 3D), s	32	32	32	196
Mass, kg	0.7	0.65 each	0.3	2.2

TABLE II The performance of the NPI, NPD, ELS, and IMA sensors.

The ELS uses an external metallic conic-shape ring to protect the sensitive electronics. Table II summarises the instrument performance.

#### **B.** The Neutral Particle Imager (NPI)

The ASPERA-4 NPI on Venus Express is a spare model of the ASPERA-3 NPI currently flying on board the Mars Express spacecraft which in turn is a replica of the NPI-MCP sensor developed for the ASPERA-C experiment on the Mars-96 mission and successfully flown on the Swedish microsatellite Astrid launched in 1995 (*Barabash*, 1995).

In the NPI the charged particles, electrons and ions, are removed by the electrostatic deflection system, which consists of two disks separated by a 3 mm gap (Fig. 10). The 5 kV potential between the grounded and biased disks results in a strong electric field, which sweeps away all charged particles with energies up to 60 keV. Since the integral ENA flux substantially exceeds the charged particle flux for energies greater than 60 keV, this rejection energy is sufficient for satisfactory performance. The disks also collimate the incoming beam over the azimuth angle. Apart from being ON or OFF, the deflection system can be operated in two other modes, alternative mode and sweeping mode. In the alternative mode, the deflection system is turned on and off for one sampling time. This mode is used for more accurate separation between charged and



FIG. 10 Photograph and cut-away view of the NPI sensor.

neutral particles entering the system. The deflection system is connected to the high voltage supply via an optocoupler. Regulating the optocoupler reference voltage one can change the deflection voltage performing the sweeping and alternating. In order to reduce the time for discharging of the deflection system disks down to 1 ms, a second parallel optocoupler is used.

The space between the deflection system disks is divided into 32 sectors by plastic (PEEK) spokes forming 32 azimuthal collimators with a field of view of  $9^{\circ} \times 18^{\circ}$  each. Neutrals passing through the deflection system hit a 32-sided cone target at a grazing angle of incidence of  $20^{\circ}$ . On impact with the target block the incident neutral can either be reflected, produce secondary particles, or both. The secondaries can be both ions and electrons. A 56 mm diameter PHOTONIS MCP stack in chevron configuration followed by a 32 sector anode detects the particles leaving the target. The signal from the MCP gives the direction of the primary incoming neutral. The MCP operates in ion mode with a negative bias of slightly more than -2.2 kV applied to the front side and thus detects (a) sputtered positive ions of the target material, (b) positive ions resulting from ionising of the primary neutrals, and (c) neutrals reflected from the target surface. In order to improve the angular resolution and collimate the particles leaving the interaction surface, 32 separating walls are attached to the target forming a star-like structure. This configuration allows the entering particles to experience multiple reflections and reach the MCP. NPI covers  $4\pi$  in one scanner scan (except a fraction blocked by the spacecraft body) and produces an image of the ENA flux distribution in the form of an azimuth  $\times$  elevation matrix. The direction vector of 32 elements is read out once every 62.5 ms. Two sectors centred around the spin axis and looking toward the spacecraft body are blocked intentionally to provide monitoring of the MCP assembly dark counts. This space is also used for the ELS sensor harness. The internal views of the NPI sensor is given



FIG. 11 NPI integration: the sectioned anode (a), target block installed (b), and deflection system mounted (c).



FIG. 12 The efficiency of sector 4 with neighbouring sectors mechanically blocked.

in Fig. 11

A calibration of the NPI sensor was preformed to characterise the sensor response. MCPsaturation bias, dark count level, angular response in elevation and azimuth, and efficiency. One sector (number 4) was thoroughly investigated, and a scan with the calibration beam in the central plane of all sectors was used to find the relative response of the other 31 sectors. The calibration was performed using an ion beam as a particle source. This is equivalent to using an ENA beam, since particles "forget" their initial charge state when interacting with the surface of the target block.

Fig. 12 is the efficiency of the NPI measured with  $H_2O^+$  ions and protons in the beam for different MCP bias and energies. The efficiency was measured in sector 4 with the neighbouring sectors mechanically blocked. For the MCP operating bias 2.2 kV the efficiency for solar wind energies (~ 1 kV) is around 5 × 10<sup>-4</sup>. Fig. 13 is showing a scan in the central plane of all sectors over a wide parallel beam of 5 keV protons. This measurement was performed to calibrate out the rela-



FIG. 13 Scan through the central plane of the sectors.



FIG. 14 a) Full angular scan with sector 4 in the particle beam (protons). The lower panels show a polynomial fit. (b) Full angular scan with sector 4 in a UV photon beam (Lyman- $\alpha$ ). The lower panels show a polynomial fit.

tive sensitivity of the sectors, which varies significantly. Since the sector angular (polar–azimuth) response function should be included in the ENA image inversion models it was measured and analytical fits were produced. The upper panels of Fig. 14(a) show the measured data and response function and the lower panels show a polynomial fit to the response.

An important issue in the NPI design is the coating of the target block for suppressing UV photon fluxes, which enter the instrument and produce the UV background in the measurements. NPI uses the same coating as in the experiments PIPPI (Prelude in Planetary Particle Imaging) on board Astrid-1 and ASPERA-C on board MARS-96, namely, DAG 213, a resin-based graphite



FIG. 15 (a) NPI sensitivity to UV intensity. (b) Total count during angular scan of sector 4 with UV beam.(c) Translation measurement set up. (d) Translation measurement results.

dispersion. This is similar to Aquadag, which is a graphite dispersion in water. The coating demonstrated satisfactory performance in the PIPPI experiment flown in the Earth's magnetosphere (*C:son Brandt et al.*, 2000). To determine the target block UV separation the NPI was calibrated against hydrogen Lyman- $\alpha$  photons ( $\lambda = 121.6$  nm). The calibration philosophy was similar as that of the particle calibration in that the response of one sector (number 4) was fully characterised then a relative measurement was made for the other sectors.

During calibrations conducted at the University of Arizona the UV-intensity in the beam was continuously monitored by an absolutely calibrated channeltron. The maximum intensity measured was  $10^7$  photons per second into the aperture of the NPI. The measured count rate was  $\sim 30$  counts per second, which corresponds to a UV suppression efficiency of  $10^7/30 \approx 3 \times 10^{-5}$ . This is somewhat higher than what was previously reported by *Barabash* (1995).

The intensity measurement is important to understand the NPI UV response. If we know that the response is more or less linear within certain intensities we can scale the response against what is present in space to determine the photon related background. Due to an unstable beam only three points on this curve were obtained. The NPI count rates for the respective beam intensities are plotted in Fig. 15.

It is important to know what the UV-response is at different incident angles to an NPI aperture. An angular scan could reveal if there are any reflections off of the deflection plates or the spokes in



FIG. 16 The relative response of all sectors to the UV photons (Lyman- $\alpha$ ). The measurements are taken with the UV beam centred on the aperture of each sector.

the electrostatic deflection system. The angular scan was made with respect to the aperture plane of the NPI (sector 4). We should thus expect not to see any counts in any other sector than number 4. If we do this must be a result of internal reflections since all photons from the beam are directed into the centre of sector 4 for all angles. The result of the angular scan is in Fig. 14(b) and Fig. 15(b) shows the sum of all counts during the angular scan in all sectors. There are visible counts in sectors 3, 4 and 5 at around 10% of that in sector 4. To ensure that there are no reflections from the spokes of sectors other than the centre a translation measurement was made. Sector aperture number 4 was centred in the UV beam direction and the NPI was horizontally translated according to figure Fig. 15(c). The space in the tank limited the translation to less than the full diameter of the NPI. However, reflections from aperture spokes further away than the translation range is highly unlikely as it would require a multitude of reflections to reach the target block. The resulting counts are in Fig. 15(d). It shows that there are not significant counts in any sector other than 4.

The relative response of other sectors was measured with the beam centred in the centre of each sector aperture. The beam intensity-compensated result is in Fig. 16.

Fig. 17 shows an example of NPI data from ASPERA-3 on Mars Express. Simulations of the ENA emissions from the corresponding directions (sectors) are also included. The increase in the count at around 20:10–20:20 UT results from ENA fluxes generated in the Martian magnetosheath when the shocked solar wind protons charge exchange on the exosphere and move further as hydrogen atoms along lines tangential to the solar wind stream lines. From data such as these one can find important parameters. For example, the position of the Induced Magnetosphere Boundary near Mars can be found (*Gunell et al.*, 2005a).



FIG. 17 Simulations (red curves) and filtered data (black curves) from Mars Express orbit 363 and the ASPERA-3 NPI sensor. The highest count rates in sector 23 correspond to a flux of  $1.3 \times 10^{11} \text{m}^{-2} \text{sr}^{-1} \text{s}^{-1}$ .



FIG. 18 Three-dimensional view of the NPD principal components.

### C. The Neutral Particle Detector (NPD)

The NPD sensor consists of two identical detectors, each of which is a pinhole camera. Fig. 18. provides a conceptual view of one detector.

In each detector the charged particles, electrons and ions, are removed by a deflection system, which consists of two 90° sectors separated by a 4.5 mm gap. In the normal operational mode the 10 kV potential ( $\pm$ 5 kV) applied to the disks and the resulting strong electric field sweeps away all charged particles with energies up to 70 keV. The deflector also collimates the incoming beam in the elevation angle. The collimated ENA beam emerging from the 3.5 × 4.5 mm pin-hole hits the START surface under a 15° grazing angle causing secondary electron emission. By a system of



FIG. 19 Ray-tracing of electron (a) and 80 eV ion trajectories (b) in the START assembly optics.

collecting grids, the secondary electrons are transported to one of two MCP assemblies that give the START signal for TOF electronics.

Depending on the azimuth angle, the collection efficiency varies from 80% to 95%. The incident ENAs are reflected from the START surface near-specularly. Since the charge state equilibrium is established during the interaction with the surface, the emerging beam contains both the neutral and ionised (positive and negative) components. To increase the total efficiency, no further separation by the charge is made.

As proven by the ion tracing, there is very little disturbance to the reflected atomic ions leaving the START surface with an energy above 80 eV, introduced by the START electron optics. Fig. 19 shows the results of electron and ion ray-tracing in the START assembly electron optics.

Therefore particles of all charge states, i.e., negative, neutral, and positive, will impact the second surface, the STOP surface, and again produce secondary electrons, which are detected by one of the three MCP assemblies giving the STOP signal. The time of flight over a fixed distance of 8 cm defines the particle velocity. Three STOP MCPs also give crude resolution over azimuth within 90° acceptance angle. Since the secondary electron yield depends on mass for the same velocity, the pulse height distribution analysis of the STOP signals provides the estimation of ENA mass. Each event is stored in the array STOP MCP charge  $\times$  time-of-flight  $\times$  direction. The array is accumulated over the sampling time 62.5  $\mu$ s.

Fig. 20 shows a cross-section of the NPD sensor and its main elements with an ENA trajectory shown in blue. Fig. 21 shows the views of the flight model of the NPD sensor. Each sensor has 90° acceptance angel. Two identical sensors are built in a package installed on the scanning platform proving 180° scan and thus organising  $2\pi$  coverage. Fig. 22 shows the two flight NPD sensors during installation into the ASPERA-4 instrument with apertures covered by red-tagged covers



FIG. 20 Cross-view of the NPD sensor.



FIG. 21 Top and bottom view of the flight model of the NPD sensor.



FIG. 22 The flight model of the NPD sensor during installation.

with nitrogen purging tubes connected.

The selection of the START and STOP surfaces was the most challenging part of the NPD development. Extensive studies have been performed at University of Bern (*Jans*, 2000) and Brigham Young University (USA) to optimise the performance of the surfaces which must satisfy a number of requirements, namely, high secondary electron yield, high UV absorption even at grazing angles, high particle reflection coefficient (START surface), low angular scattering, and low photoelectron yield. For the START surface we chose a multi-layer coating composed of a thin layer of  $Cr_2O_3$ , covered by a thicker layer of MgF, and topped with a thin layer of WO<sub>2</sub>. The coating is optimised for the absorption of the 121.4 nm line at the 15° incident angle. The reflection coefficient reached was about 30%, a factor of 2 lower than the uncoated surface. The coating is applied on a titanium substrate polished down to 100 Å roughness.

The STOP surface is graphite (roughness around 100 nm) covered by a MgO layer of about 500 nm. This combination has a very high secondary electron yield, low photoelectron yield, and high UV absorption. A lot of efforts have been made to increase the stability of the MgO coating against moisture. It was established that polishing the graphite substantially improves the stability and possible increases in air humidity during storage and pre-launch operations does not present any problems for the surface performance. Therefore, both surfaces are stable and do not require special maintenance.

The NPD calibrations included determining the efficiency, geometrical factor, angular response and energy resolution. The calibration results fully correspond to the specified performance. Since charge-equilibrium establishes over just a few Å at the particle-surface interaction, ion beams can be used for calibrations of ENA sensors. Fig. 23 shows the TOF distributions for a proton beam at different energies (colour coded) in the energy range 0.1 to 5.0 keV. The displacement of the peaks from the exact energy of the incident particles reflects the energy loss of 33%, which is independent on energy. The full width at half maximum (FWHM) is about 80%. Fig. 24 shows the TOF distributions for H<sub>2</sub>O<sup>+</sup> ion beams of different energies covering the energy range from 0.3 keV to 10.0 keV. The energy losses are the same as for the proton beams.

Fig. 25 shows calibrated dependence of the measured TOF on the incoming particle energy for protons and  $H_2O^+$  ions. The dashed lines show the theoretical dependence corresponding to the 33% energy loss in the START surface. The water molecules produced in the ion source break up during the impact, but the residual components carry the same initial velocity corrected for the energy loss in the target. Therefore, water can be used to calibrate the response of the instrument


FIG. 23 NPD TOF spectra of proton beams at different energies.



FIG. 24 NPD TOF spectra of H<sub>2</sub>O beams at different energies.

to oxygen beams. Since the TOF for oxygen with an energy below 2 keV is longer than the TOF corresponding to slowest protons at around 100 eV TOF measurements alone can be used to identify the particle mass at least in the low energy range.

Fig. 26 shows the NPD angular response over azimuth for a 3 keV proton beam for the three STOP sectors. The red line shows the response of the central sector and the green and the black lines show the side sectors. Fig. 27 shows the sensor angular response over the polar angle. The FWHM over azimuth varies from  $52^{\circ}$  for the central sector to  $35^{\circ}$  and  $37^{\circ}$  for the two side sectors respectively. Over polar angle the FWHM is  $4.5^{\circ}$  for all directions.

Fig. 28 shows the absolute efficiency of the NPD sensor as a function of energy. The blue line corresponds to the incident proton beam and the red line corresponds to the  $H_2O^+$  beam.



FIG. 25 Time-of-flight measurements for different masses as a function of energy. The dashed lines give the theoretical dependence corresponding to 33% energy loss.



FIG. 26 The angular response of the NPD sensor in the azimuthal direction.

As is seen in Fig. 28 the efficiency is more than 11% for  $H_2O$  ENAs at 6 keV. For the H ENA the efficiency reaches 6.5%. Up to a certain energy the efficiency increases with energy, corresponding to an increase of the secondary electron yield. At the energy where the yield reaches unity the efficiency levels out (approximately 3 keV for protons and 6 keV for oxygen). At energies below 1 keV, the efficiency is around few percent.

Fig. 29 shows an example of NPD data from NPD on ASPERA-3 on Mars Express. The six panels correspond to the six directions from the two NPD sensors. For each panel the recorded



FIG. 27 The angular response of the NPD sensor in the polar direction.



FIG. 28 NPD sensor absolute efficiency

TOF spectrum is shown. NPD1 was looking at the subsolar region of Mars while NPD2 looked at the Martian upper atmosphere. The peaks in panels 1–3 correspond to an intense flux of ENAs emerging from the sub-solar region (*Futaana et al.*, 2005). The origin of this flux is not yet known. It is perhaps similar to ENAs recorded by the NPI (see Fig. 17). The lower peaks visible on panels 4–6 are from ENAs originated from the Martian upper atmosphere. They are the result of backscattering of the solar wind protons precipitating onto the upper atmosphere (*Futaana et al.*, 2005) as predicted by *Kallio and Barabash* (2001). A somewhat similar picture is expected from



FIG. 29 NPD TOF spectra from Mars Express ASPERA-3 NPD. The six panels correspond to the six viewing directions from the two NPD sensors.



FIG. 30 Cut-away view of the ELS sensor

the NPD on Venus Express ASPERA-4.

#### **D.** The Electron Spectrometer (ELS)

The Electron Spectrometer (ELS) sensor represents a new generation of ultra-light, low-power, electron sensor (Fig. 30). It is formed by a 17° spherical top-hat electrostatic analyser and a collimator system with the radii of the inner and outer hemispheres equal to 14.9 mm and 15.9 mm respectively. Particles can enter the aperture at any angle in the plane of incidence. Electrons are then deflected into the spectrometer by applying a positive voltage to the inner hemisphere.

The electrons hit a micro channel plate (MCP) after being filtered in energy by the analyser plates. A spectral measurement is achieved by stepping the plate voltage.

Electrons with energies up to 20 keV/q are measured, with a maximum time resolution of one energy sweep (consisting of 128 steps) per four seconds. There are 16 anodes behind the MCP, each anode defining a 22.5° sector and each connected to a preamplifier. The ELS sensor is mounted on the ASPERA-4 scanner platform, on top of the NPI sensor, in such a way that the full  $4\pi$  angular distribution of electrons will be measured during each platform scan. Depending on the mode of operation a sample rotation scan takes 32, 64, or 128 seconds.

The ELS was designed to be solar blind so that it may operate in exposure to direct sunlight. This has been achieved using two UV reducing mechanisms and one secondary electron suppression technique. UV is minimised through the use of a series of light baffles in the ELS collimator and a series of UV light traps at the entrance to the spherical deflection plates. Secondary electrons are reduced by the addition of a special coating, based on a modified Ebanol-C process, which is included through out the deflection surface, light trap, and collimator system (*Johnstone et al.*, 1997).

There are two small differences between the ASPERA-3 (on board Mars Express) and ASPERA-4 ELS units. One is the inclusion of an outer cylindrical 2 mm thick Aluminium shield, which was added to prolong ASPERA-4 ELS operation in the harsher radiation environment of Venus. The other is an offset of the symmetry axes of the ASPERA-4 ELS deflection plates outside the 1% design specification. This happened because the ASPERA-4 ELS, as the refurbished Mars Express flight spare, was actually built earlier than the ASPERA-3 ELS, and therefore did not have the advantage of a critical improvement in the fabrication process that ensured that the stringent 1% requirement was achieved. The misalignment results in differences in instrumental properties as a function of the anode sector position, which will be illustrated in the calibration results discussed below.

The ASPERA-4 Electron Spectrometer (ELS) was calibrated at Mullard Space Science Laboratory, University College, London. The calibration facility (*Johnstone et al.*, 1997), which is based on the technique described by *Marshall et al.* (1986), provides a wide area photoelectron beam at energies ranging from a few eV to 15 keV with variable beam intensities from a few Hz to several MHz. The system is fully automated facilitating calibration scans over the complete range of polar and azimuth angles at several instrument voltage settings both for the analyser as well as the MCP. A flexible data acquisition system was integrated into the automation to provide



FIG. 31 Profile of 10eV electron beam prior to ELS calibration.

simultaneous measurements from the 16 preamplifier channels, coordinated with the instrument position and voltage settings. Before performing the instrument calibration, a profile of the beam output is recorded at each of the calibration energies by means of a channeltron mounted on an X-Y-table. A typical profile at 10 eV is shown in Fig. 31. During calibrations, the channeltron is mounted as close as possible to the instrument aperture in order to provide a constant reference to the beam intensity. Due the the mechanical imperfections of the instrument mentioned above, the laboratory calibrations were critical for defining the instrument response.

The instrument has two operational voltage ranges for the energy sweeps as described later and hence, tests were carried out at several energies in both ranges to cover  $\pm 180^{\circ}$  in polar and  $\pm 3^{\circ}$  in elevation. Fig. 32 is a typical plot of the voltage-angle scans carried out over the 16 anodes at 30 eV in the lower range. Fig. 33 is a plot of the k-factor across the 16 anodes giving an average value of 11.33. Although this is higher than the design value of 7.5 due to the mechanical imperfections, the variation across the anodes is less than 5%, allowing the instrument response to be made good with the calibrations with small errors. The imperfections result in a lower geometric factor but have the advantage of increasing the maximum energy acceptance of the instrument. The calibrations also establish the MCP operational levels for flight and are found to be 150 V higher for the ASPERA-4 compared to the ASPERA-3 unit. This is possibly due to an MCP with a lower intrinsic gain and/or due to a higher electronics threshold for the readout electronics. Finally, the UV rejection ratio of the analyser was also tested using a Lyman- $\alpha$  UV source (*Alsop et al.*, 1996).

The ELS unit has a self contained, dual range, linear high voltage power supply. The first power supply range is from 0 to about 20 volts (about 150 eV) and has 4096 possible settings. The second power supply range is from 0 to 2800 volts (about 20 keV) and also has 4096 possible



FIG. 32 Spectrograms of elevation angle versus the applied voltage on the inner hemisphere for a 30 eV beam.



FIG. 33 Plot of the k-factor across the 16 anodes.

settings. The ELS sweep is fully programmable within the constraint of the maximum decay rate of 32 steps/s. On any given step, the deflection plate voltage is held constant during a minimum of 28.125 ms used to accumulate electrons. There is a minimum of 3.125 ms of data latency between energy steps for transition.

In order to obtain high resolution measurements of the energy spectrum, the power supply may be operated in an oversampling mode, which, when combined with the knowledge of the instrumental response function, increases the number of measurement points per energy interval over a reduced energy range. Measurements in this mode are shown in Fig. 34, which shows a clear resolution of the  $CO_2$  photoelectron peaks, characteristic of the Martian atmosphere.

#### E. The Ion Mass Analyzer (IMA)

The Ion Mass Analyzer (Fig. 35), is an improved version of the ion mass spectrographs TICS (Freja, 1992), IMIS (part of ASPERA-C, Mars-96, 1996), and IMI (Planet-B, 1998) (*Norberg et al.*, 1998). It is an exact copy of the ICA instrument that is on its way to comet 67P/Churyumov-Gerasimenko on board the Rosetta spacecraft.

The principal diagram of the instrument is shown in Fig. 36. Ions enter the analyser through the external grounded grid. Behind the grid there is a deflection system whose purpose is to vary the incident polar angle of particles (shown in Fig. 36 as trajectories 1, 2, and 3). The deflection angle depends on the voltage applied to the deflector electrodes and lies within the  $\pm 45^{\circ}$  from the equatorial plane of the instrument. Fig. 37 shows the instrument polar angle response as a function of the deflector voltage. Then ions pass through the top hat electrostatic analyser which select only



FIG. 34 Photoelectron spectrum from the Mars ionosphere.

the given particle energy according to the interplate voltage. Since the top hat analyser has a full  $360^{\circ}$  cylindrical symmetry, the azimuthal range (in the plane perpendicular to the symmetry axis) of the instrument is  $360^{\circ}$ . The parallel incident ion beam is focusing in the vicinity of the exit of the top hat analyser. Thus the particle position at the top hat analyser exit codes its azimuthal angle. Then the ions pass through the magnetic separation section. The cut of this section in the azimuthal plane is shown in the right panel of Fig. 36. The magnets are shown as blue sectors. Sixteen gaps between the magnets correspond to 16 azimuthal sectors of the instrument of  $22.5^{\circ}$  each. The radial deviation of the ion trajectories at the exit of the magnetic field region corresponds to particle velocity per charge. Since behind electrostatic analyser all particles have the same energy per charge value, ion position codes their masses. The particles are registered by an MCP with a position sensitive anode. The anode resolves 32 bins in the radial position and 16 azimuthal sectors. An example of detector response is shown in Fig. 38.



FIG. 35 The IMA sensor in the vacuum chamber.



FIG. 36 Cut of the analyser (left) with examples of the ion trajectories, and a cross section of the magnet separator (right).



FIG. 37 Colour coded instrument response as a function of polar (elevation) angle and deflector voltage normalised to the ion energy.



FIG. 38 Radial profiles of a few mass peaks. The particle energy is 1250 eV, and the post acceleration voltage is -2150 V.

To provide the possibility to measure light ions at low energies, ions, such as  $H^+$  which have too small gyro-radius to reach the MCP, can be accelerated between the top hat analyser exit and the magnetic section entrance. Fig. 38 shows the 1 keV particles distribution over the detector surface when the acceleration level is -2150 V. Protons only partially reach the MCP for this post acceleration level. With an acceleration of 3615 V protons hit the detector at least down to an energy of 300 eV. From Fig. 37 one can see that polar angle resolution for constant deflector voltage is about 6°. Fig. 39. shows the azimuthal response of the instrument.



FIG. 39 Azimuthal response for selected sectors.

Logically the IMA instrument consists of the ion optics part shown in Fig. 36, a position sensitive detector,

Besides the ion analyser and position sensitive detector the IMA sensor includes a high voltage unit that provides the sweep voltage for all electrodes and MCP bias, and an IMA DPU. The IMA DPU, which is built around the 16-bit MA31750 processor from Dynex, controls analyser voltages, reads out and accumulates the position information for each detector event, and forms telemetry packets. The hardware operation mode is fixed. The fastest changing parameter is the particle energy. It sweeps from 30 keV down to 10 eV over 96 logarithmically equidistant steps. The exposure time on each energy step is 125 ms. During this time interval 16 radial position spectra (32 points) corresponding to 16 azimuthal sectors are accumulated. After each complete energy sweep the instrument changes the polar angle of the field of view. The polar angle is scanned from  $-45^{\circ}$  up to  $+45^{\circ}$  over 16 steps. The total time to complete a full 3D spectrum is 192 s. This spectrum consists of 32 radial (mass) points  $\times$  16 azimuthal sectors  $\times$  96 energy steps  $\times$  16 polar angles. The data processing includes 3 stages: 1) logarithmic compression of the count values; 2) integration (if necessary) over polar angles, and/or azimuthal angles; and 3) RICE compression of the final spectrum. The processing mode is set by TC or chosen automatically according to the TM rate limitations. The acceleration level is also commandable. Only 3 values of acceleration are available: 0 V, -2150 V, and -3650 V.

Fig. 40. shows an example of a energy-mass matrix of an ion-beam event, and was obtained by the ASPERA-3 IMA on Mars Express. The vertical axis represents the energy per charge in eV and the horizontal axis represents the IMA sensor's mass ring number. The red and blue lines in the figure indicate the calibrated mass band ranges for the different ion species:  $O_2^+$ ;  $O^+$ ;  $He^{2+}$ ; and  $H^+$ . Measurements such as these are used to study the ion composition of the plasma that



FIG. 40 Energy-mass matrix obtained by the ASPERA-3 IMA during Mars Express orbit no. 539. The vertical axis represents the energy per charge in eV and the horizontal axis the mass ring number. The red and blue lines show the calibrated mass band ranges for  $O_2^+$ ,  $O^+$ ,  $He^{2+}$ , and  $H^+$ .

escapes from Mars (Carlsson et al., 2005).

#### F. The Digital Processing Unit (DPU)

The ASPERA-4 DPU mechanically includes two boards: the DPU board itself, which is shown in Fig. 41, and a Housekeeping (HK) board, which is shown in Fig. 42. These are connected together with the sensor control electronics and the power supply via a common bus system with 8 address and 16 data lines besides control, analog and power supply lines.

The DPU is built around the 16-bit processor MA31750 from Dynex with 12 MHz system clock frequency and an Actel Field Programmable Gate Array (FPGA) RT54SX32S, which implements memory management, watchdog functions and the serial spacecraft interface protocol. The software runs inside a 128 kByte RAM, organised in 2 banks of two 32kByte static memory chips each. On power-up, a two times 16 kByte bipolar PROM (HARRIS) is activated with a boot loader, which transfers the complete PROM contents into the RAM, changes then the program control to the RAM area and switches the power to the PROMs off via transistor switches to conserve power. It then starts monitoring the telecommand interface for possible boot instructions. This allows the configuration of the instrument in a flexible, but safe manner: If a start configura-



FIG. 41 Main DPU circuit board.

tion is defined via telecommand, the software continues accordingly. Otherwise the default start configuration inside the EEPROM is used. If this is corrupted, the original default configuration from PROM will be used.

A 512 kByte radiation hardened EEPROM (Maxwell) contains additional program code and configuration information, which can be modified from ground. 2 MByte mass memory RAM is used to store measurement data and buffer telemetry packets.

An Actel FPGA RT1280 implements the serial data transfer protocol to the IMA detector with an interface identical to the corresponding hardware used on the Rosetta mission. All interface lines are buffered via special circuits to protect the instrument from external noise effects.

The DPU board is controlled by a 24 MHz crystal which is divided down to 12 MHz and



FIG. 42 ASPERA-4 housekeeping board.

buffered inside an FPGA before it is used for FPGA and processor operations and also on the HK board. As the main FPGA needs 2.5 V operations voltage, this is generated by dedicated regulators directly on the DPU and on the HK board. The watchdog circuit inside the FPGA can be enabled by software. Then it has to be reset regularly by software access. Otherwise it issues a hardware reset to the whole DPU board after 16 seconds. Except for a special error message, the behaviour is identical to a boot sequence after power-up. The DPU board controls most detector voltages with direct access to the power supply board.

The HK board is controlled by a separate RT54SX32S FPGA, which maps all input and output functions into standard bus address space. It also implements the needed counters for detector pulses from the NPI and ELS.

Four eight-channel analog multiplexers select one out of 32 analog voltages to be monitored. They are digitalised by one 14-bit Analog-to-Digital-Converter (ADC, LTC1419). Another 14-bit ADC monitors the ELS deflection voltage. Two 8-bit Digital-to-Analog-Converters generate via 8 latching buffers the control voltages for NPD, NPI, ELS and the scanner. Also the sun-sensor electronics is implemented on the HK board

The software is built around a real-time system with scheduler and interrupt handler. All exe-

cutable routines are defined inside a routing table, which resides in EEPROM and can be modified during flight. In this way new or modified software routines can be stored inside a free area of the EEPROM, verified and added to the operating software by including their start address into this routing table. A macro feature of the telecommand handler offers the possibility to generate sequences of standard telecommands automatically according to a pre-defined list, reducing the need for complex telecommand groups to be up-linked over and over again. Besides detector activation and parameter control, compression and averaging of measurement data allow the reduction of the amount of telemetry generated.

#### G. The Scanner

The scanning platform was originally developed for the ASPERA-C experiment for the Russian Mars-96 project. The modifications that were made for the Mars Express and the Venus Express missions mostly concerned optimisation of the performance during longterm operations and reducing it mass. The ASPERA-4 scanner serves also as a bearing structure for the ELS, NPI, NPD sensors, and the DPU, as well as all electrical interfaces with the spacecraft. The technical data of the scanner system are summarised in table III.

Fig. 43. shows an internal view of the scanner. The large diameter worm wheel (1) to which the sensor assembly is fixed is rotated by a stepper motor (2) via a co-axial worm screw (not visible below the flat cable). The worm wheel is fixed to the structure with a large diameter angular contact ball bearing. During the scanner life time tests, several types of balls, including the ordinary already mounted in the original bearings, were tested. The balls finally used are of ceramic type (Si<sub>3</sub>N<sub>4</sub>), which was found to be the most suitable. The housing and circular sensor platform are manufactured in a high-strength aluminium alloy. The motor driving electronics (not shown), also located in the scanner, provides the motor control and driving. The position of the movable parts relative the scanner is given by three magnetic sensors, two end-sensors at  $0^{\circ}$  and  $180^{\circ}$  (3), and one step counter. Because of the requirements on long-term operations no mechanical contact exist in the sensors. The feed-through cable loop (4) with six cables and 6 connectors, each cable with 26 conductors (a maximum of 156 connections possible) interfacing through D-SUB connectors, provides electrical interface of the whole instrument with the satellite electrical systems.

A worm gear type of mechanism was selected in order to provide self-locking without electrical

Technical data	Value	Unit
Maximum angle of rotation	±100	deg.
Angular movement per step, fs. Mode	0.0190	deg.
Angular movement per step, hs. Mode	0.0095	deg.
Angular position feedback resolution	0.05	deg.
Angular positioning accuracy	0.2	deg.
Operational rotation rate	1.5/3.0/6.0	deg./s
Maximum rotation rate	$\sim 25.0$	deg./s
Power dissipation	0.5–2.0	W
Platform load	3.7	kg
Maximum platform load	$\sim 12$	kg
Dimensions	$60 \times 254 \times 232$	mm
Mass	1.42	kg
Operational lifetime in vacuum	$\sim 3$	years

TABLE III Mechanical scanner platform technical data.

power, to minimise friction, and to obtain a high gear ratio. The platform is made as a plug-in unit towards the sensor assembly. Great efforts have been spent to reduce mass, volume, power consumption and out-gassing in vacuum as well as to achieve high reliability. On command the platform can be turned to an arbitrary position or perform continuous scanning at any rate of rotation up to the maximum.

The scanner also contains a locking mechanism to avoid possible movements of the platform during vibration. The mechanism contains a wire which ties two small levers locking the worm screw axis. Applying by command a voltage to the wire burns it out and the levers are forced apart by a spring unlocking the axis.

#### III. THE TEAM

The ASPERA-4 experiment is a large consortium including 16 groups from 11 countries over the entire Europe, USA, and Japan. Table IV shows the primary hardware responsibilities for the different groups.

Organisation	Primary hardware contribution
Swedish Institute of Space Physics, Kiruna, Sweden	PI-institute, Instrument provider
	NPI, NPD, IMA, scanner
Centre d'Etude Spatiale des Rayonnements,	Co-PI institute, NPI MCPs, IMA anode
Toulouse, France	system, IMA calibrations, IMA
	development, DC/DC board, scanner
	driver board, hardware support
Institute of Space and Astronautical Science,	NPI calibrations and development
Sagamichara, Japan	
University of Bern, Physikalisches Institut, Switzerland	NPD surfaces, NPD mechanics
Instituto di Fisica dello Spazio Interplanetari, Rome, Italy	EGSE, NPI mechanics, NPD electronics
Mullard Space Science Laboratory, UK	ELS calibrations
University of Arizona, Tucson, USA	START surface, NPD UV calibrations
Southwest Research Institute, San Antonio, USA	ELS (MEX spare), data analysis
Rutherford Appleton Laboratory, Oxfordshire, UK	NPD MCPs
Finnish Meteorological Institute, Helsinki, Finland	MU and IMA DPUs, theory
Space Physics Research Laboratory, University,	Theory
of Michigan, Ann Arbor, Michigan, USA	
Max Planck Institute for Solar System Research,	NPD TOF electronics
Katlenburg-Lindau, Germany	
Space Science Laboratory, University of California	Theory
at Berkeley, Berkeley, California, USA	
Space Research Institute, Graz, Austria	Magnetometer team
Space Technology Ireland, National University of Ireland,	Hardware support
Maynooth, Co. Kildare, Ireland	
Applied Physics Laboratory/John Hopkins University,	Theory
Laurel, Maryland, USA	

TABLE IV ASPERA-4 groups and primary hardware responsibilities.



FIG. 43 Internal view of the ASPERA-4 scanner. The numbered items indicate 1) the large diameter worm wheel; 2) a stepper motor; 3) the two end-sensors at scanner position  $0^{\circ}$  and  $180^{\circ}$  respectively; and 4) the feed-through cable loop.

#### **IV. ACKNOWLEDGEMENTS**

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## **APPENDIX 3. ASPERA-4 SCANNER**

## 1 Aspera-4 scanner history

The scanner platform was developed originally for the ASPERA-C experiment for the Russian Mars – 96 project. Some modifications made for Mars Express and Venus express missions mostly concerned optimization of the performance during long term operations and reducing it mass. Aspera–4 scanner is from Aspera–3 scanner further approved with respect to its electronics and mechanical behaviour.

## 2 Scanner key features

The Aspera-4 scanner key features are shown in table 1.

Technical data	Value	Unit
Maximum angle of rotation	+/-100	[deg.]
Angular movement per step, fs. Mode	0.0190	[deg.]
Angular movement per step, hs. Mode	0.0095	[deg.]
Angular position feedback resolution	0.05	[deg.]
Angular positioning accuracy	0.2	[deg.]
Operational rotation rate	1.5/3.0/6.0	[deg./s]
Maximum rotation rate	~25.0	[deg/s]
Power dissipation	0.5-2.0	[W]
Platform load	3.7	[kg]
Maximum platform load	~12	[kg]
Dimensions	60x254x232	[mm]
Mass	1.42	[kg]
Operational lifetime in vacuum	~3	[years]
Gear ratio	188	-

 Table 1
 Mechanical scanner platform key features

## **3** Scanner overview

The Aspera scanner, Aspera-4 scanner shown in figure 1 and 2, constitutes the 0° to 180° rotating platform on which all Aspera sensors (part from IMA) as well as the DPU, high voltage power supply, house keeping and DC/DC boards are situated. The scanner also provides all necessary mechanical and electrical interfaces between the space craft and Aspera (part from IMA).



Figure 1

Aspera-4 scanner





Figure 3 shows Aspera-4 scanner with its mechanical and electrical interface with the DPU box that contains almost all necessary electronics as well as all sensors that constitutes Aspera-4 plasma package (part from IMA).

For the rotation feature a worm gear type of mechanism was selected in order to provide selflocking without electrical power, to minimize friction and to obtain a high gear ratio (1:188). The platform is made as a plug-in unit towards the sensor assembly. Great efforts have been spent to reduce mass, volume, power consumption and out-gassing in vacuum as well as to achieve high reliability.



Figure 3 Aspera scanner dimensional overview

## 3.1 Mechanical overview

Figure 4 shows the scanner internal view. The large diameter worm wheel (1) to which the sensor assembly is fixed is rotated by a stepper motor (2) via a co-axial worm screw (not visible below the flat cable). The worm wheel is fixed to the structure with a large diameter angular contact ball bearing. During the scanner life time tests, several types of balls, including the ordinary already mounted in the original bearings, where tested. The balls finally used are of ceramic type (Si<sub>3</sub>N<sub>4</sub>), which was found to be the best suited. The housing and circular sensor platform is manufactured in high-strength aluminum alloy. The position of the movable parts relative the scanner is given by three magnetic sensors, two end-sensors at  $0^{\circ}$  and  $180^{\circ}$  (3), and one step counter. Because requirements of long-term operations no mechanical contact exist in the sensors. Feed-through cable loop (4) with six cables and 6 connectors, each cable with 26 conductors (a maximum of 156 connections possible) interfacing through D-SUB connectors provides electrical interface of the whole instrument with the satellite electrical systems.



Figure 4. ASPERA – 4 scanner. Internal view. See explanations in text.

## 3.2 Scanner locking mechanism

The worm gear type of mechanism selected provides a self-locking behaviour without electrical power. However, during launch and other necessary transports, Aspera will encounter heavy mechanical loads; why as a looking mechanism was introduced.

The locking mechanism will avoid unwanted movements of the platform. It contains of a wire which tires two small levers locking the square shaped worm screw axis. By command, applying a voltage to the ware will burn the wire which forces and the levers apart by a spring, and unlocks the axis, shown in figure 5. Clearly, the release scanner command can only be run once – which in Aspera-4 case is done during commissioning – and in Aspera-3 case in December 2005 (after app. 2 years of orbiting Mars).



Figure 5 Scanner locking mechanism

## 3.3 Scanner motor configuration

The stepper motor used is a modified P430 from Escap (Figure 6). The modifications made regards the two ball bearings within the stepper motor holding the motor shaft. The original ball bearings are replaced by type NMB R-1350ZZ bearings surface treated with NoWear Gamma by SKF, Sweden. The balls are mounted at IRF, and are made of Si3N4 (NBD200) by Saint Gobain/Cerbec. The ball diameter is 2.00018 mm, grade 5. The ball holders are designed and manufactured at IRF and are made of Beraloy (Acoflon 100 Mo, 97% PTFE + 3% MoS2). The ball bearings are mounted in the motor with shims for a correct axial displacement. Also, the ball bearings are mounted without any axial tension applied to them in order to release the ball bearings from wear. The motor shaft is isolated from any axial load from the worm screw by a soft split of the motor shaft and worm screw. Also, the rightmost end plate in the picture is reduced in thickness by 0.1 mm by milling in order to increase the axial space in which the magnetic disk rotates.



Figure 6.Scanner stepper motor

Key features of the scanner motor are shown in table 2.

			coils in series
Co	bil dependent parameters		typ
1	Phase resistance	ohm	10
2	Phase inductance (1 kHz)	mH	14
3	Nominal phase current (2 ph. on)	А	0.56
4	Nominal phase current (1 ph. on)	A	0.8
5	Back-EMF amplitude	V/kst/s	4.7

#### Coil independent parameters 1)

Tor	que parameters		typ
6	Holding torque (nominal current)	mNm (oz-in)	60 (8.5)
7	Holding torque (2 x nominal current) <sup>2)</sup>	mNm (oz-in)	90 (12.7)
8	Detent torque amplitude and friction	mNm (oz-in)	3.5 (0.5)
Thermal parameters			
9	Thermal resistance coil-ambient <sup>3)</sup>	°C/W	11
An	gular accuracy		
10	Absolute accuracy (2 ph. on full-step mode)	% full-steps	
Mechanical parameters			
11	Rotor inertia	kgm².10-7	3
Other parameters			
12	Natural resonance frequency (nominal current)	Hz	360
13	Electrical time constant	ms	1.5
14	Angular acceleration (nominal current)	rad/s <sup>2</sup>	200 000

#### Table 2Scanner motor key features

## **3.4** Motor drive electronics

The motor driving electronics located in the scanner provides the motor control and driving. The stepper motor is driven by a classical H-bridge drive system with a motor current control system. The location of the board is shown in figure 7.



Figure 7 Scanner interior with scanner electronic board

For a smooth stepping of the motor, 16 micro steps per full step and winding is implemented, illustrated in figure 8.





Micro step behaviour

The 16 micro step levels are set by an ACTEL FPGA to a DAC, both situated on the scanner electronics board, and set the current reference value for the motor current control system. Figure 9 shows the same behaviour of the actual reflection voltage of the current and the reference value measured in the current feed back loop.



Figure 9 Motor current reflection voltage and current reference voltage

In addition to current control, for minimizing mechanical interaction with its environment the scanner electronics controls the scanner start up sequence in that sense it provides a start up ramp. Given a start up command, the scanner electronics ramps up the scanner speed from zero to full speed in 4 steps, illustrated in figure 10 which is the pulses read out from the wheel pulse generator (see section scanner positioning).



Figure 10

Ramp behaviour

## 3.5 Motor current settings

In order to increase the torque of the motor, an offset of the current setting can be changed by command. The relation for Aspera-4 between the hexadecimal current reference value and the actual current consumed is shown in figure 11.



Scanner current consumtion vs Hexadecimal reference value

#### Figure 11 Scanner current setting plot

By command, one can set the coast as well as the ramp current separately, meaning that one can have a higher current (higher torque) during ramp period than during coast period.

### 3.6 Scanner modes

On command, the platform can be turned to an arbitrary position or perform continuous scanning at any rate of rotation up to the maximum. For all modes, the scanner can be run in speed steps of 128, 64 and 32 seconds/180° turns, called coast speed, which is selected in the command sequence.

#### 3.6.1 Scanner initialization

Scanner will rotate to its home position (CCW) referred to as  $0^{\circ}$  position, and stay there.

#### 3.6.2 Full scan mode

Continuous back and forth scans between 0° and 180°. Stopped by command.

#### 3.6.3 Stepping mode

Continuous back and forth scans in steps of predefined degrees. Stops a predefined interval between every scan. I.e. one can define the scanner to continuous move  $15^{\circ}$  - wait for 20 seconds – move 15 further degrees – wait 20 seconds – move – wait - and so on. At end positions the scanner will reverse its direction, and continue. Stopped by command.

#### 3.6.4 Go to position

The scanner will go to a position defined by command, and stay there.

## **3.7** Scanner positioning

The position determination of the scanner is obtained by counting pulses from the wheel sensor that sits on the motor shaft as it rotates away from one of the two end position sensors. Hence, the end sensors will reset the pulse counter. The position of the scanner is referred to as the direction perpendicular to the centre of the plane of ELS sensor field of view. Hence, in the +x direction in the frame of Aspera-4 coordinate system. The Angular positioning accuracy of the scanner pointing direction is  $0.2^{\circ}$ . The position can be read out of the house keeping data of Aspera.

## 3.8 Friction break system

For flawless operation reasons, there is a built in clearance between the gears in the gearbox. The clearance is optimized to a minimum with respect to thermal expansions. The tension introduced by the 6 bended flat cables within the scanner that eventually connects Aspera to the space craft, can cause reduction of mechanical pressure between the gears in the gearbox. The friction system applied in Aspera-4 prevents this to happen. The friction system mainly consists of a peek friction ring, and two flat spring tensioned TiN (Titanium Nitride) coated pads, illustrated in figure 12, 13, and 14. The friction applied is of very small magnitude, and is optimized to prevent the tension of the flat cables to push the gear cogs apart.



Figure 12

Part of peek ring and friction pads



Figure 13 Flat spring tensioned TiN coated pads



Figure 14 Peek friction ring illustration







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# APPENDIX 4. MAIN UNIT TM / TC DESCRIPTION



ASPERA-4



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## **ACRONYMS AND DEFINITIONS**

EEPROM	Electrically Erasable Programmable Read-Only Memory
НК	Housekeeping
IMA	Ion Mass Analyser
MCP	Microchannel plate
MU	Main Unit
NPD	Neutral Particle Detector
NPI	Neutral Particle Imager
PROM	Programmable Read-Only Memory
S/C	Spacecraft
SGICD	Mars Express Space / Ground Interface Control Document, Issue 2
SW, S/W	Software
TBC	To Be Confirmed
TBD	To Be Defined
TBW	To Be Written
TC	Telecommand
ТМ	Telemetry







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# **ASPERA-4**

## 1 GENERAL

## **1.1** Software in general

ASPERA-4 Main Unit software is responsible for operating Main Unit according to the telecommands. It will, depending on its mode and received telecommands, produce telemetry. It has also a small server for communications with IMA. This server converts telecommands form spacecraft to form known by IMA. It also converts telemetry sent by IMA to a form known by the spacecraft.

The software is run on a MIL-STD-1750 type microprocessor and is written in C (using POSIX threads) and partly in assembler. Compilers used are m1750-gcc version 1.4.3b2 by XGC Software. Package includes also version gas (gnu assembler) for MIL-STD-1750.

Software described in this Users Guide is the version R-4.8.0, in other words Aspera-4/VenusExpress version of the software.

#### **1.2** Startup procedure

When the experiment boot it will perform a short self-check. If an anomaly is detected (like watchdog reset), the Main Unit will inform the s/c with an event report packet at the end of the boot process. After a short self-check, the s/w will start basic services (TM, limited TC, HK).. At this point an event (with eid=40001) is nominally sent. User must next idetify how to proceed by sending command 'select boot mode' to inform s/w from there on to stay at safe mode or to continue with default boot module. If this command is not sent for 17 hours S/W tries to load so called PROM module and executes that. Prom module is module providing MU housekeeping and full IMA services (except memory services of tc type 6). All MU services applicable for safe mode are also available in this mode.

If the default boot module is choosed, s/w can't be loaded from PROMs. It will instead try to load a replacement from a module in EEPROM, starting from address 0x10000 or higher. If the module can't be loaded from EEPROM or ROM, the experiment will enter safe mode (actually stay in safe mode). If **valid** module is found it will be loaded and started. The end status of this process is sent as an event.

If the s/w was loaded successfully, an event report will be generated to show that the experiment has booted properly. Pending error messages from the boot process will be sent.

# S/W will verify wether the boot process isrunned due the watchdog reset or power-on. In case of watchdog reset an event is generated (40004).

#### 1.3 Shutdown procedure

There aren't any strict s/w requirements for shutdown. Only after Patch EEPROM command it's recommended to wait long enough to receive an event reporting about successful EEPROM programming. This is to ensure that EEPROM does have valid content.

#### 1.4 On commands

## 1.4.1 General

One fundamental aspect of the ASPERA-44 Main Unit is the way it uses commands (both telecommands and internal commands). Telecommands can be classified in many ways, but most fundamental is division to direct and indirect telecommands. Direct commands are command with type



255 or under 193. These commands are executed immediately after they have been detected in telecommand input buffer. Indirect commands are forwarded (after verifying command structure) to a specific process, command handler for later execution. Telecommands TC(192,21) and TC(193,11) fall into both categories. If s/w is in safe mode (or some broken state) these commands are used as direct commands. However, in normal situation these are treated as indirect. Indirect commands are handled via a specific `telecommand` table 'Telecommand table' is table that specifies most of the telecommand is found. Due to this table it's relatively easy to change the way some command behave without compiling and reprogramming all of the s/w. It is also important to note that indirect commands, i e commands found only in telecommand table, are not available in safe mode.

Further division is made to classify commands as safe and hazardous. Hazardous commands must be followed immediately by TC(191,255) containing sequence count of hazardous command. Hazardous commands can't be run from macros.

## 1.4.2 On acknowledgments

The ASPERA-4 MU provides only telecommand acceptance acknowledgment for itself. For IMA, acknowledgments are provided by using execution acknowledgments. When an IMA related telecommand is found, the Main Unit will send an acceptance acknowledgment to the s/w (if acknowledgement is requested in the telecomannd headers ) and then it forwards the command to IMA. If execution acknowledgment is - requested in the telecomand headers (applicable only for IMA) IMA will send an acknowledgment to the Main Unit which is waiting for that. This will then be forwarded to the s/c. Although this process is more acceptance than execution type of acknowledgment, it has to be used. Due to the acceptance acknowledgment time-out criteria (20s) and the 32-second acquisition period of IMA, it is not possible to have acceptance acknowledgments on IMA.

#### 1.4.3 On error conditions

Error conditions are reported as event packets. If the error is such that automatic recovery process in the MU s/w cannot be executed, the software will shut down erroneous services. S/w won't enter safe mode unless it's absolutely necessary.



## 2 USING IMA

#### 2.1 General

IMA commands (type 194 and 195, and memory management sevice 6 for PID 62) are first received in MU. MU convert commands to valid IEEE1355 link packets and then send these to IMA. There is separate command queues for MU and IMA and MU specific commands are executed simulataneosly with command transmission to IMA. Therefore, if for some reason IMA fails to receive command at all MU can be commanded withourt furher problems. The command acknowledgments scheme is explained in chapter 1.4.2.

#### 2.2 IMA Server

There is separate serverfor IMA. It works in parallel to other parts of the software and does not require any specific modes on MU. Acquisition period of 16 sec and is independent of MU modes. Also, TM sent by IMA is reformatted (to standard ESA packets) in parallel with other activities in MU. IMA command sent to MU will be passed to IMA server so that other MU commands can be executed before IMA command is really transmitted to IMA. To allow parallel TM and TC handling for IMA and MU there is a buffer for both IMA TC and TM.



#### **3 TELECOMMANDS**

#### 3.1 General

The general structure of telecommands is defined in SGICD.

## **3.2 Field descriptions**

Field name	Form	Description	
Parameter	=X	Parameter is constant with value X	
	$X \Rightarrow Y$	Parameter can vary in range from X to Y	
	(X) * n	X is repeated n times	

Parameters are listed in the same order that they appear in the telecommand or telemetry packet so that first parameter to be sent is listed first.

Some terminology: Immediate response means immediate answer for the telecommand, like event reporting about success of the command. Related effect is effect that can be seen in telemetry, but it is not not immediate answer for the command. Exapmles of this are starting of generation of some packet type, changed reference field in housekeeping packet or change in monitor value in housekeeping packet.

NOTE: Related effect is often something that can't be seen at all in some cicumstances. For example, changing NPI bias voltage can't be seen in hk or science data packets if these are not generated at all.

#### 3.3 Telecommand set Part I - commands defined in SGICD

#### 3.3.1 TC(3,5) Enable HK Packet generation

Generic description			
Acronym		aspmHKEnable	
Туре	3	PID	61
Subtype	5	Packet Category	12
16 bit parameters	1		
General description			
Description		Enable HK generation in ASPERA-4 Main Unit	
Note		Only housekeeping packet generation of Main Unit can be switched on by this TC	
Parameter description			
Name	Size (bytes)	Value	Note
None	2	=0	
Response			
Immediate response			
Related effect		Generation of MU HK report packet TM(3,25) starts	



# 3.3.2 TC(3,6) Disable HK Packet generation

Generic description			
Acronym		aspmHKDisable	
Туре	3	PID	61
Subtype	6	Packet Category	12
16 bit parameters	1		
General description			
Description		Disable HK generation in ASPERA-4 Main Unit	
Note		Only housekeeping packet generation of Main Unit can be switched off by this TC	
Parameter description			
Name	Size (bytes)	Value	Note
None	2	0	
Response			
Immediate response			
Related effect		Generation of MU HK report packet TM(3,25) stops	

## 3.3.3 TC(6,2) Load memory using absolute addresses

Generic desc	cription			
Acronym			aspmMEMLoad	
Туре		6	PID	61
Subtype		2	Packet Category	12
16 bit paran	neters	varies		
General desc	cription			
Description			Load memory to an absolute	e address
Note			Any patch to be loaded to E	EPROM must be loaded to
			mass memory. It can be tran	sferred to EEPROM by
			TC (193,10) which is availa	ble only in safe mode.
Parameter d	escription			
Name		Size (bytes)	Value	Note
Memory id		1	0x80 => 0x83	0x80: N/A
-				0x81: RAM
				0x82: N / A
				0x83: MASSMEMORY
Number of b	locks (=nb)	1	1=>	Number of blocks to load
Data block	Address	4	$0 \Rightarrow 0x7FFFF$	Address of first word in
(repeated nb				block
times)	The second second	3	1 . 0 .000	N
,	Length of	2	$1 \Rightarrow 0 \times 1111$	Number of words in this
	DIOCK (=ID)			DIOCK
	Data	2*lb	( 1=> 0xffff) * lb	lb times data words
Response				
Immediate re	esponse			
Related effect	et			



## 3.3.4 TC(6,5) Dump memory using absolute addresses

Generic desc	ription			
Acronym			AspmMEMDump	
Туре		6	PID	61
Subtype		5	Packet Category	12
16 bit paran	neters	varies		
General desc	cription			
Description			Dump memory from an ab	osolute address
Note				
Parameter d	escription			
Name		Size (bytes)	Value	Note
Memory id		1	0x80 => 0x83	0x80: ROM
				0x81: RAM
				0x82: EEPROM
				0x83: MASMEMORY
Number of b	locks (=nb)	1	1=>	Number of blocks to
				dump
Data block	Address	4	$0 \Rightarrow 0 x7FFFF$	Address of first word in
(repeated nb				block
times)	Length of	2	$1 \rightarrow 0$ vffff	Number of words in this
	block (-lb)	2	1 => 0XIIII	block
	010CK (-10)			DIOCK
Response				
Immediate response			At least one memory dump report packet TM(6,6)	
Related effect				

# 3.3.5 TC(9,1) Accept Time update

Generic description			
Acronym		AspmTime	
Туре	9	PID	61
Subtype	1	Packet Category	12
16 bit parameters	0		
General description			
Description		Accept time update	
Note			
Name	Size (bytes)	Value	Note
None	-	-	
Response			
Immediate response			
Related effect		The clock is updated	



## **3.3.6** TC(17,1) Request connection test response

Generic description			
Acronym		aspmConn	
Туре	17	PID	61
Subtype	1	Packet Category	12
16 bit parameters	0		
General description			
Description		Test Connection	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
None	-	-	-
Response			
Immediate response		Connection Test Report TM(17,2)	
Related effect			

## 3.3.7 TC(20,1) Enable Science Report Packet Generation on RTU Link

Generic description				
Acronym		aspmSCIEnable		
Туре	20	PID	61	
Subtype	1	Packet Category	12	
16 bit parameters	0			
General description				
Description		Enable Science rep	oort packet generation in Main Unit.	
		Set instrument in scientific mode.		
Note		This command must be executed before Scanner can		
		be operated or science data can be produced. This is		
		due to fact that timing of Scanner is tightly coupled		
		with handling of measurement modes.		
Parameter description				
Name	Size (bytes)	Value	Note	
None	-	-	-	
Response				
Immediate response				
Related effect	ed effect Generation of Science data will be enabled. A		nce data will be enabled. All	
		scanner operations can be performed after execution		
		of this command.	-	



# 3.3.8 TC(20,2) Disable Science Report Packet Generation on RTU Link

Generic description			
Acronym		AspmSCIDisable	
Туре	20	PID	61
Subtype	2	Packet Category	12
16 bit parameters	0		
General description			
Description		Disables Science report packet generation in Main	
		Unit.	
Note		Science data production will be disabled. Data that	
		has already been me	asured will be handled and sent.
Parameter description			
Name	Size (bytes)	Value	Note
None	-	-	-
Response			
Immediate response			
Related effect		Generation of Scien	ce data will be disabled.



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## 3.4 Telecommand set Part II - commands of type 191

## 3.4.1 TC(191,1) Switch ELS +30V on/off

Generic description			
Acronym		aspmELS30	
Туре	191	PID	61
Subtype	1	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description Switch ELS +30V on/off		off	
Note		The +30V for ELS controls the high voltages of the	
		deflection plates and MCP.	
Parameter description			
Name	Size (bytes)	Value	Note
On/off	2	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect		Corresponding power i	indicator changes in HK packet.

#### 3.4.2 TC(191,2) Set ELS Screen Grid Voltage

Generic description			
Acronym		AspmELSGrid	
Туре	191	PID	61
Subtype	2	Packet Category	12
16 bit parameters	1	Hazardous	No
General description		· · · ·	
Description	ription Set ELS Screen grid voltage		voltage
Note		Screen grid value define the minimum energy of particle	
		detected by ELS.	
Parameter description	n		
Name	Size (bytes)	Value	Note
PAD	1	= 0	
Grid voltage	1	$0 \Rightarrow 0 \text{xFF}$	Sets screen grid reference voltage
Response			
Immediate response			
Related effect		Set screen grid reference fields in HK telemetry packet and in ELS Engineering Information packet.	

The MU generate a voltage which is linear from 0 to +5 V. These values are represented by the parameter limits 0x0000 and 0x00FF respectively.



## 3.4.3 TC(191,3) Set ELS Deflection Voltage

Generic description				
Acronym		aspmELSDef1		
Туре	191	PID	61	
Subtype	3	Packet Category	12	
16 bit parameters	1	Hazardous	No	
General description				
Description		Set ELS deflection plate voltage and deflection power		
		supply range.		
Note		Set a constant value for c	leflection plate voltage.	
Parameter description				
Name	Size (bytes)	Value	Note	
PAD	3 bits (msb)	=0		
ELS HV Supply Range	1 bit	0 => 1	0 = Low, 1 = High	
Deflection voltage	12 bits (lsb)	$0 \Rightarrow 0 x 0 FFF$		
Response				
Immediate response				
Related effect		Set ELS deflection reference to a constant value, reflected in		
		ELS Engineering telemetry packet.		

The Deflection HV supply range has two states, low range and high range. The control of each supply voltage is generated by the MU. The values linearly range from 0 to +5 V and are represented by the parameter limits of 0x0000 and 0x0FFF respectively.

## 3.4.4 TC(191,4) Enable ELS High Voltages

Generic description			
Acronym		AspmELSHV	
Туре	191	PID	61
Subtype	4	Packet Category	12
16 bit parameters	1	Hazardous	Yes
General description			
Description		Switch ELS High voltages off/on	
Note		Command must be verified with TC(191,255)	
Parameter description			
Name	Size (bytes)	Value	Note
On/off	2	0 => 1	0=off, $1=$ on
Response			
Immediate response			
Related effect		ELS high voltage enable telemetry state changes in HK packet.	



## 3.4.5 TC(191,5) Set ELS MCP Bias Voltage

Generic description				
Acronym		AspmELSMcp		
Туре	191	PID	61	
Subtype	5	Packet Category	12	
16 bit parameters	1	Hazardous	No	
General description				
Description		Set ELS MCP bias volta	ge	
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
PAD	1	=0		
MCP bias voltage	1	$0 \Rightarrow 0 \text{xFF}$		
Response				
Immediate response				
Related effect		ELS MCP bias reference field is reflected in HK packet and		
		in ELS Engineering Information packet.		

The MU generates a reference voltage to control the ELS MCP voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.

## 3.4.6 TC(191,7) Switch IMA +30V on/off

Generic description			
Acronym		aspmIMA30	
Туре	191	PID	61
Subtype	7	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Switch IMA +30V on/off	
Note		The +30V for IMA controls the high voltages of the	
		deflection and MCP.	
Parameter description			
Name	Size (bytes)	Value	Note
IMA +30V	2	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect		IMA +30V power state indicator field changes in HK packet.	



## 3.4.7 TC(191,9) Switch IMA on/off (±5V and ±12V on/off)

Generic description			
Acronym		AspmIMApow	
Туре	191	PID	61
Subtype	9	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Switch IMA $\pm 5V$ and $\pm 12V$ on/off	
Note		Switch on low voltage power to IMA	
Parameter description			
Name	Size (bytes)	Value	Note
IMA $\pm$ 5V and $\pm$ 12V	2	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect		IMA $\pm 12V$ and $\pm 5V$ power state indicator field	
		change in HK packet.	

## 3.4.8 TC(191,10) Switch NPD Heaters on/off

Generic description			
Acronym		AspmNPDheaters	
Туре	191	PID	61
Subtype	10	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
<b>Description</b> Switch NPD Start surface heaters on/off		ace heaters on/off	
Note		Activate NPD heaters to control the temperature of	
		NPD instrument. Simu	ultaneously for both NPD1 and
		NPD2.	
Parameter description			
Name	Size (bytes)	Value	Note
NPD Heaters on/off	2	0 => 1	0=off, $1=$ on
Response			
Immediate response			
Related effect		NPD heater status fiel	d changes in HK packet.

# 3.4.9 TC(191,11) Switch NPD1 +30V on/off

Generic description				
Acronym		aspmNPD130		
Туре	191	PID	61	
Subtype	11	Packet Category	12	
16 bit parameters	1	Hazardous	No	
General description				
Description Switch NPD1 +		Switch NPD1 +30V	+30V on/off	
Note		The +30V for NPD1 controls the high voltages of the		
		deflection and MCP supplies.		
Parameter description				
Name	Size (bytes)	Value	Note	
NPD +30V on/off	2	0 => 1	0=off, $1=$ on	
Response				
Immediate response				
Related effect		Power indicator field	d changes in HK packet.	



## 3.4.10 TC(191,12) Set NPD1 Bias Voltage

Generic description			
Acronym		aspmNPD1bias	
Туре	191	PID	61
Subtype	12	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
<b>Description</b> Set NPD1 bias voltage			
Note		Set the value of the MC	CP bias supply for NPD1.
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD1 bias voltage	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		NPD1 bias reference an packet.	nd monitor fields change in HK

The MU generates a reference voltage to control the NPD1 MCP Bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.

#### 3.4.11 TC(191,13) Set NPD1 Deflection Voltage

Generic description			
Acronym		aspmNPD1def1	
Туре	191	PID	61
Subtype	13	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPD1 deflection voltage	
Note		Set the value of the deflection voltage for NPD1.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD1 Deflection voltage	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		NPD1 deflection supply reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD1 Deflection voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.



## 3.4.12 TC(191,14) Set NPD1 Start MCP Bias Voltage

Generic description			
Acronym aspmNPD1start			
Туре	191	PID	61
Subtype	14	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPD1 start MCP bias voltage	
Note		Set the bias reference for the NPD1 start MCP.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD1 Start MCP bias	1	$0 \Rightarrow 0 \text{xFF}$	
voltage			
Response			
Immediate response			
Related effect		NPD1 start MCP bias reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD1 Start MCP Bias voltage. The range varies linearly from 0 to +5 volts and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.

## 3.4.13 TC(191,15) Set NPD1 Stop MCP Bias Voltage

Generic description			
Acronym		aspmNPD1stop	
Туре	191	PID	61
Subtype	15	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPD1 stop MCP Bias Voltage	
Note		Set the bias reference for the NPD1 stop MCP.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD1 Stop MCP bias	1	$0 \Rightarrow 0 x FF$	
voltage			
Response			
Immediate response			
Related effect		NPD1 stop MCP bias reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD1 Stop MCP Bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.



#### 3.4.14 TC(191,16) Switch NPD2 +30V on/off

Generic description			
Acronym		aspmNPD230	
Туре	191	PID	61
Subtype	16	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Switch NPD2 +30V on/off	
Note		The +30V for NPD2 controls the high voltages of	
		the deflection and MCP supplies.	
Parameter description			
Name	Size (bytes)	Value	Note
NPD2 +30V on/off	2	0 => 1	0=off, $1=$ on
Response			
Immediate response			
Related effect		Power indicator fields changes in HK packet.	

## 3.4.15 TC(191,17) Set NPD2 Bias Voltage

Generic description			
Acronym		AspmNPD2bias	
Туре	191	PID	61
Subtype	17	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description Set NPD2 bias voltage			
Note		Set the value of the MCP bias supply for NPD2.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD2 Bias voltage	1	$0 \Rightarrow 0 \text{xFF}$	
Response	· ·		
Immediate response			
Related effect		NPD2 bias reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD2 Bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.



## 3.4.16 TC(191,18) Set NPD2 Deflection Voltage

Generic description			
Acronym		aspmNPD2def1	
Туре	191	PID	61
Subtype	18	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPD2 deflection voltage	
Note		Set the value of the deflection voltage for NPD2.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD2 Deflection voltage	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		NPD2 deflection supply reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD2 Deflection voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.

#### 3.4.17 TC(191,19) Set NPD2 Start MCP Bias Voltage

Generic description			
Acronym		aspmNPD2start	
Туре	191	PID	61
Subtype	19	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPD2 start MCP bias voltage	
Note		Sets the bias reference for the NPD2 start MCP.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPD2 Start mcp bias	1	$0 \Rightarrow 0 \text{xFF}$	
voltage			
Response			
Immediate response			
Related effect		NPD2 start MCP bias change in HK packet.	reference and monitor fields

The MU generates a reference voltage to control the NPD2 Start MCP Bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.



## 3.4.18 TC(191,21) Switch NPI +30V on/off

Generic description			
Acronym		aspmNPI30	
Туре	191	PID	61
Subtype	21	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Switch NPI +30V on/off	
Note		The +30V for NPI controls the high voltages of the	
		deflection and MCP supplies.	
Parameter description			
Name	Size (bytes)	Value	Note
NPI +30V on/off	2	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect		Power indicator field c	hanges in HK packet.

## 3.4.19 TC(191,22) Set NPI Bias Voltage

Generic description			
Acronym		aspmNPIBias	
Туре	191	PID	61
Subtype	22	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPI bias voltage	
Note		Set the value of the MCP bias supply for NPI.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPI Bias voltage	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		NPI bias reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPD2 Stop MCP bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.



## 3.4.20 TC(191,23) Set NPI Deflection Voltage

Generic description			
Acronym		aspmNPIdefl	
Туре	191	PID	61
Subtype	23	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set NPI deflection voltage	
Note		Set the value of the deflection voltage for NPI.	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
NPI Deflection voltage	1	$0 \Rightarrow 0 x FF$	
Response			
Immediate response			
Related effect		NPI deflection supply reference and monitor fields change in HK packet.	

The MU generates a reference voltage to control the NPI Bias voltage. The range varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively.

## 3.4.21 TC(191,24) Set NPI Deflection Switch

Generic description			
Acronym		aspmNPIswitch	
Туре	191	PID	61
Subtype	24	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
<b>Description</b> Set NPI Deflection switch on/off		itch on/off	
Note		Turn on/off NPI deflection voltage.	
Parameter description			
Name	Size (bytes)	Value	Note
NPI Deflection switch	2	0 => 1	0=off, 1=on
on/off			
Response			
Immediate response			
Related effect		NPI deflection switch indicator telemetry point	
	changes in HK packet.		



## 3.4.22 TC(191,25) Set Scanner Setup

Generic description			
Acronym		aspmSCANSetup	
Туре	191	PID	61
Subtype	25	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Defines the operation o	f the Scanner.
Note		Scanner $+30\overline{V}$ on/off and select IRQ operation	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	12 bits	=>0	
Scanner error handler	1 bit	0 => 1	0=enabled, 1=disabled
Auto-switchoff mode	1 bit	0 => 1	0=enabled, 1=disabled
Scan IRQ	1 bit	0 => 1	0=disabled, 1=enabled
Scanner +30V on/off	1 bit	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect		Scanner +30V power state indicator telemetry point	
		changes in HK packet.	

# 3.4.23 TC(191,26) Set Scanner Voltages

Generic description			
Acronym		aspmSCANVolts	
Туре	191	PID	61
Subtype	26	Packet Category	12
16 bit parameters	3	Hazardous	No
General description			
Description		Set Scanner voltages an	nd currents
Note			
Parameter description			
Name	Size (bytes)	Value	Note
VREFMC	1	$0 \Rightarrow 0 \text{xFF}$	
Coast current	1	$0 \Rightarrow 0 \text{xFF}$	
Ramp current	1	$0 \Rightarrow 0 \text{xFF}$	
Threshold CW	1	$0 \Rightarrow 0 \text{xFF}$	
Threshold CCW	1	$0 \Rightarrow 0 \text{xFF}$	
Threshold Wheel	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		Scanner voltage and cu	rrent reference telemetry points
		change in HK packer.	

The MU generates voltages to control different Scanner functions. The ranges varies linearly from 0 to +5 V and the values are represented by the parameter limits of 0x000 and 0x00FF respectively. All except VREFMC are passed to Scanner controller board as digital values.



## 3.4.24 TC(191,27) Scanner String Heaters

Generic description				
Acronym aspmSCANStrHeat				
Туре	191	PID	61	
Subtype	27	Packet Category	12	
16 bit parameters	1	Hazardous	Yes	
General description				
Description		Release scanner locking mechanism by using string heater 1 or 2 for 15sec. Hazardous command on database level.		
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
Pad	14 bits	= 0		
Stringheater	2 bits	0x1 => 0x2	Number of string heater	
			to be used.	
			0 = N / A	
			1 = String Heater $1$	
			2 = String Heater $2$	
			3 = N / A	
Response				
Immediate response				
Related effect		Scanner locking mecha	Scanner locking mechanisms should be released. The	
		release can be verified	release can be verified by trying to initialize Scanner (i	
		e by rotating it)		

# 3.4.25 TC(191,30) Enable ASPERA-4 Main Unit watch dog

Generic description			
Acronym		AspmWatchdog	
Туре	191	PID	61
Subtype	30	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Enable Watchdog t	timer
Note: May contain	disable option	*Watchdog cannot be disabled.	
-	-	* With current version of s/w wd is enabled as a	
		default	
Parameter description	on		
Name	Size (bytes)	Value	Note
Security code	2	=0x2704	
Response			
Immediate response			
Related effect			



## 3.4.26 TC(191,32) NPD1 High Voltage Switch

Generic description			
Acronym		aspmNPD1switch	
Туре	191	PID	61
Subtype	32	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Enable NPD1 high voltage	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
NPD1 HV	2	0 => 1	0=off, $1=$ on
Response			
Immediate response			
Related effect			

## 3.4.27 TC(191,33) NPD2 High Voltage Switch

Generic description			
Acronym		aspmNPD2switch	
Туре	191	PID	61
Subtype	33	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Enable NPD2 high voltages	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
NPD2 HV	2	0 => 1	0=off, 1=on
Response			
Immediate response			
Related effect			

# 3.4.28 TC(191,34) Set NPD1 Counter Thresholds

Generic description			
Acronym		aspmNPD1Tresholds	
Туре	191	PID	61
Subtype	34	Packet Category	12
16 bit parameters	2	Hazardous	No
General description			
Description	Description Set NPD1 counter thresholds		lds
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Start	1	$0 \Rightarrow 0 \text{xFF}$	
Stop0	1	$0 \Rightarrow 0 \text{xFF}$	
Stop1	1	$0 \Rightarrow 0 \text{xFF}$	
Stop2	1	$0 \Rightarrow 0 x FF$	
Response			
Immediate response			
Related effect		NPD1 start count and stop count fields change in the	
		NPD1 Science packets.	



#### 3.4.29 TC(191,35) Set NPD2 Counter Thresholds

Generic description			
Acronym		aspmNPD2Tresholds	
Туре	191	PID	61
Subtype	35	Packet Category	12
16 bit parameters	2	Hazardous	No
General description			
Description		Set NPD2 counter three	sholds
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Start	1	$0 \Rightarrow 0 \text{xFF}$	
Stop0	1	$0 \Rightarrow 0 \text{xFF}$	
Stop1	1	$0 \Rightarrow 0 \text{xFF}$	
Stop2	1	$0 \Rightarrow 0 \text{xFF}$	
Response			
Immediate response			
Related effect		NPD2 start count and s NPD2 Science packets	stop count fieldschange in the

## 3.4.30 TC(191,255) Confirm Hazardous Command

Generic description			
Acronym		aspmLaunch	
Туре	191	PID	61
Subtype	255	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Confirms previous hazardo	ous command.
Note		This command must follow immediately after	
		command to be confirmed (i e this must be next	
		command).	
Parameter description			
Name	Size (bytes)	Value	Note
Packet Type	1	191 => 193	Packet type of the
			confirmable command.
Packet Subtype	1	0 => 255	Packet subtype of the
			confirmable command.
Response			
Immediate response			
Related effect			



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# 3.5 Telecommand set Part III - commands of type 192

# 3.5.1 TC(192,1) Select ELS mode

Generic description			
Acronym		aspmELSmode	
Туре	192	PID	61
Subtype	1	Packet Category	12
16 bit parameters	2	Hazardous	No
General description			
Description		Select ELS measurement m	ode.
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Spare	1 bit		
Rice Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
Log Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
Energy Compression	2 bits	0 => 2	0 = 1 step
			1 = 2 steps
			2 = 4 steps
Time Compression	3 bits	0 =>4	0 = 1 sweep
			1 = 2 sweeps
			2 = 4 sweeps
			3 = 8 sweeps
			4 = 16 sweeps
Sweep Table Number	5 bits		
PAD	1 bit	0	
Deflection Voltage Sweep	1 bit	0 => 1	
Disabled			
None	1 bit	0 => 1	0 = inactive
			1 = active
Sector Mask	2	$0 \Rightarrow 0$ xFFFF	
Response			
Immediate response			
Related effect ELS information changes in the HK pa		n the HK packet and the	
		ELS Science telemetry pack	ket



## 3.5.2 TC(192,6) Set NPI Mode

Generic description			
Acronym		aspmNPImode	
Туре	192	PID	61
Subtype	6	Packet Category	12
16 bit parameters	3	Hazardous	No
General description			
Description		Set NPI measurement mode	
Parameter description			
Name	Size (bytes)	Value	Note
Stepping Mode	1	0=>255	0 = normal mode (no voltage stepping) 1-255 = number of samples in one step
Accumulation Time	4 bits	0 => 15	Accumulation Time (n) so that one period is $31.25$ ms * (2 ^ n)
PAD	1 bit	0	
Log Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
Rice Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
None	1 bit	0 => 1	0 = inactive, $1 = $ active
Sector Mask	4	$0 \Rightarrow 0$ xFFFFFFFF	
Response			
Immediate response       Related effect       NPI information changes in the HK packe         NPI Science telemetry packet		the HK packet and the et	

# 3.5.3 TC(192,7) Set NPD Mode

Generic description			
Acronym		aspmNPDmode	
Туре	192	PID	61
Subtype	7	Packet Category	12
16 bit parameters	3	Hazardous	No
General description			
Description		Set NPD measurement mod	e
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Integration Factor	4 bits		Reserved for TOF mode
Accumulation Time	4 bits		Accumulation Time (n)
			so that one period is
			31.25ms * (2 ^ n)
PAD	1 bit	0	
Measurement Mode	3 bits	0 => 3	0 = Raw Array Mode
			1 = Bin Matrix Mode
			2 = TOF Mode
			3 = PHD Mode
Log Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
Rice Compression Enabled	1 bit	0 => 1	0=disabled, 1=enabled
NPD2 active	1 bit	0 => 1	0=inactive, 1=active
NPD1 active	1 bit	0 => 1	0=inactive, 1=active
NPD1 Bin Matrix	2	$0 \Rightarrow 0 x 0 FFF$	Bits $12-15 = PAD$
Reduction Tables			Bits $8 - 11 = \text{Dir } 2$
			Bits $4 - 7 = \text{Dir } 1$
			Bits 0 - $3 = \text{Dir } 0$



Generic description			
NPD2 Bin Matrix	2	$0 \Rightarrow 0 x 0 FFF$	Bits 12-15 = PAD
Reduction Tables			Bits $8 - 11 = \text{Dir } 2$
			Bits 4 - $7 = \text{Dir } 1$
			Bits 0 - $3 = \text{Dir } 0$
Response			
Immediate response			
Related effect		NPD information char	nges in the HK packet and the
		NPD Science telemetr	v packet

# 3.5.4 TC(192,12) Set MU HK Packet Generation Frequency

Generic description			
Acronym		AspmHKDelay	
Туре	192	PID	61
Subtype	12	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Set HK Generation Frequency	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
None	2	$0 \Rightarrow 0 \text{xffff}$	Delay in seconds
Response			
Immediate response			
Related effect			



## 3.5.5 TC(192,13) Set Scanner mode

Generic description				
Acronym		AspmSCANmode		
Туре	192	PID	61	
Subtype	13	Packet Category	12	
16 bit parameters	2	Hazardous	No	
General description				
Description		Set Scanner mode		
Note		In scanning mode (r be sent but doesn't a	In scanning mode (mode = 1), second parameter must be sent but doesn't affect anything.	
		Mu unit will accept the scanner to rotate 0xB0 to 0xBF). If co scanner is simply no step not in b-positio	Mu unit will accept scanner mode commands leading the scanner to rotate into b-positions (ie.positions from 0xB0 to 0xBF). If command is for standing mode scanner is simply no moving. In stepping mode next step not in b-positions is commanded instead.	
Parameter description				
Name	Size (bytes)	Value	Note	
PAD	/ bits	0	0 = Standing (scanner	
Scanner mode	1 bits	0 => 3	on) 1 = Scanning 2 = Stepping 3 = Not in use (Scanner off)	
Scanner speed	1	0 => 3	0 = Shutdown 1 = 32 sec per scan 2 = 64 sec per scan 3 = 128 sec per scan	
Scanner cycle duration	1	$0 \Rightarrow 0 \mathrm{xFF}$	Length of measurement cycle (n) so that cycle lasts for 31.25ms * (2^n).	
Scanner step angle or Scanner position (based upon Mode Setting)	1	0 => 0xFF	Standing mode => Position Stepping mode => Step Angle	
<i>Response</i> Immediate response Related effect		Scanner information	the	



## 3.5.6 TC(192,14) Initialize Scanner

Generic description			
Acronym		AspmSCANinit	
Туре	192	PID	61
Subtype	14	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Initialize Scanner	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	7 bits	0	0 = test communication
Scanner init	1 bit	0 => 1	and initialization
			1 = test communication
			only
Communication test value	1	$0 \Rightarrow 0 x FF$	test value
Response			
Immediate response			
Related effect			

## 3.5.7 TC(192,16) Set High Voltage Shutter Reduced Voltages

Generic description				
Acronym		AspmHVShutVolts	AspmHVShutVolts	
	100		~	
Туре	192	PID	61	
Subtype	16	Packet Category	12	
16 bit parameters	3	Hazardous	No	
General description				
Description		Set HV shutter reduce	Set HV shutter reduced voltages	
_		Set HV shutter reduced voltages		
Note			-	
Parameter description				
Name	Size (bytes)	Value	Note	
PAD	1	0		
NPI Bias	1	$0 \Rightarrow 0 \text{xFF}$		
NPD1 Stop Bias	1	$0 \Rightarrow 0 \text{xFF}$		
NPD1 Start Bias	1	$0 \Rightarrow 0 \text{xFF}$		
NPD2 Stop Bias	1	$0 \Rightarrow 0 \text{xFF}$		
NPD2 Start Bias	1	$0 \Rightarrow 0$ xFF		
Response				
Immediate response				
Related effect		Bias reference fields	values change in the HK packet	



# 3.5.8 TC(192,15) Set High Voltage Shutter Mode

Generic description			
Acronym		aspmHVShut	
Туре	192	PID	61
Subtype	15	Packet Category	12
16 bit parameters	varies	Hazardous	No
General description			
Description		Set HV shutter mode	
Parameter description			
Name	Size (bytes)	Value	Note
Test mode	1 bit	0 off	In solar sensor mode
		1 on	only
Mode	3 bits	0 off	-
		1 Solar sensor with init	
		2 Test scan only	
		3 NPD Countrate	
		4 External	
Others, varies with mode	12 bits		
Others, varies with mode	8		
Command interpretation in	solar sensor mode:		
Test mode	1 bit	0 off	
i est mode	1 on	1 on	
Mode	3 hits	1 Solar sensor with init	
Re-init period	8 bits	Number of measurement	
Re line period	0 010	cycles	
PAD	2 hits	cycles	
Scanner speed	2 bits	0 default $(32s)$	
Seumer speed	2 010	1 32s	
		2 64s	
		2 0 <del>1</del> 3 3 128s	
Solarsensor 1 CW limit	1	5 1268	Valid if test mode
Solarsensor i CW mint	1		specified
Solarsensor 1 CCW limit	1		Valid if test mode
Soluisensor r ee w mint	1		specified
Solarsensor 2 CW limit	1		Valid if test mode
Soluisensol 2 e tt milit	1		specified
Solarsensor 2 CCW limit	1		Valid if test mode
Solarsensor 2 CC W mint	1		specified
PAD	4		specifica
Command interpretation in	NPD countrate mode		
Test mode	1 bit	N/A	
Mode	3 bits	3 NPD Countrate	
Duration	12bits	Duration (n) so that reduced	
Durution	120105	voltages are used for 31 25	
		* (n+1) ms	
Countrate criteria for NPD	1.2		
Countrate criteria for NPD	2.2		
PAD	4		
Command interpretation in	Ext mode:		
Test mode	1 bit	0 off	
Mode	3 bits	4 Ext Countrate	
Duration for NPI shutter	12 bits	Duration (n) so that reduced	
		voltages are used for 31.25	
		* (n+1) ms	
CW position for NPI	1		
shutter			
CCW pos for NPI shutter	1		




Generic description		
PAD	4 bits	
Duration for NPD1 and	12 bits	Duration (n) so that reduced
NPD2 shutter		voltages are used for 31.25
		* (n+1) ms
CW position for NPD1	1	
shutter		
CCW position for NPD1	1	
shutter		
CW position for NPD2	1	
shutter		
CCW position for NPD2	1	
shutter		
Response		
Immediate response		
Related effect		Values in coresponding fields change in the HK
		packet

# 3.5.9 TC(192,20) Run Macro

Generic description			
Acronym		aspmMacroRun	
Туре	192	PID	61
Subtype	20	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Run macro	
Parameter description			
Name	Size (bytes)	Value	Note
PAD	1	= 0	
Macro Number	1	$0 \Rightarrow 0 xFF$	0 - 191 range of values
Response			
Immediate response			
Related effect		Corresponding macro i executed	s loaded from EEPROM and

# 3.5.10 TC(192,21) Terminate Current Macro

Generic description			
Acronym		aspmMacroTerminate	
Туре	192	PID	61
Subtype	21	Packet Category	12
16 bit parameters	0	Hazardous	No
General description			
Description Terminate current macro			
Note		This command cannot be used in a macro.	
Parameter description			
Name	Size (bytes)	Value	Note
None	-	-	-
Response			
Immediate response			
Related effect			



# 3.5.11 TC(192,22) Run Single Macro Command

Generic description			
Acronym		aspmMacroRunCmd	
Туре	192	PID	61
Subtype	22	Packet Category	12
16 bit parameters	varies	Hazardous	No
General description			
Description		Run single macro comm	and
Parameter description			
Name	Size (bytes)	Value	Note
None	2	= 0x2704	
Confirm Word	2		type+subtype as in
			aspmLaunch
Туре	1	$0 => 0 \mathrm{xFF}$	
SubType	1	0 => 0 xFF	
None	2	= 0x0	
Number of Parameters	1	0 => 0 xFF	
None	1	$= 0 \mathbf{x} 0$	
Parameters	varies		as many as specified
			above
Response			
Immediate response			
Related effect			

ASPER



### 3.6 Telecommand set Part IV - commands of type 193

# 3.6.1 TC(193,1) Pipe Telecommand

Generic description		
Acronym		aspmPipe
Туре	193	<b>PID</b> 61
Subtype	1	Packet Category 12
16 bit parameters	Varies	Hazardous No
General description		
Description		Pipe TC to TM
-		Send parameters back to telemetry
Note		
Parameter description		
Response		
Immediate response		
-		Piped TC report packet TM (193, 128)
Related effect		

# **3.6.2** TC(193,2) Relax (do nothing)

Generic description			
Acronym		aspmRelax	
Туре	193	PID	61
Subtype	2	Packet Category	12
16 bit parameters	0	Hazardous	No
General description			
Description		Relax i e do nothing	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
None	-	-	-
Response			
Immediate response			
Related effect			

# 3.6.3 TC(193,3) Generate simulated data

Generic description			
Acronym		AspmSim	
Туре	193	PID	61
Subtype	3	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description Generate simulated data		a	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Simulation enabled	2	0 => 1	0: simulation disabled
			1: simulation enabled
Response			
Immediate response			
Related effect			



# 3.6.4 TC(193,4) Write word to address

Generic description			
Acronym		aspmWrite	
Туре	193	PID	61
Subtype	4	Packet Category	12
16 bit parameters	2	Hazardous	Yes
General description			
Description		Write word to address	
Note		Command must be verified with TC(191, 255)	
Parameter description			
Name	Size (bytes)	Value	Note
Address	2	$0 \Rightarrow 0 \text{xFFFF}$	
Data word	2	$0 \Rightarrow 0 \text{xFFFF}$	
Response			
Immediate response			
Related effect			

### 3.6.5 TC(193,5): Read word from address

Generic description			
Acronym		aspmRead	
Туре	193	PID	61
Subtype	5	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description Read word from address			
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Address	2	$0 \Rightarrow 0 \text{xFFFF}$	
Response			
Immediate response		Read word report packet TM(193,6)	
Related effect			

### **3.6.6** TC(193,10) Patch EEPROM

Generic description			
Acronym		aspmPatch	
Туре	193	PID	61
Subtype	10	Packet Category	12
16 bit parameters	6	Hazardous	No
General description			
Description		Patch EEPROM (starting from absolute address) using specified number of words found from massmemory at specified absolute address.	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Massmemory address	4	0 => 0x0007 FFFF	
Eeprom address	4	$0 => 0 \times 0003$ FFFF	
Patch Mode	1 bit	0 => 1	0 = Patch without using paging mode 1 = Patch using paging mode
Patch length	15 bits	$1 \Rightarrow 0x7FFF$	Length of patch in 16bit words



Generic description			
Patch CRC checksum	2	$0 \Rightarrow 0 x FFFF$	CRC checksum calculated over whole patch
Response			
Immediate response		EVENT:	
_		- EEPROM programm	ied or
		- EEPROM programm	ing not successful or
		- EEPROM programm	ing CRC error
Related effect		1	-

# 3.6.7 TC(193,11): Load Module

Generic description			
Acronym		aspmModule	
Туре	193	PID	61
Subtype	11	Packet Category	12
16 bit parameters	3	Hazardous	No
General description			
Description		Load Module	
Note			
Parameter description			
Name	Size (bytes)	Value	Note
Address	4	$0 \Rightarrow 0x0007$ FFFF	
PAD	6 bits	= 0	
Execution Flag	1 bit	0 => 1	0 = Load and run module
			1 = Load but don't run
			module
CRC Verify	1 bit	0 => 1	0 = Verify crc
			1 = Don't verify crc
Memory ID	1	= 0x82	(EEPROM)
Response			
Immediate response		EVENT:	
		- Module loaded or	
		- Module load failed	
Related effect			

# 3.6.8 TC(193,12) Select Boot Mode

Generic description			
Acronym		aspmBootMode	
Туре	193	PID	61
Subtype	12	Packet Category	12
16 bit parameters	1	Hazardous	No
General description			
Description		Select boot mode	
Note		No use after boot process	
Parameter description	n		
Name	Size (bytes)	Value	Note
Boot Mode	1	1 => 2	1 = Safe Mode
			2 = Normal Mode
Response			
Immediate response			
Related effect			
3.6.9 TC(193,16	) Watchdog reset		





Generic description				
Acronym		aspmWDReset		
Туре	193	PID	61	
Subtype	16	Packet Category	12	
16 bit parameters	1	Hazardous	No	
General description				
Description		Force watchdog reset		
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
Security code	2	=0x2704		
Response				
Immediate response		EVENTS:		
-		- I'm alive and		
		- Watchdog reset		
Related effect		-		



#### 3.7 List of telecommands

Telecommand	Acronym	Description	Number of
			Parameters
TC (3, 5)	aspmHKEnable	Enable HK generation	1
TC (3, 6)	aspmHKDisable	Disable HK generation	1
TC (6, 2)	aspmMEMLoad	Load memory	4
TC (6, 5)	aspmMEMDump	Dump memory	4
TC(9, 1)	aspmTime	Accept Time Undate	0
TC(17, 1)	aspmConn	Connection Test	0
TC (20, 1)	aspmSCIRnable	Enable Science on RTU link	0
TC (20, 2)	aspmSCIDisable	Disable Science on RTU link	0
TC (191, 1)	aspmELS30	Switch ELS +30V on/off	1
TC(191, 2)	aspmELSGrid	Set ELS Screen Grid voltage	1
TC (191, 2)	aspmELSOFId aspmELSDefl	Set ELS Deflection voltage and switch	1
TC (191 4)	aspmELSEV	Switch ELS high voltage on/off	1
TC(191, 7)	aspmELSIT v	Set ELS MCP bias voltage	1
TC(191, 3)	aspmLLStrep	Switch IMA +30V on/off	1
TC(191, 7) TC(191, 9)	aspmIMAPow	Switch $MA + 5V$ and $\pm 12V$ on/off	1
TC(191, 9) TC(191, 10)	aspmNPDheaters	Switch NPD besters on/off	1
TC (191, 10) TC (191, 11)	aspmNPD130	Switch NPD1 +30V on/off	1
TC(191, 11) TC(191, 12)	aspmNPD1bias	Set NPD1 bigs	1
TC(191, 12) TC(191, 13)	aspmNPD1defl	Set NPD1 Deflection bias	1
TC (191, 13) TC (191, 14)	aspmNPD1start	Set NPD1 Start bias	1
TC(191, 14) TC(101, 15)	aspmNPD1start	Set NPD1 Start blas	1
TC(191, 15) TC(101, 16)	aspinit Distop	Switch NDD2 + 20V on/off	1
TC (191, 10) TC (101, 17)	aspiniveD250	Switch NFD2 +30V 01/011	1
TC(191, 17) TC(101, 18)	aspinive D201as	Set NPD2 Dias	1
TC(191, 10) TC(101, 10)	aspinivPD2den	Set NPD2 Deflection bias	1
TC(191, 19) TC(101, 20)	aspininPD2start	Set NPD2 Start blas	1
TC(191, 20)	aspiniveD2stop	Switch NDL 20V on/off	1
TC(191, 21)	aspiniNP150	Switch NP1 +50V 0h/0h Set NDL Piec	1
TC (191, 22)	aspininPiBias	Set NPI Dids	1
TC(191, 23)	aspinivriDen	Set NPI Defiection voltage	1
TC(191, 24) TC(101, 25)	aspiniverswitch	Set NET Switch	1
TC(191, 23)	aspinSCANSetup	Set Scamer voltages	2
TC (191, 20)	aspinSCANStrillast	Set Scaller voltages	3
TC(191, 27)	aspinsCANStrieat	Switch stringheaters on/on	1
TC (191, 50)	aspin watchdog	Enable walchdog	1
TC (191, 32)	aspiniNPD1switch	Set NPD2 high voltages	1
TC(191, 55)	aspmNPD2switch	Set NPD2 nign voltages	1
TC(191, 34) TC(101, 25)	aspiniNPD1Tresholds	Set NPD2 counter tracholds	2
TC(191, 55)	aspiniNPD2Tresholds	Set NPD2 counter tresholds	2
TC(191, 255)	aspinLaunch	Commin Hazardous Command	1
TC(192, 1)		Set ELS IIIode	2
TC(192, 0)	aspinivPiniode	Set NPD mode	3
TC(192, 7) TC(102, 12)	aspinivPDilode	Set HV generation frequency	3
TC(192, 12) TC(102, 13)	aspini i KDelay	Set Seanner mode	1
TC(192, 13) TC(102, 14)	aspinSCAMinode	Juitializa Saannar	2
TC(192, 14) TC(102, 15)	aspmUVShut	Sot HV shutter mode	1 Varias
TC (192, 15) TC (192, 16)	aspmHVShutVolte	Set HV shutter reduced voltages	3
TC (192, 10) TC (192, 20)	aspmMacroRup	Run macro	1
TC (192, 20)	aspmMacroTerminate	Terminate current macro	0
TC(192, 21) TC(192, 22)	aspmMacroRunCmd	Run single macro command	Varies
TC (192, 22)	aspmPine	Pipe TC to TM	Varies
TC (193, 2)	aspmRelax	Relax Le do nothing	0
TC (193, 3)	aspmSim	Generate simulated data	1
TC (193, 4)	aspmWrite	Write to address	2
- \-> 0, ./	···· r ···· · · · · · · · · · · · · · ·		1 -



 Reference
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Telecommand	Acronym	Description	Number of
			Parameters
TC (193, 5)	aspmRead	Read from address	1
TC (193, 10)	aspmPatch	Patch eeprom	6
TC (193, 11)	aspmModule	Load module	3
TC (193, 12)	aspmBootMode	Select boot mode	1
TC (193, 16)	aspmWDReset	Watchdog reset	1



#### **4 TELEMETRY**

#### 4.1 General

#### 4.2 Telemetry packages

#### 4.2.1 TM(1,1) Telecommand Acceptance report - Success

Generic description				
Acronym		ASPMTCAck		
Туре	1	PID	61	
Subtype	1	Packet Category	1	
16 bit parameters	4			
General description				
Description		Telecommand acceptar	ice report	
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
Telecomand packet ID	2	$0 \Rightarrow 0 x FFFF$		
Telecommand packet	2	$0 \Rightarrow 0 x FFFF$		
sequency control				
Long description				
In SGICD				

# 4.2.2 TM(1,2) Telecommand Acceptance report - Failure

Generic description			
Acronym		ASPMTCNack	
Туре	1	PID	61
Subtype	2	Packet Category	1
16 bit parameters	Varies		
General description			
Description		Telecommand acceptance report - failure	
Note			
Parameter description			
Name Size (bytes)		Value	Note
Long description			
In SGICD - No changes	or additions to that define	nition has been made	

### 4.2.3 TM(1,7) TM Execution acknowledgment report – Success

As specified in SGICD

### 4.2.4 TM(1,8) TM Execution acknowledgment report – Failure

As specified in SGICD





# 4.2.5 TM(3,25) Housekeeping report

Generic description				
Acronym		ASPMHKRep / ASPIHKRep		
Туре	3	Subtype	25	
APID		61 => 62		
16 bit parameters		Varies		
General description				
Description		Housekeeping repo	rt	
Note				
Parameter description				
Name Size (bytes)		Value	Note	
Long description				
Description later in this document				

# 4.2.6 TM(6,6) Memory dump report packet (as specified in SGICD)

Generic descripti	on		
Acronym		aspmMemDump	
Туре	6	Subtype	6
APID		61	
16 bit parameter	'S	Varies	
General descripti	on		
Description		Memory dump report packet.	
Note			
Parameter descri	ption		
Name Size (bytes)		Value	Note
Long description	·		

# 4.2.7 TM(17,2) Connection test report

Generic description	1			
Acronym		ASPMConnRep		
Туре	<b>Type</b> 17		2	
APID		61		
16 bit parameters				
General description	n			
Description	Connection test report		port	
Note				
Parameter descript	ion			
Name	Size (bytes)	Value	Note	
Long description				
In SGICD				



# 4.2.8 TM(20,3) Science data report

Generic description				
Acronym		ASPMScienceRep		
Туре	20	Subtype	3	
APID		61		
16 bit parameters		Varies		
General description				
Description		Science data report		
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
Long description				
Definition later in this document				

# 4.2.9 TM(193,6) Read word report packet

Generic descriptio	n				
Acronym		ASPMReadRep			
Туре	193	Subtype	6		
APID		61			
16 bit parameters		2			
General descriptio	General description				
Description	ption Word read from address specified in packet T		dress specified in packet TC(193,5)		
Note					
Parameter descrip	tion				
Name	Size (bytes)	Value	Note		
Address	2	Any	Address of word		
Data 2		Any	Word read from address		
Long description					

### 4.2.10 TM(193,128) Piped TC report packet

Generic description				
Acronym		ASPMPipeRep		
Туре	193	Subtype	128	
APID		61		
16 bit parameters		Varies		
General description				
Description		Piped Telecommad		
Note				
Parameter description				
Name	Size (bytes)	Value	Note	
Long description				
Parameters should be exact copy of source data field (without checksum) of received telecommand aspmPipe				



# 4.3 Telemetry list

Telecommand	Acronym	Description	Note
TM (1, 1)	aspmTCAck	Telecommand acceptance report – Success	
TM (1, 2)	AspmTCNack	Telecommand acceptance report – Failure	
TM (1, 7)	AspiTCEAck	Telecommand execution report – Success	Only from IMA
TM (1, 8)	aspiTCENAck	Telecommand execution report – Failure	Only from IMA
TM (6,6)	AspmMemDumpRep /	Memory dump report packet for MU / IMA	
	aspiMemDumpRep		
TM (6, X)	AspiMemCheckRep	Memory check report for IMA	Only for iMA
TM (3, 25)	AspmHKRep /	Housekeeping packet fro MU / IMA	
	AspmHKRep		
TM (17, 2)	aspmConnRep	Connection Test response	
TM (20, 3)	AspmScienceRep /	Enable Science on RTU link for MU/IMA	
	aspiScinceRep		
TM (193,6)	ASPMReadRep		
TM (193,128)	aspmSCIDisable	Disable Science on RTU link	



### **5** EVENT REPORTING

#### 5.1 General

All events from the MU are formatted according to the same scheme. First word (after headers, i e word number 8) is the event number. The following two words are freely chosen extra information about the event, typically just zeros. Events generated by the MU are of type TM(5,1) to TM(5,2), as specified in the SGICD. Subtype 1 corresponds to normal progress and subtype 2 corresponds to a warning.

#### 5.2 Event List

The following table defines all events produced by the MU. If extra parameters are not specified, these are constant zeros.

Event	Event name	Parameter 1	Parameter 2	Description
<i>number</i>	I'm Alizza			Compared offer
40001	I III Alive			normal boot
				process as a first
				event
40003	Going to reboot			
40004	Watchdog reset	wd mask	wd mask cleared	
40005	Going to safe mode			
40006	Going to normal mode			
40007	Telecommand buffer overflow			
40010	Eeprom programmed			
40011	Eeprom programming -	CRC check sum in patch	CRC checksum in	
	nonsuccess	Ĩ	programmed EEPROM	
			area	
40012	CRC error in Eeprom patch	CRC check sum in patch	CRC checksum specified	
		-	in TC	
40013	Module loaded			
40014	Module load failed	Error code defining exac	t Optional extra	
		type of error	information	
40015	Default boot module loaded			
40016	Default boot module loading	Error code defining exac	t Optional extra	
	failed	type of error	information	
40020	Command handler error	1: command not	Seq count of command	
		confirmed properly	raising error	
		16: other error		
		Oxffff: command not		
		found		
40021	Invalid confirmation by	For Command to be	From the confirmation	
10021	TC(191,255)	confirmed.	narameters:	
	10(1)1,255)	Bit 8-15: type	Bit 8-15: type	
		bit 0-7: Subtype	bit 0-7. Subtype	
40022	Invalid mode definition	Upmost address for the c	lata storage of invalid mode	
40026	Macro execution succesful	Macro number	0	
40027	Macro terminated by TC	Macro number	Command index in macro	
			command buffer	
40028	Macro Checksum error in	Calculated checksum	Checksum in EEPROM	
	EEPROM			
40029	Macro Can't start			
40074	IMA command buffer full			







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Event	Event name	Parameter 1	Parameter 2	Description
number				_
40092	Scanner initialized			
40097	Scanner error	2: Communication test		
		failed before		
		initialization		
		3: Initialization failed.		
		4: Can't start scanner		
		properly		
5		5: Scanner not stopped		
	proper	properly		
		6: Scanner not		
		initialized		
		7: Can't escape		
		endposition on		
		initialization		
		8: Science not enabled		





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#### HOUSEKEEPING TELEMETRY 6

#### General 6.1

The ASPERA-4 Main Unit have one type of housekeeping (HK) packet which contains all HK signals and parameters.

#### 6.2 HK packet source data field

#### 6.2.1 Source data field for Main Unit

#### 6.2.1.1 Generic structure

After headers, there will be the source data field. For the HK report packet, it will be as shown below.

Byte	Bits	Field	Note		
Source data field					
16		PAD	for TM(3,25) always 0		
17		SID			
18-119		Parameters	Full HK packet		

The SID field contains an identifier telling which type of HK packet is being sent. For the Main Unit the full Housekeeping packet is identified by setting SID to 0. For IMA SID=10. They can also be recognised by examining the application id field.

### 6.2.1.2 Full Housekeeping Packet

The full HK packet will have the following format. Bit number 0 will be the LSB (i e numbering is NOT the same as defined in the SGICD). If not otherwise stated, the fields will contain exactly the value read from hardware.

Byte	Bits	Field	Note
18		els_temp	
19		npd1_temp	
20		npd2_temp	
21		npi_temp	
22		scanner_temp_sensor	
23		PAD	
24-25		sw_version	Software version
26		els_minus_5v_screen_grid_ref	sw monitored
27		els_minus_5v_screen_grid_mon	
28		els_bias_mcp_ref	sw monitored
29		els_bias_mcp_mon	
30-31	13-15	PAD	
	12	els_plus_30v_on_off	
	11	els_enable_hv	sw monitored
	9	PAD	
	8	els_range	sw monitored
	0-7	ELS deflection voltage sweep table number	sw_monitored
32		hk_i_plus_30v	
33		hk_i_plus_5v	







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Byte	Bits	Field	Note
34		hk_v_plus_12v	
35		hk_v_plus_30v	
36		hk_v_plus_5v	
37		hk_v_minus_12v	
38		hk v minus 5v	
39	7	NPD1 defl switch	
	6	NPD2 defl switch	
	5	Sun sensor 2	
	4	Sun sensor 1	
	3	PAD	
	2	npd heaters on off	sw monitored
	1	npd1 plus 30v on off	
	0	npd2 plus 30v on off	
40	-	npd1 bias mon	
41		npd1 bias ref	sw monitored
42		npd1 defl mon	
43		npd1_defl_ref	sw monitored
44		npd1 start bias mon	
45		npd1_start_bias_ref	sw monitored
46		npd1_stop_bias_mon	50 montored
47		npd1_stop_bias_ref	sw monitored
48		npd1_stop_olds_lol	swiniontoica
10		npd1_minetrl	
50-51		npd1_maneur	
52 53		npd1_tderd	
54 55		npd1_calib11	
56 57		npd1_calib12	
58 50		npd1_calib21	
60.61		npd1_calib22	
62 63		npd1_cdfb22	
64 65		npd1_defeent	
66		npd1_dereent	
67		npd2_biog_rof	any monitored
68		npd2_dofl_mon	sw momored
60		npd2_defl_mon	sw monitored
09 70		npd2_deff_fer	sw monitored
70		npd2_start_bias_mon	swinointoied
71		npd2_stan_bias_mon	
72		npd2_stop_bias_mon	sw monitored
73		npd2_stop_olds_ici	sw momored
74		npd2_monetrl	
76 77		npd2_maneur	
70-77		npd2_stat	
70-79 80.81		npd2_calib11	
00-01		npd2_calib12	
02-03		npd2_calib21	
04-03		npd2_callb21	
80-87		npd2_call022	
00.01		npd2_selectit	
90-91		npu2_uercent	
92		npi_bios_mon	sw monitored
93	+	npi_olas_liloli	any monitored
94	-		sw monitored
93	7	npi_deni_mon	and an an ite and
90	1	npi_pius_3UV_on_oII	sw monitored
	0	npi_defi_switch	sw monitored
	5	np1_def1_mode	sw monitored
1	3-4	SPARE4	







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Byte	<b>Bits</b>	Field	Note
-	2	ima_plus_minus_12v_on_off	sw monitored
	1	ima_plus_30v_on_off	sw monitored
	0	ima_plus_minus_5v_on_off	sw monitored
97		scanner_vrefmc	
98	7	scanner_status_ccw_end_pos	
	6	scanner_status_cw_end_pos	
	5	scanner_status_pos_clock	
	4	scanner_status_direction	0: 0 - 180 1: 180 - 0
	2-3	scanner_status_state	0: Not busy 1: ramp up
			2: Full speed move 3: Ramp down
	1	Lost step	
	0	scanner_initialized	
99	7	scanner_plus_30v_on_off	
	5-6	PAD	
	4	scanner_setup_mode	0: normal 1: manual
	3	scanner_setup_direction	0: 0 - 180 1: 180 - 0
			for manual mode speed command only
	2	PAD	
	0-1	scanner_speed	0: STOP 1: 32s scan
			2: 64s scan 2: 128s scan
100		scanner_coast_current_ref	
101		scanner_ramp_current_ref	
102		scanner_treshold_cw_ref	
103		scanner_treshold_ccw_ref	
104		scanner_treshold_wheel_ref	
105		scanner_position	
106		sw_mode	sw monitored
107		cpu_load	sw monitored
108-		ELS sector mask	sw monitored
109			
110-	8-15	ELS compression scheme (ie. defines mode)	sw monitored
111	0-7	ima_link_status	Bitfield is best explained in document called
			'Rosetta RPC PIU Interfaces document. Part II
			- Data handling interfaces'. In short, it
			contains status register of IEEE 1355 LINK
			Chip.
			Bit: 7: ndata0A
			Bit 6: crdMEM
			Bit 5: datav
			Bit 4: resetm
			Bit 3: ffrx
			Bit 2: EOP1
			Bit 1: ndata0
			Bit 0: nm1
			In typical nominal operation one should find
			value 0x41 on the link when link is working
112		NDL Geoteenseel	properly.
112-		NPI Sector mask	
115	7 15		
110-	/-15	rau NDI Mada	
11/	0	INPI MODE	21.05*0 <sup>n-1</sup>
	2-5	NPI Accumulation time	51.25mS*2
	1	NPI LOg compression enabled	
110	0	NPI KICE compression enabled	
118	/	rad	







Byte	<b>Bits</b>	Field	Note
	6	NPD RICE compression enabled	
	5	NPD Log compression enabled	
	0-4	NPD Accumulation time	
119	4-7	NPD2 mode	0: not in use
	0-3	NPD1 mode	1: raw data
			2: bin matrix (0 0 0)
			3: bin matrix (0 0 1), (0 1 0) or (1 0 0)
			4: bin matrix (0 0 2), (0 2 0) or (2 0 0)
			5: bin matrix (0 1 1), (1 0 1) or (1 1 0)
			6: bin matrix (0 1 2), (1 0 2), (0 2 1),
			(1 2 0), (2 0 1) or (2 1 0)
			7: bin matrix (0 2 2), (2 0 2) or (2 2 0)
			8: bin matrix (1 1 1)
			9: bin matrix (1 1 2), (1 2 1) or (2 1 1)
			10: bin matrix (1 2 2), (2 1 2) or ( 2 2 1)
			11: bin matrix (2 2 2)
			12: phd mode
			13: tof mode
			NOTE Although and a time tables for the
			NOTE: Although reduction tables for bin
			matrixc can be defined independendently all
			default modes in macros are defined so that
			bin matrix is of type (0 0 0), (1 1 1) or (2 2 2)
			for both NPDs simultaneosly.

There are a few spare bits. They are used to align 8 bit signals to 8 bit fields. Spare bits can be allocated later for some other use.

Software signal fields:

\*ref: All values named \*ref are monitored by software. They represent values written to some hardware register, typically values commanded by TC.

sw\_version: sw\_version is one 16-bit number defining the software version. It is included in every private tecommand packet originating in MU and in MU HK packets. S/W mode is constructed as follows:

Bits	Name	Description
14-15	Release class	0: N/A 1: D (development) 2: T (Testing version) 3: R (Release, official and stable revision)
9-13	Major	
4-8	Minor	
0-3	Patch number	

For example, Version number 0xC871 means s/w version R-4.7.1 (Release, major=4,minor=7, and patch number =1)

cpu\_load: N/A

sw\_mode: sw\_mode defines software mode



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### 7 INSTRUMENT SOFTWARE MODES

SW Mode	Mode name
1	Booting
2	Safe
3	Prom
4	Normal

#### 7.1 Instrument modes

Instrument modes are defined in housekeeping packet just by reporting corresponding settings one by one.



#### 8 IMA TELEMETRY

#### 8.1 Source data field for IMA

After headers, there will be the source data field. For the HK report packet, it will be as shown below:

Byte	Bits	Field	Note		
Source	Source data field				
16	8-15	PAD	PAD=0		
	0-7	SID	SID=10		
18-41		IMA Housekeeping packet data (24 bytes)			

The content of the IMA Housekeeping packet data is defined by the IMA team and can be found in the ICA-IMA TC/TM Data Formats and Related Software Aspects Document issued by Hans Borg at IRF dated 2002-04-07. The content of the source data field is exactly the same as the data fields of 4 link packets sent by IMA to the MU.

### 8.2 IMA HK definition

Word	Bits.	Content.	Table	Parameter.
offs.			pos.	
0	15-10	Mode. See below.	0	mode
	9-8	Cmd status	9	hk_prm
		0=Ok (Ok)		
		1=Invalid (Inv)		
		2=Out of range (Out)		
		3=Erroneous (Err)		
	7-0	HV switches	10	ad_prm
	7	Deflection HV logical (ref)		<u> </u>
	6	Deflection LV logical (ref)		
	5	Entrance HV logical (ref)		
	4	Grid LV logical (ref)		
	3	Pacc HV logical (ref)		
	2	+28V main		
	1	+28V opto		
	0	+28V mcp		
1	15	Cmd toggle (Numeric 0/1)	12	hk_prm
	14-12	SID no	1	Sid_nr
	0	Minimum (Min)		
	1	Normal (Nrm)		
	2	Burst (Bst)		
	3	Calibration (Cal)		
	4	Special (Spc)		
	5	Test (Tst)		
	11-8	+28V presence	11	ad_prm
	11	HV enable/disable		
	10	Main		
	9	Opto		
	8	Мср		
	7-0	Fifo filling (F8)	2	fifo fill
2	15-0	Cmd return (Numeric hex)		direct from tc_decoder
3	15-8	Opto HV monitor	13	ad_prm
	7-0	Mcp HV monitor	14	ad_prm
4	15-8	Deflection HV monitor	15	ad_prm



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Word	Bits.	Content.	Table	Parameter.
offs.			pos.	
	7-0	Deflection LV monitor	16	ad_prm
5	15-8	Pacc HV monitor	17	ad_prm
	7-0	Grid LV monitor	18	ad_prm
6	15-8	Sensor temperature. (Sns)	19	ad_prm
	7-0	DPU temperatur. (Dpu)	20	ad_prm
7	15	Direct command switch	3	switches
	14-12	Pacc low level (ref.)	4	dta_12bit[3]
	11-0	Deflection HV reference	21	dig_dflhv
8	15	Alt. Pacc (Opera=Fix/Alt)	5	switches
	14-12	Pacc high level ref.	6	dta_12bit[4]
	11-0	Deflection LV reference	22	dig_dfllv
9	15	Pacc level (High/Low)	23	ms.flag
	14-12	Grid LV reference	24	dta_12bit[2]
	11-0	Entrance HV reference	25	dig_entr
10	15	Deflection HV (Opera=Stp/Fix)	26	switches
	14-12	Opto default reference	7	dta_12bit[0]
	11-9	Mcpdefault reference	8	dta_12bit[1]
	8-0	Entrance upper HV monitor	27	ad_prm
11	15	Entrance HV (Opera=Stp/Fix)	28	switches
	14-12	Opto current reference	29	Optocur
	11-9	Mcp current reference	30	Mcpcur
	8-0	Entrance lower HV monitor	31	ad nrm







# 8.3 IMA scientific TM modes

Mode	Mnemonic	Comments
Minimum		
0	Idle	
1	Mmom	Moments only
2	Mspo	Spectras only
3	Mmsp	Moments and Spectras
4	Msis	Selected Ion Species
5	Mexm	Energy Mass matrix
6	Void	
7	Void	
Normal	•	•
8	Nrm0	Normal 0
9	Nrm1	
10	Nrm2	
11	Nrm3	
12	Nrm4	
13	Nrm5	
14	Nrm6	
15	Nrm7	
Burst	•	
16	Har0	High angular resolution 0
17	Har1	
18	Har2	
19	Har3	
20	Har4	
21	Har5	
22	Har6	
23	Har7	
24	Exm0	Energy Mass matrix 0
25	Exm1	
26	Exm2	
27	Exm3	
28	Exm4	
29	Exm5	
30	Exm6	
31	Exm7	
Special		
32	Test	
33	Cal1	Calibration 1
34	Cal2	Calibration 2
35	Fake	Faked science data
36	Void	
37	Void	
38	Void	
39	Void	



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Fifo filling must be unpacked by int unpack\_f8 (int acc)

```
int Astat5a::unpack_f8(int acc)
{
    int exp;
        exp=(acc >>4) &0xF;
        if(exp>1) {
            acc=(acc & 0xF) | 0x10;
            acc=acc<< (exp-1);
        }
        return acc;
}</pre>
```



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#### 9 **SCIENCE DATA**

#### 9.1 Science data production modes

#### 9.2 Science data packet formats

All packages will have the normal TM header and Data field header in front of the package.

The Lossy compression scheme will be used only if the RICE (lossless) compressed package is larger than the packet size.

If the measurement mode is changed before the data for one packet is completely measured, the packet will be cut on the starting place of invalidity. Hence, the data sent to the ground is valid (in this sense) but the set is not necessarily complete. This can be identified by the packet length (in the uncompressed case it's smaller than normal) or as a smaller amount of decompressed data (in compressed case). Of course, this kind of recovery is not always possible.

#### 9.3 Science data packet types

The Science packets produced in the Main Unit have data types and subtypes. The data Type (4bits) defines mainly an instrument the packet is related to and the subtype (4bits) specifies the packet type within an instrument packet. Packet types and subtypes are allocated as follows.

The Main Unit will also format telemetry packets coming from IMA. These will be formatted to the ESA packet TM format and sent to the s/c. Science data coming from IMA is not analyzed by any means in the Main Unit.

Data	Data	Data type name	Description
Туре	subtype		
0	0	Dummy	Doesn't contain anything meaningful
ELS Date	a Packages		
1	0	ELS Engineering information	First ELS packet within one scan cycle. Contains
			engineering information needed for analysis of ELS
			data. No science data included
	1	ELS Complete sweep	Data from one complete sweep included
	2	ELS Sweep step 0-63	Data from first 64 steps in one sweep
	3	ELS Sweep step 64-127	Data from latter 64 steps in one sweep
NPD1 data packages			
2	0	NPD raw data	NPD1 data produced in raw data mode
	1	NPD binning data	NPD1 data produced in bin matrix mode
	2	NPD TOF mode	NPD1 data in Time-of-Flight mode
	3	NPD PHD mode	NPD1 data in Pulse height distribution mode
NPD2 da	ta packages		
3	0	NPD raw data	NPD2 data produced in raw data mode
	1	NPD binning data	NPD2 data produced in bin matrix mode
	2	NPD TOF mode	NPD2 data in Time-of-Flight mode
	3	NPD PHD mode	NPD2 data in Pulse height distribution mode
NPI data	packages		
4	0	NPI Normal mode data	NPI data in normal mode
	1	NPI Stepping mode	NPI data in deflection voltage stepping mode
Engineer	ring data pao	ckages	
5	0	Solar sensor information	Status of Solar sensor 1&2 in each sample irq
			during one scan.
	1	Scanner information	Scanner position on each sample irq in one scan.



### 9.3.1 IMA telemetry packets

IMA telemetry packets will be sent almost as they are received in the Main Unit. The structure of the IMA telemetry packets are as follows. The time tag of the TM packet will be the time of receiving the first link packet from IMA. Time will be the same for all packets built from the same IMA packet.

Byte	Bits	Field	Subfield	Remark
16		Error status	0: No errors identified by MU	
			others: first invalid word in IMA	
			data	
17		IMA SID		
18-last		IMA packet		Maximum 2046 words of IMA
				telemetry packet

### 9.3.2 ELS telemetry packets

An ELS data packet can contain a maximum of 128 steps \*16 sectors = 2048 words of (16-bit) raw data. Based upon whether compression is enabled or not, the data may fit in a single packet or may have to be split into 2 packets, with each packet comprised of 64 steps. The following table represents the ELS packet header that is common to all ELS packets.

Byte	<b>Bits</b>	Field	Subfield	Remark
16-17		Science data Header	SW version	
18-19	8-15		Spare	
	4-7		Data type	1 = ELS Packet
	2-3		PAD	
	0-1		ELS packet subtype	0 = ELS engineering information
				1 = ELS data steps 0-127
				2 = ELS data steps 0-63
				3 = ELS data steps 64-127
20-25			SCET Time	On start of first sweep (i e 'engineering'
				sweep) in this scan
26-27			ELS sector mask	
28	7	ELS compression	Spare	
	6	scheme	Rice compression	
	5		Log compression (16 to 8 bit)	Note: If RICE compression is used,
				values will be 16bits in width, but the
				range for the value is 0-255. This is to
				optimize both performance and
				compression.
	3-4		Energy compression	0=1 step, $1=2$ steps,
				2=4 steps, $3=$ undefined
	0-2		Time compression	0=1 sweep, 1=2 sweeps,
				2=4 sweeps, 3=8 sweeps,
				4=16 sweeps, 5-7=undefined
29			spare	





#### 9.3.2.1 ELS engineering information

In the beginning of every scan cycle, some engineering information is sent in a separate ELS science packet. This information is needed for the analysis of the ELS science data that is returned during that scan cycle. This packet is built in the following way, starting from byte 30.

Byte	<b>Bits</b>	Field	Subfield	Remark
30	3-7		Spare	
	2		Scanner direction	0 = 0 - 180
				1 = 180 - 0
	0-1		Scanner speed	0 = standing
				$1 = 32s \operatorname{scan}$
				$2 = 64s \operatorname{scan}$
				$3 = 128s \operatorname{scan}$
31			Scanner position	On start of scan (or step) period
32		ELS Status	PAD	
33			ELS temperature	
34			ELS MCP reference	
35			ELS MCP monitor	
36			ELS Screen grid reference	
37			ELS Screen grid monitor	
38-39			ELS Deflection reference step1	
40-41			ELS Deflection monitor step 1	
42-43			ELS Deflection ref. step 2	
44-45			ELS Deflection mon. step 2	
Etc				
546-			ELS Deflection ref. step 128	
547				
548-			ELS Deflection mon. step 128	
549			-	

### 9.3.2.2 ELS data

After the first packet of ELS engineering data is sent, the remaining ELS packets will contain ELS science data. There are three types of packets: (1) one containing data from one complete sweep (128 steps), (2) one containing the first 64 steps from one sweep, and (3) one containing the latter 64 steps from one sweep. All ELS packets will be sent in a row so it's possible to find the order of these packet from the Packet sequence count field. In this case, the packet will be as follows:

Byte	<b>Bits</b>	Field	Subfield	Remark
30	3-7		Spare	
	2		Scanner direction	0 = 0 - 180
				1 = 180 - 0
	0-1		Scanner speed	0 = standing
			_	$1 = 32s \operatorname{scan}$
				$2 = 64s \operatorname{scan}$
				3 = 128s scan
31			Scanner position	On start of scan (or step) period
32		Data	Sector 0, step 1, sweep 1	Data from one sweep. If no log, energy
			Sector 1, step 1, sweep 1	nor sectormask type of comresssion is
				applieed to the data it will be divided to
			Sector 0, step 2, sweep 1	two parts. (ELS data packet subtypes 2
			Sector 1, step 2, sweep 1	and 3). In this case both packets will
				have same time tag on packet bytes 6-
				11. However, sequence count will
				differ between these two packets.



Byte	Bits	Field	Subfield	Remark

#### 9.3.3 NPD telemetry packets

Byte	Bits	Field	Subfield	Remark
16-17		Science data Header	SW version	
18			spare	
19	4-7		Data type	2 = NPD1 packet
				3 = NPD2 packet
	0-3		NPD packet subtype	0 = NPD raw data
				1 = NPD binning data
				2 = NPD TOF mode
				3 = NPD PHD mode

# 9.3.4 NPD Raw data packet

Because raw data events are 25 bit in width and the compression scheme used is 16 bit RICE, one has to do a trick in order to make the compression as effective as possible. These 25 bit events are divided in the packet into two separate 'data streams', both containing 512 words.

Stream\_1 words will have following structure.

Byte	Bits	Field	Subfield	Remark
0-1	5-15	Stream_1 word	TOF	
	3-4		Direction	
	0-2		Coincidence	

Stream\_2 words will have the following structure.

Byte	Bits	Field	Subfield	Remark
0-1	8-15	Stream_2 word	PAD	
	0-7		Stop PH	

The overall structure for the NPD raw data packet will be as follows.

Byte	Bits	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26-27	8-15	Scanner information	Scanner position	In the beginning of sample
	3-7	block	PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28			PAD	
29	4-7	NPD bit information	Accumulation time	Time = $2^{N} * 31.25$ ms
	2-3	-	PAD	
	1		Log compression enabled	Always 0 for raw data mode (0 = disabled)
	0	-	RICE Compression enabled	
30		NPD Registers	FRONTCTRL	
31			MAINCTRL	
32-33			STAT	
34-35		-	TDCRD	
36-37			CALIB11	
38-39			CALIB12	
40-41			CALIB21	
42-43			CALIB22	



Byte	Bits	Field	Subfield	Remark
44-45			STARTCNT	
46-47			STOP0CNT	
48-49			STOP1CNT	
50-51			STOP2CNT	
52-53			TOFCNT	
54-55			RAWCNT	
56-		Data	Stream 1:	If applied, RICE compression is used in
			512 * Stream_1 words	'one-shot' over both streams.
			Stream 2:	If applied, RICE compression is used in
			512 * Stream_2 words	'one-shot' over both streams.

### 9.3.4.1 NPD Bin matrix data packet

The NPD Bin matrix data packet will contain data from 768 bin counters. The data will be ordered so that bin number 0 is the first one found in the packet.

Byte	<b>Bits</b>	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26		Scanner block	Scanner position	In the beginning of this sample.
		information		
27	3-7		PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28			PAD	
29	4-7	NPD Bit information	Accumulation time	Time = $2^{N} * 31.25 ms$
	2-3		PAD	
	1		Log compression enabled	0 = disable
				1 = enable
	0		RICE Compression enabled	0 = disable
				1 = enable
30-31	12-15	Treshold values	PAD	
	8-11		Treshold 3	$0 = \text{Matrix } 0, 16 \times 16$
	4-7		Treshold 2	1-14 = Matrix 1, 2x16
	0-3		Treshold 1	15 = Matrix 2, 1x16
32-33		NPD Registers	CALIB11	
34-35			CALIB12	
36-37			CALIB21	
38-39			CALIB22	
40-41			STARTCNT	
42-43			STOP0CNT	
44-45			STOP1CNT	
46-47			STOP2CNT	
48-		Data	Bin number 0x000	Might be RICE compressed
		1	Bin number 0x001	Number of bins returned is dependent
			Etc	upon the threshold mode, so the



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Byte	<b>Bits</b>	Field	Subfield	Remark
			Bin number 0x2ff	maximum number of bins returned
				would be $16x16x3 = 300$ bins (0x000)
				to $0x2ff$ ).
				The 3 represents the number of
				directions.
				In case of 1x16 matrices count for
				lowest tof value is sent first.
				In case of 2x16 matrices lowest tof
				value in hydrogen region is sent frist.
				16 <sup>th</sup> element is lowest tof value in
				oxygen region.

# 9.3.4.2 NPD TOF mode data packet

When NPD is run in the special TOF mode, the data will be packeted into TOF mode packets which contain 3 different 'TOF' tables.

Byte	Bits	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26-27	8-15	Scanner information	Scanner position	In the beginning of sample
	3-7	block	PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28			PAD	
29	4-7	NPD bit information	Accumulation time	Time = $2^{N} * 31.25 ms$
	2-3		PAD	
	1		Log compression enabled	0 = disable
				1 = enable
	0	-	RICE Compression enabled	0 = disable
				1 = enable
30			Number of (valid) samples	Latchups may happen during
			integrated to the matrix	integration. Affected samples are not
				integrated to the matrix.
31			PAD	
32-33		NPD Registers	CALIB11	
34-35			CALIB12	
36-37			CALIB21	
38-39			CALIB22	
40-41			STARTCNT	
42-43			STOP0CNT	
44-45			STOP1CNT	
46-47			STOP2CNT	
48-		Data	First data word in TOF mode	768 data words (or bytes), Might be
				RICE compressed







### 9.3.4.3 NPD PHD mode data packet

When NPD is run in the special PHD mode, the data will be packeted into PHD mode packets which contain the least significant bytes of the stoparray.

Byte	Bits	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26-27	8-15	Scanner information	Scanner position	In the beginning of sample
	3-7	block	PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28			PAD	
29	4-7	NPD bit information	Accumulation time	Time = $2^{N} * 31.25$ ms
	2-3		PAD	
	1		Log compression enabled	Always 0 for PHD mode
				(0 = disabled)
	0		RICE Compression enabled	
30-31			PAD	
32-33		NPD Registers	CALIB11	
34-35			CALIB12	
36-37		-	CALIB21	
38-39			CALIB22	
40-41			STARTCNT	
42-43			STOP0CNT	
44-45			STOP1CNT	
46-47			STOP2CNT	
48-		Data	Least significant byte of	48 data bytes (or bytes), Might be
			STOPARRAY channel 0	RICE compressed
			Least significant byte of	
			STOPARRAY channel 1	
			Least significant byte of	
			STOPARRAY channel 47	

#### 9.3.5 NPI telemetry packets

One NPI telemetry packet will consist of 32 samples. This leads to 32 samples\*32sectors = 1024 words of raw 16 bit data. This data can be compressed. Whether the packet is compressed or uncompressed can be determined using the NPI compression flags that are returned in the MU full housekeeping packet and in byte 28 of the NPI science packet.

Byte	Bits	Field	Subfield	Remark
16-17		Science data Header	SW version	
18			PAD	
19	4-7		Data type	4 = NPI packet
	0-3		NPI packet subtype	0 = NPI data (normal mode)
				1 = NPI data (defl stepping mode)



# 9.3.5.1 NPI normal mode data packet

Byte	Bits	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26-27	8-15	Scanner information	Scanner position	In the beginning of sample
	3-7	block	PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28	4-7	NPI bit information	Accumulation time	Time = $2^{N} * 31.25 ms$
	2-3		PAD	
	1		Log compression enabled	0=disabled
				1=enabled
	0		RICE Compression enabled	0=disabled
				1=enabled
29			Sample Number	Number of samples in packet (max=32)
30-33			NPI Sector mask	
34-		Data	Sample 0, sector 0	Might be RICE compressed
			Sample 0, sector 1	
			Sample 31, Sector 31	

# 9.3.5.2 NPI Deflection stepping mode data packet

Byte	Bits	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26-27	8-15	Scanner information	Scanner position	In the beginning of sample
	3-7	block	PAD	
	2		Scanner direction	
	0-1		Scanner speed	
28	4-7	NPI bit information	Accumulation time	$Time = 2^{N} * 31.25ms$
	2-3		PAD	
	1		Log compression enabled	0=disabled
				1=enabled
	0		RICE Compression enabled	0=disabled
				1=enabled
29			Sample Number	Number of samples in packet (max=32)
30-33			NPI Sector mask	
34-37			NPI deflection status mask	
38-		Data	Sample 0, sector 0	Might be RICE compressed
			Sample 0, sector 1	
			Sample 31, Sector 31	



### 9.3.6 Engineering telemetry packets

There are two packets of 'engineering type' packets; the solar sensor information packet and the scanner information packet. Solar sensor information is a readout of the solar sensors in each sample interrupt during one scan cycle. The Scanner position packet reports on the scanner position on each sample irq during one scan cycle.

Byte	Bits	Field	Subfield	Remark
16-17		Science data Header	SW version	
18			PAD	
19	4-7		Data type	5 = Engineering packet
	0-3		Engineering packet subtype	0 = Solar sensor information
				1 = Scanner information

#### 9.3.6.1 Solar sensor information packet

Byte	<b>Bits</b>	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26			Scanner position	At start
27	7		PAD	
	6		Scanner direction	
	4-5		Scanner speed	
	1-3		PAD	
	0		RICE compression enabled	
28-	7		Solar sensor 1 status pos 0	
	6		Solar sensor 2 status pos 0	
	1		Solar sensor 1 status pos 3	
	0		Solar sensor 2 status pos 3	
Last	7		Solar sensor 1 status pos last-3	
	6		Solar sensor 2 status pos last-3	
	1		Solar sensor 1 status pos last	
	0		Solar sensor 2 status pos last	

#### 9.3.6.2 Scanner information packet

Byte	<b>Bits</b>	Field	Subfield	Remark
20-25			Sample start time (SCET)	
26			Scanner position	At start
27	7		PAD	
	6		Scanner direction	
	4-5		Scanner speed	
	1-3		PAD	
	0		RICE compression enabled	
28-		Data	Scanner position 0	Up to 2048 positions (each is 1 byte),
			Scanner position 1	which corresponds to 64sec. Can be
				RICE compressed.
			Scanner position last	







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# APPENDIX 5. NPD RAW DATA STRUCTURE

# **DigTOF in ASPERA/NPD**

This documents contains a description of the DigTOF-electronics for ASPERA/NPD.

Version 1.0

# History

Issue	Pg.	Date	Changes	Orig
0.1	all	04/09/00	first edition	cd
0.2	all	11/06/01	typos corrected reset of single FPGA counters replaced by common reset Register ADCRST added flag STAT. TDCWRERR added flag STAT. TDCRDERR added flag STAT. TDCCMDERR added flag STAT. ADCERR added switch FRONTCTRL.ADCCALDIS added flag MAINCTRL. LATCHUP added Register LURST added Register IFTEST added SRAM burst readouts: exceeding of read accesses are shown now coincidence changed, also default value for COINBDRS has changed CALNO: precision increased DACCMD: Channel numbering changed from 1,2,3, to A, B, C, Burst Readout: range overflow is shown by 0x5555 now Appendix entries deleted LATCHUP implemented	cd
0.3	All	17/01/02	Hamming-Code Error Correction for memory data on FM board added Switch MAINCTRL.ECENA added Counter SEFCCNT implemented Counter DEFCCNT implemented	cd
1.0	All	17/01/02	numbering of document sides corrected	cd

# Overview



The tasks of the DigTOF-electronics are:

- TOF measuring from one start to one out of three stop signals
- serving of the preamplifier board and initiating analog/digital conversion of stop pulseheight
- coincidence check and selection of valid TOF Stop pulseheight pairs
- counting of events
- buffering of three different data types in SRAM
- interfacing DigTOF to the DPU


## Logic Implementation

The occurance of a start, followed by a stop signal leads to a  $\Delta t$ -measurement in the TDC (Time to digital converter) and a pending generation of a data item with uncorrected  $\Delta t$ -information. The task of the TMU (TDC management unit) is to handle the TDC, mainly read data from this and correct these values. Prior to any correction process, the necessary parameters have to be determined. This will be done with the calibration process (see calibration). The output of the TMU is a TOF value with 12 bit binary time information. In parallel to this, the occurance of a stop signal will be followed by a sampling process to the preamplifier ADC, thus a 10bit data item with information of both direction and 8-bit stop pulseheight will be generated. The coincidence control then checks for a valid coincidence of these two data items and additionally flags the occurance of more then one start or stop signal during  $\Delta t$ -measurment. This now leads to a 25-bit raw data item that will be used for the pending storing process. The memory control has to handle three different memory areas in the SRAM. For the binning array, the raw data will be compressed to a 10 bit data (see compression), that represents the bin number inside the destinated array. The respective bin will be incremented by one up to the bin depth of 65536 (16 bit). For the raw data array, incoming raw data items will sequently be stored until this array is filled completely. The stop counter array will be filled in the same way as the binning array, but with the compressed stop pulseheight together with the respective direction. All data arrays will be filled in parallel (binning array will be excluded if coincidence level does not fit). Readout and the following initialization of these arrays will be done with burst read access from the DPU. Besides the stop counter array, 16-bit event counters and two registers facing the preamplifier board are implemented in the FPGA. One of this registers will be used to program the DAC on the preamplifier board, the other for directly commanding the preamplifier electronics. All control-, counter- and memory- data will be accessed from the DPU over 16-bit registers (see registers), physically the connection to the DPU is a 16-bit bus (see description of the DPU-Interface).

There is a linear relationship between the TDC values and the TOF, with parameters mainly depending on temperature and voltage. They have to be known to the DigTOF electronics, in order to perform correction of the TDC values. Determination of these parameters will be done by stimulation the TDC with two known time differences from a calibration clock. The resulting TDC values will than be used in the DPU to calculate gain and offset, which afterwards will be written into DigTOF. This calibration process has to be repeated within a given time to obtain a specified precision.

The goal is to obtain a binary TOF data

$$N = \frac{T}{\ln s},$$

this originates from the TDC value M with following relation:

$$N(t) = O + G \cdot M(t) \, .$$



With the measured TDC calibration values

$$M1 = CAL12 + \frac{CAL11}{16384},$$
  

$$M2 = CAL22 + \frac{CAL21}{16384},$$
  

$$N1 = \frac{TCAL}{1ns},$$
  

$$N2 = 2 \cdot \frac{TCAL}{1ns},$$

the gain G and offset O to transform the TOF-values can be calculated:

$$G = \frac{N2 - N1}{M2 - M1},$$
$$O = Nv - G \cdot Mv \qquad ; v = 1;2$$

With respect to the position of the comma (see registers), these two values have to be written into DigTOF.

## Data buffering

DigTOF buffers three different data items in dedicated memory areas:

#### 1. Binning Array

This array contains 1024 bins, each with a depth of 65536 (16-bit). Data items fitting a dedicated bin will increment its counter by one up to the upper limit of 65536. Readout of this area will be done by write access to the respective register, followed by 1024 read accesses.

The bin number has following relation to its contents:

Bin Array [10230]			
Bit[9:8]	Bit[7:4] Bit[3:0]		
DIR[1:0]	STOP PH COMPRESSED[3:0]	TOF COMPRESSED[3:0]	

(see compression)

#### 2. Raw Data Array

This array contains 512 data places, each with a width of 32-bit. Incoming raw data items will sequently be stored until this array is filled completely. Readout of this area will be done by write access to the respective register, followed by 1024 read accesses.

Storing sequence: upper 16-bit, lower 16-bit

Raw Data[310]					
Bit[31:25]	Bit[24	:22]	Bit[21:20]	Bit[19:12]	Bit[11:0]
n.c.	COIN	[2:0]	DIR[1:0]	STOP PH [7:0]	TOF [11:0]
	00 1 Start	, 1 Stop 0	Stop0		in 0.5ns steps
	01 n Start	, 1 Stop 1	Stop1		
	02 1 Start	, n Stop 2	Stop2		
	03 n Start	, n Stop			
	04 0 Start	, 1 Stop			
	n = 2, 3,				

#### 3. Stop Counter Array

This array contains 48 bins, each with a depth of 65536 (16-bit). Data items fitting a dedicated bin will increment its counter by one up to the upper limit of 65536. Readout of this area will be done by write access to the respective register, followed by 48 read accesses.

The bin number has following relation to its contents.

Stop Counter Array [470]			
Bit[5:4] Bit[3:0]			
DIR[1:0]	STOP PH COMPRESSED[3:0]		

TOF:

## *||DA*|

## **Data Compression**

To reduce the amount of data, the 12-bit TOF and the 8-bit Stop values are compressed according to the following rule:

TOF[11:0]		TOF COMPRESSED[3:0]
100 - 124	$\rightarrow$	0
125 - 156	$\rightarrow$	1
157 - 197	$\rightarrow$	2
198 - 248	$\rightarrow$	3
249 - 311	$\rightarrow$	4
312 - 391	$\rightarrow$	5
392 - 491	$\rightarrow$	6
492 - 617	$\rightarrow$	7
618 - 774	$\rightarrow$	8
775 - 972	$\rightarrow$	9
973 - 1220	$\rightarrow$	10
1221 - 1532	$\rightarrow$	11
1533 - 1923	$\rightarrow$	12
1924 - 2413	$\rightarrow$	13
2414 - 3028	$\rightarrow$	14
3029 - 3800	$\rightarrow$	15

STOP:	STOP PH[7:0]	STOP PH	COMPRESSED[3:0]
	0 - 15	$\rightarrow$	0
	16 - 31	$\rightarrow$	1
	32 - 47	$\rightarrow$	2
	48 - 63	$\rightarrow$	3
	64 - 79	$\rightarrow$	4
	80 - 95	$\rightarrow$	5
	96 - 111	$\rightarrow$	6
	112 - 127	$\rightarrow$	7
	128 - 143	$\rightarrow$	8
	144 - 159	$\rightarrow$	9
	160 - 175	$\rightarrow$	10
	176 - 191	$\rightarrow$	11
	192 - 207	$\rightarrow$	12
	208 - 223	$\rightarrow$	13
	224 - 239	$\rightarrow$	14

 $\rightarrow$ 

15

240 - 255

## **DigTOF-handling / Software**

The handling of the DigTOF-electronics will be done with a few macros. This chapter gives a rough overview over the steps to be made when performing special tasks. The extracts (appendix) from the EGSE S/W @ IDA give more specified information.

#### Setup

- Reset NPD electronics (H/W reset)
- Initialize Actel control register
- Initialize TDC Glob register
- Set TDC into measurement mode 1
- Write max and min borders for coincidence part
- Program DAC 0
- Program DAC 1
- Program DAC 2
- Program DAC 3
- Write Preamp Control Register
- (Perform calibration)
- Enable TDC

#### Main DPU Task (Calibration+HK+Science data readout)

- Enable TDC input for calibration
- Disable Storing into SRAM
- Read Start Counter
- Read Stop0 Counter
- Read Stop1 Counter
- Read Stop2 Counter
- Read TOF Counter
- Read RAW Counter
- Reset FPGA Counter
- Read Stop Counter array
- Set TDC into calibration mode
- Read Binning array (if this is desired)
- Read Raw data array (if this is desired)
- Read Calibration register
- Calculate Gain and Offset
- Write Gain and Offset
- Set TDC back into measurement mode 1
- Enable TDC input for measurement
- Enable Storing into SRAM

#### Calibration

- Enable TDC input for calibration
- Set TDC into calibration mode
- Wait
- Read Calibration register
- Calculate Gain and Offset
- Write Gain and Offset
- Set TDC back into measurement mode 1
- Enable TDC input for measurement

#### **Binning Data**

- Disable Storing into SRAM
- If desired: disable simultanously deleting of both Binning and Raw Data array (debug)
- Read Binning array
- Enable Storing into SRAM

#### Raw Data

- Disable Storing into SRAM
- If desired: disable simultanously deleting of both Binning and Raw Data array (debug)
- Read Raw data array
- Enable Storing into SRAM

### Main DPU Task

- Disable Storing into SRAM
- Disable FPGA Counter
- Read Start Counter
- Read Stop0 Counter
- Read Stop1 Counter
- Read Stop2 Counter
- Read TOF Counter
- Read RAW Counter
- Read Stop Counter array
- Reset FPGA Counter
- Enable Storing into SRAM
- Enable FPGA Counter

Note:

- after power on, the first SRAM access delivers unvalid data and will be used to initialize the respective memory cells
  - later in the flight S/W there will be one main task with performing calibration and all data readout tasks (storing into SRAM will be disabled during complete readout)

## Register

All control-, counter- and memory- data will be accessed from the DPU over 16-bit registers. Bevor accessing a destinated register, the respective address has to be written into the electronics (see description of the DPU-Interface).

Address	Read	CS_BUS	Write	CS_BUS
(hex)				
0	FRONTCTRL	F7	FRONTCTRL	F9
1	STAT	F8	TDCCMD	F10
2	TDCRD	F12	TDCWR	F11
3	CALIB11	F3	CALNG	F16
4	CALIB12	F4	CALNO	F17
5	CALIB21	F5	COINBDRS	F44
6	CALIB22	F6	TDCRST	-
7	-	-	_	-
8	STARTCNT	F30	CNTRST	F36
9	STOP0CNT	F31	ADCRST	F37
А	STOP1CNT	F32	-	-
В	STOP2CNT	F33	-	-
С	TOFCNT	F34	-	-
D	RAWCNT	F35	-	-
Е	-	-	DACCMD	F42
F	-	-	PREAMPCTRL	F43
10	BINARRAY	M3	BINARRAY	M0
11	RAWARRAY	M4	RAWARRAY	M1
12	STOPARRAY	M5	STOPARRAY	M2
13	MAINCTRL.	M7	MAINCTRL	M6
14	SEFCCNT	M13	RAWDBGHIGH	M8
15	DEFCCNT	M14	RAWDBGLOW	M9
16		-	LURST	M10
17	IFTEST	M11	IFTEST	M12

ADA

Description:	This register is used to as a common control register		
Address:	see register table		
Group:	common		
Access:	Read/Write		
Note:	· see below		

Bit-	Name		Description
Position			
0	TDCINENA		TDCINENA = 1 enables attention of TDC to the input signals
			start, stop and calibration clock
1	TDCOUTDIS		TDCOUTDIS = 1 disables readout of valid data from the TDC
2	CALWAITENA		CALWAITENA=1 enables wait for calibration values
3	AUTORSTDIS		AUTORSTDIS = 1 disables automatic TDC-reset when
			SYSERR occurs
4	STOARTDIS		STOARTDIS =1 disables generation of artifical stop signal
5	CNTDIS		CNTDIS = 1 disables FPGA-counter
6	STADIS		STADIS = 1 disables start signal going into the TDC
7	ADCCALDIS		ADCCALDIS=1 disables using of ADC calibration
15-8	-	-	

Name:	MAINCTRL
Name:	MAINCTRL

This register is used to as a common control register		
see register table		
common		
Read/Write		

Bit-	Name	Description
Position		
1-0	LVL[1:0]	Level for storing as binning data, storing into binning array will
		be omitted if COIN[2:0] > LVL[1:0]
2	STOREDIS	STOREDIS = 1 disables storing into SRAM
3	DEBUGENA	DEBUGENA = 1 enables simulation of rawdata (debug)
4	DELSIMDIS	DELSIMDIS = 1 disables simultanously deleting of both
		Binning and Raw Data array (after each read access on data)
5	LATCHUP	LatchUp occured, if LATCHUP = 1
6	ECENA	Hamming-Code Error Correction on SRAM data enabled, if
		ECENA=1
15-7	n.c.	

**IDA** 

Name: STAT

Description:This register is used to reflect some TDC and FPGA status signalsAddress:see register tableGroup:commonAccess:ReadNote:see below

Bit-	Name	Description
Position		
0	TDCSYSERR	SYSERR-Flag from TDC
1	TDCREADY	READY-Flag from TDC
2	TDCVALID	VALID-Flag from TDC
3	TDCCALM	CALM-Flag from TDC
4	TDCBUSDIR	BUSDIR-Flag from TDC
8-5	-	
9	TDCWRERR	TDC write access error – Flag
10	TDCRDERR	TDC read access error – Flag
11	TDCCMDERR	TDC command error – Flag
12	CMDBUSY	Commanding TDC active, if CMDBUSY=1
13	DACBUSY	Programming DAC active, if DACBUSY=1
14	NEWCAL	new calibration data available, if NEWCAL=1; any read-access
		to the CALIBxx registers resets this flag
15	ADCERR	ADC error occured, if ADCERR=1

Note:

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ADA

Name:	TDCCMD
Description:	After being written with an TDC-opcode, the contents of this register will be written into the TDC
Address:	see register table
Group:	TDC handling
Access:	Write
Note:	• dependent on the TDC-opcode, a respective parameter value has to be written into TDCWR before
Name:	TDCRD
Description:	After the transmission of an appropriate TDC-opcode, the contents of the requested TDC register is available in this register
Address:	see register table
Group:	TDC handling
Access:	Read
Note:	
Name:	TDCWR
Description:	Together with an appropriate TDC-opcode, the contents of this register will be used as a parameter value and will be written into the TDC
Address:	see register table
Group:	TDC handling
Access:	Write

**IDA** 

Description:	This register contains part1 of the calibration data from the TDC (CAL11)
Address:	see register table
Group:	Calibration
Access:	Read
Note:	• New calibration data will be shown with STAT.NEWCAL=1

## Name: CALIB12

Description:	This register contains part2 of the calibration data from the TDC (CAL12)
Address:	see register table
Group:	Calibration
Access:	Read
Note:	$\cdot$ New calibration data will be shown with STAT.NEWCAL=1

Name:	CALIB21
Description:	This register contains part3 of the calibration data from the TDC (CAL21)
Address:	see register table
Group:	Calibration
Access:	Read
Note:	· New calibration data will be shown with STAT.NEWCAL=1

Name:	CALIB22
Description:	This register contains part4 of the calibration data from the TDC (CAL22)
Address:	see register table
Group:	Calibration
Access:	Read
Note:	• New calibration data will be shown with STAT.NEWCAL=1

ADA

Name:	CALNG	
Description:	With respect to the position of the comma, this register has to be written with the calculated gain G from the calibration process	
Address:	see register table	
Group:	Calibration	
Access:	Write	
Note:	• 11 digits after decimal point	
Name:	CALNO	
Description:	With respect to the position of the comma, this register has to be written with the calculated offset O from the calibration process	
Address:	see register table	
Group:	Calibration	
Access:	Write	
Note:	• 4 digits after decimal point	

/DA

Name:	COINBDRS

Description:	This register contains both lower and upper time borders for the coincidence part
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	· This register has to be written with a hardware-specific value

CMD

<b>Description:</b>	This register will be used to program the DAC on the preamplifier board (serial link)
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	<ul> <li>programming of one DAC channel needs about 4µs</li> </ul>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
-			]	DACCI	HN[3:0]				]	DACV	AL[7:0]	]			

DACVAL[7:0]: 8-bit DAC value

DACCHN[3:0]: DAC Channel to be programmed, 0x01 = Channel A, 0x02 = Channel B, 0x03 = Channel C etc.

Name PREAMPCTRL

Description:This lower 8 bit of this register are directly connected to the preamplifier board and will be<br/>used to control this (tbd)Address:see register tableGroup:MiscellaneousAccess:WriteNote:· PREAMPCTRLVAL[7:0] = 0xff after power up

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				-						PREA	MPCT	RLVA	L[7:0]		

Name:	ADCRST
Description:	Write access to this register resets the ADC control unit and performs new calibration of the ADC ('internal mid-scale error calibration')
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	

ADA

Name:	STARTCNT
Description:	This register counts the start-signals from the NPD-sensor up to the upper limit of 65536
Address:	see register table
Group:	FPGA Counter
Access:	Read
Note:	<ul> <li>Write access to CNTRST sets counter to zero</li> <li>FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access</li> </ul>
Name:	STOP0CNT
Description:	This register counts the stop0-signals from the NPD-sensor up to the upper limit of 65536
Address:	see register table
Group:	Prod Counter
Access:	Read
	• FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access
Name:	STOP1CNT
Description:	This register counts the stop1-signals from the NPD-sensor up to the upper limit of 65536
Address:	see register table
Group:	FPGA Counter
Access:	Read
Note:	<ul> <li>Write access to CNTRST sets counter to zero</li> <li>FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access</li> </ul>
Name:	STOP2CNT
Description:	This register counts the stop2-signals from the NPD-sensor up to the upper limit of 65536
Address:	see register table
Group:	FPGA Counter
Access:	Read
Note:	<ul> <li>Write access to CNTRST sets counter to zero</li> <li>FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access</li> </ul>

Name:	TOFCNT					
Description:	This register counts the generated TOF values up to the upper limit of 65536					
Address:	see register table					
Group:	FPGA Counter					
Access:	Read					
Note:	<ul> <li>Write access to CNTRST sets counter to zero</li> <li>FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access</li> <li>For debugging/evaluating purpose only</li> </ul>					
Name:	RAWCNT					
Description:	This register counts the generated RAW values up to the upper limit of 65536					
Address:	see register table					
Group:	FPGA Counter					
Access:	Read					
Note:	<ul> <li>Write access to CNTRST sets counter to zero</li> <li>FPGA counters should be disabled (FRONTCTRL.CNTDIS = 1) before read access</li> <li>For debugging/evaluating purpose only</li> </ul>					
Name:	CNTRST					
Description:	This register is used to reset the 6 FPGA counters					
Address:	see register table					
Group:	FPGA Counter					
Access:	Write					
Note:	Write access sets all 6 FPGA counters to zero					

IDA

Name:	BINARRAY
Description: Address: Group:	This register will be used to link the binning array (from SRAM) to the DPU see register table SRAM Data
Access:	Read/Write
Note:	<ul> <li>Readout of the binning data must be initiated by a write access to this register, after that 1024 read access have to be performed.</li> <li>This register automatically reflects the next valid data item from the binning array</li> <li>The respective memory cells will be set to zero automatically after read access on BINARRAY or RAWARRAY, latter only if MAINCTRL.DELSIMDIS = 0</li> <li>Time between two read accesses should not be less than 1.2µs (tpd)</li> <li>Storing into SRAM must be disabled (MAINCTRL.STOREDIS = 1) bevor any access to this register</li> <li>exceeding the amount of read accesses is shown by Data=0x5555</li> </ul>

Name:	RAWARRAY
Description:	This register will be used to link the raw data array (from SRAM) to the DPU
Address:	see register table
Group:	SRAM Data
Access:	Read/Write
Note:	<ul> <li>Readout of the binning data must be initiated by a write access to this register, after that 1024 read access have to be performed.</li> <li>This register automatically reflects the next valid data item from the binning array</li> <li>The respective memory cells will be set to zero automatically after read access on RAWARRAY or BINARRAY, latter only if MAINCTRL.DELSIMDIS = 0</li> <li>Time between two read accesses should not be less than 1.2µs (tpd)</li> <li>Storing into SRAM must be disabled (MAINCTRL.STOREDIS = 1) bevor any access to this register</li> <li>exceeding the amount of read accesses is shown by Data=0x5555</li> </ul>

Name:	STOPARRAY					
Description:	This register will be used to link the stop array (from SRAM) to the DPU					
Address:	see register table					
Group:	SRAM Data					
Access:	Read/Write					
Note:	<ul> <li>Readout of the binning data must be initiated by a write access to this register, after that 48 read access have to be performed.</li> <li>This register automatically reflects the next valid data item from the binning array</li> <li>The respective memory cells will be set to zero automatically after read access on STOPARRAY</li> <li>Time between two read accesses should not be less than 1.2µs (tpd)</li> <li>Storing into SRAM must be disabled (MAINCTRL.STOREDIS = 1) bevor any access to this register</li> <li>exceeding the amount of read accesses is shown by Data=0x5555</li> </ul>					
Name:	SEFCCNT					
Description:	This registers counts the occurance and correction of single bit errors of the SRAM up to the upper limit of 65536.					
Address:	see register table					
Group:	SRAM Data					
Access:	Read					
Note:	• Register is cleared by hardware-reset to DigTOF					
Name:	DEFCCNT					
Description:	This registers counts the occurance of double bit errors of the SRAM data from up to the upper limit of 65536.					
Address:	see register table					
Group:	SRAM Data					
Access:	Read					
Note:	· Register is cleared by hardware-reset to DigTOF					

IDA

Name:	TDCRST
	IDCKSI

Description:	This register will be used to reset the TDC and the error-flags
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	· For debugging/evaluating purpose only

## Name: RAWDBGHIGH

Description:	This register will be used to simulate RAW-data (these are the upper 16 bits)
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	<ul> <li>to see any effect, MAINCTRL.DEBUGEN has to be set to 1 before</li> <li>pending write access to RAWDBGLOW is needed</li> <li>For debugging/evaluating purpose only</li> </ul>

Name:	RAWDBGLOW
Description:	This register will be used to simulate RAW-data (these are the lower 16 bits)
Address:	see register table
Group:	Miscellaneous
Access:	Write
Note:	<ul> <li>to see any effect, MAINCTRL.DEBUGEN has to be set to 1 before</li> <li>RAWDBGHIGH have to be written before</li> <li>For debugging/evaluating purpose only</li> </ul>

Name:	IFTEST
Description:	This 16-bit register is implemented to simplify the DPU I/F-tests (single Write and Read accesses)
Address:	see register table
Group:	Miscellaneous
Access:	Read/Write
Note:	· For debugging/evaluating purpose only

## Appendix

The following pages previously contained extracts from the EGSE-S/W @IDA. Now these extracts are available within single files.







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# APPENDIX 6. HK CHANNEL CONVERSION FACTORS

Extract from the ASPERA-4 VEX HK calibration database. Date 2005-11-22 Values are taken from VE-ASP-DS-0012 (VERDI Database - I1R3).xls

The "CPOI" type of calibration data consists of x,y pairs that define the calibration curve. The "SVAL" type describes the meaning of the specific value of that HK parameter. The raw HK value is converted to engineering value when calibration is applied.

X-value

Y-value

Type CPOI : polynom, SVAL : Value to nemonic Description

X-value	Y-value	Туре	Description
0	-264,68	CPOI	ELS Temp
255	114,07	CPOI	ELS Temp
0	-268,18	CPOI	NPD1 Temp
255	116,74	CPOI	NPD1 Temp
0	-271,88	CPOI	NPD2 Temp
255	118,76	CPOI	NPD2 Temp
0	-265,38	CPOI	NPI Temp
255	154,56	CPOI	NPI Temp
0	-267,27	CPOI	Scanner Temp
255	115,84	CPOI	Scanner Temp
0	0	CPOI	HK_V12V
255	-13,22	CPOI	HK_V12V
0	0	CPOI	HK_V5V
255	-5,17	CPOI	HK_V5V
0	0	CPOI	HK_V_+5V
255	5,24	CPOI	HK_V_+5V
0	0	CPOI	HK_V_+12V
255	13,0769	CPOI	HK_V_+12V
0	0	CPOI	HK_V_+30V
255	30,165	CPOI	HK_V_+30V
0	0	CPOI	HK_I_+5V
255	2961,06	CPOI	HK_I_+5V
0	0	CPOI	HK_I_+30V
255	368,985	CPOI	HK_I_+30V
0	-149,6	CPOI	NPD1 Bias
255	4406,23	CPOI	NPD1 Bias
0	-149,6	CPOI	NPD1 Start
255	4406,23	CPOI	NPD1 Start
0	-34,402	CPOI	NPD1 Stop
255	4431,923	CPOI	NPD1 Stop
0	-41,42	CPOI	NPD2 Blas
255	4428,985	CPOI	NPD2 Blas
0	-41,42	CPOI	NPD2 Start
255	4428,985	CPOI	NPD2 Start
0	-70,65	CPOI	NPD2 Stop
255	4366,095	CPOI	NPD2 Stop
0	-30,659		
205	2094,340		
0 255	40,119		
205	0012,009		
0 255	200,12		
200	-4004,935		INFI DIAS

0	-37,866 CPOI	NPI Defl
255	5696,574 CPOI	NPI Defl
0	0 CPOI	ELS MCP bias
255	3000 CPOI	ELS MCP bias
0	0 CPOI	Scanner Position
223	180 CPOI	Scanner Position
0.612	-200 CPOI	ASPERA 118MF PT2000 acg by RTU
0.898	-180 CPOI	ASPERA 118MF PT2000 acg by RTU
1 158	-160 CPOI	ASPERA 118ME PT2000 acg by RTU
1 4	-140 CPOI	ASPERA 118ME PT2000 acg by RTU
1 634	-120 CPOI	ASPERA 118ME PT2000 acg by RTU
1,004		ASPERA 118ME PT2000 acq by RTU
2 058		ASPERA 118ME PT2000 acq by PTU
2,000		ASPERA TIOMI FIZ000 acq by RT0
2,240		ASPERA 118MF F12000 acq by RTU
2,429		ASPERA TIONF FIZ000 acq by RTU
2,0		ASPERA HOMF PT2000 acq by RTU
2,766		ASPERA 118MF PT2000 acq by RTU
2,898		ASPERA 118MF PT2000 acq by RTU
3,052		ASPERA 118MF P12000 acq by RTU
3,207	60 CPOI	ASPERA 118MF PT2000 acq by RTU
3,342	80 CPOI	ASPERA 118MF PT2000 acq by RTU
3,478	100 CPOI	ASPERA 118MF PT2000 acq by RTU
3,605	120 CPOI	ASPERA 118MF PT2000 acq by RTU
3,713	140 CPOI	ASPERA 118MF PT2000 acq by RTU
3,771	150 CPOI	ASPERA 118MF PT2000 acq by RTU
176	0 CPOI	Boot EEP incl. Context
191	15 CPOI	Boot EEP incl. Context
192	0 CPOI	Test pattern
207	15 CPOI	Test pattern
208	0 CPOI	Boot EEP excl. Context
223	15 CPOI	Boot EEP excl. Context
224	0 CPOI	IMA Internal SID nr
230	6 CPOI	IMA Internal SID nr
240	0 CPOI	Default boot section
255	15 CPOI	Default boot section
256	0 CPOI	Deflection level
351	95 CPOI	Deflection level
512	0 CPOI	Entrance level
527	15 CPOI	Entrance level
768	0 CPOI	SW start level
832	64 CPOI	SW start level
1024	0 CPOI	Spare level
1279	255 CPOI	Spare level
2560	0 CPOI	Mode cmd
2599	39 CPOI	Mode cmd
3072	0 CPOI	Reprog. all EEP sections
3087	15 CPOI	Reprog. all EEP sections
4096		Opto reference
4103		Opto reference
8192		Mcp reference
8207		Mcp reference
12288		Grid reference
12200		Grid reference
16291		Pace low ref
16204		Pace low ref
20400		Faction ref.
20400	0 6401	r acc nightel.

20487	7	CPOI	Pacc high ref.
24576	0	CPOI	Deflection LV ref.
28671	4095	CPOI	Deflection LV ref.
28672	0	CPOI	Deflection HV ref.
32767	4095	CPOI	Deflection HV ref.
32768	0	CPOI	Entrance ref.
36863	4095	CPOI	Entrance ref.
36864	0	CPOI	Noise reduction
40959	4095	CPOL	Noise reduction
40960	0000	CPOL	Fifo low mark
46066	1005		Fifo low mark
45055	4033		Fife bigh mark
40151	4005		Filo high mark
49151	4095		Filo high mark
49152	4005	CPOI	
53247	4095	CPOI	Filo lorce mark
53248	0	CPOI	Fifo clear mark
57343	4095	CPOI	Fito clear mark
57344	0	CPOI	Ima scale factor
61439	4095	CPOI	Ima scale factor
0	0	CPOI	Opto HV monitor
255	5	CPOI	Opto HV monitor
0	0	CPOI	Deflection LV monitor
255	100	CPOI	Deflection LV monitor
0	0	CPOI	Grid LV monitor
255	12	CPOI	Grid LV monitor
0	-60	CPOI	DPU temperature
255	60	CPOI	DPU temperature
0	-5	CPOI	Upper entrance HV mon
511	5	CPOI	Upper entrance HV mon
0 OFF		SVAL	Generic ON/OFF
1 ON		SVAL	Generic ON/OFF
2 OFF		SVAL	Mcp 28V switch
3 ON		SVAL	Mcp 28V switch
4 OFF		SVAL	Opto 28V switch
5 ON		SVAL	Opto 28V switch
6 OFF		SVAL	Main 28V switch
7 ON		SVAL	Main 28V switch
8 OFF		SV/AI	Pace Hy switch
		SVAL	Pace Hy switch
		SV/AL	Grid LV switch
10 ON		SVAL	Grid LV switch
12 OFF		SVAL	Entr HV switch
12 ON		SVAL	Entr HV switch
13 ON		SVAL	
		SVAL	
		SVAL	
		SVAL	
17 ON		SVAL	Defi HV switch
18 OFF		SVAL	Direct cmd sw.
19 ON		SVAL	Direct cmd sw.
20 OFF		SVAL	WD enabel sw.
21 ON		SVAL	WD enabel sw.
28 OFF		SVAL	Compr. switch
29 ON		SVAL	Compr. switch
30 OFF		SVAL	Alt.Pacc switch
31 ON		SVAL	Alt.Pacc switch
32 LOW		SVAL	Pacc, level

33	HIGH	SVAL	Pacc. level
34	OFF	SVAL	Auto red. sw.
35	ON	SVAL	Auto red. sw.
36	OFF	SVAL	Shadow masking
37	ON	SVAL	Shadow masking
38	OFF	SVAL	Bad HV masking
30	ON	SV/AI	Bad HV masking
10	OFF	SV/AI	Bad mass masking
11		SVAL	Bad mass masking
41	Eixed	SVAL	Dau mass masking Dago Op. Modo
1	Alternating	SVAL	Pace.Op. Mode
1	Alternating	SVAL	
0	INO Maa	SVAL	NO/Yes
1	res	SVAL	NO/Yes
0	OK	SVAL	Ok/Overflow
1	Overflow	SVAL	Ok/Overflow
0	Ok	SVAL	Cmd status
1	Invalid	SVAL	Cmd status
2	Out of rang	SVAL	Cmd status
3	Erroneous	SVAL	Cmd status
0	Min	SVAL	IMA Internal Sid type
1	Norm	SVAL	IMA Internal Sid type
2	Burst	SVAL	IMA Internal Sid type
3	Cal	SVAL	IMA Internal Sid type
4	Spec	SVAL	IMA Internal Sid type
5	Test	SVAL	IMA Internal Sid type
6	Ima	SVAL	IMA Internal Sid type
0	Idle	SVAL	Mode
1	Void1	SVAL	Mode
2	Mspo	SVAL	Mode
3	Void2	SVAL	Mode
4	Msis	SVAL	Mode
5	Mexm	SV/AL	Mode
6	Void3	SV/AI	Mode
7	Void4	SVAL	Mode
0	Nrm0	SVAL	Mode
0	Nrm1	SVAL	Mode
9 10	Nrm2	SVAL	Mode
10	NIIIZ	SVAL	Mode
11	NIIIIO Nirroo 4	SVAL	Mode
12	NIIII4	SVAL	Mode
13		SVAL	Mode
14	NITTIO	SVAL	
15	INITITI /	SVAL	
16	Haru	SVAL	Mode
17	Har1	SVAL	Mode
18	Har2	SVAL	Mode
19	Har3	SVAL	Mode
20	Har4	SVAL	Mode
21	Har5	SVAL	Mode
22	Har6	SVAL	Mode
23	Har7	SVAL	Mode
24	Exm0	SVAL	Mode
25	Exm1	SVAL	Mode
26	Exm2	SVAL	Mode
27	Exm3	SVAL	Mode
28	Exm4	SVAL	Mode
29	Exm5	SVAL	Mode

30	Exm6	SVAL	Mode
31	Exm7	SVAL	Mode
32	Test	SVAL	Mode
33	Cal1	SVAL	Mode
34	Cal2	SVAL	Mode
35	Fake	SVAL	Mode
36	Void5	SVAL	Mode
37	Void6	SVAL	Mode
38	Void7	SVAL	Mode
39	Vcal8	SVAL	Mode
0	OFF	SVAL	dummy for ON/OFFs
1	ON	SVAL	dummy for ON/OFFs







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# APPENDIX 7. ASPERA-4 SENSOR NUMBERING

# Aspera 4 : Frame definitions and sensors attitudes

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## 1 Introduction

The purpose of the document is to determine an algorithm of calculation of the *direction of the velocity vector* (*DVV*) of incidence particles. Particle velocity vector is defined in the satellite frame of reference  $X_s, Y_s, Z_s$ . Present document considers two separated packages : Mass spectrometer

IMA and Main Unit.

*Figure 1* shows the location of **IMA** and **Main Unit** with respect to the satellite frame.



Figure 1: Satellite system  $(X_s Y_s Z_s)$ 

## 2 IMA

## 2.1 definition

Figures 2, 3, 4 and 5 shows location of IMA in the  $X_sY_sZ_s$  VEX reference frame :



Figure 2: IMA location



Figure 3: IMA location in  $x_s y_s$  plane



Figure 4: IMA location in  $x_s z_s$  plane



Figure 5: IMA orientation in  $x_s y_s z_s$  plane

#### 2.2 IMA variables

This section introduces the varibles used for IMA instrument.

 $\theta$  is the **elevation angle** of the incident ion counted from the  $X_s Z_s$  plane towards  $+Y_s.$ 

According to the calibration report, the maximum elevation angle is  $\theta_{max} = 46 \ degrees$ , and the lowest value for the elevation angle is  $\theta_{min} = -43.7 \ degrees$ .

 $\phi$  is the **azimuthal angle** counted from the  $+X_s$  axis towards the  $+Z_s$  axis.

 $\vec{u}$  is the *DVV* of the incident particle (unity vector) defined by  $\theta$  and  $\phi$ .
#### 2.3 IMA $\vec{u}$ definition



Figure 6: DVV in  $X_sY_sZ_s$  plane

 $\begin{array}{l} \theta : \text{ elevation angle} \\ \phi : \text{ azimuthal angle} \\ \overrightarrow{MO} : \text{DVV} \end{array}$ 

 $\vec{u}$  follow the direction of  $\overrightarrow{MO}$ :

$$\vec{u} = \frac{\overrightarrow{MO}}{|MO|} = \frac{\overrightarrow{MO}}{r}$$

Then  $\vec{u}$  components in the  $X_s$ ,  $Y_s$ ,  $Z_s$  plane are:

$$\vec{u} = \begin{bmatrix} -\cos\theta \, \cos\phi \\ -\sin\theta \\ -\cos\theta \, \sin\phi \end{bmatrix}$$

#### 2.4 IMA sector looking direction

Figure 7 shows the layout of 16 fields-of-view of azimuthal sectors of IMA. This view doesn't correspond to the physical sectors position.



Figure 7: IMA sector looking direction in  $X_s Z_s$  plane

For example, an ion with  $\vec{u} DVV$  shown in *figure* 7 by green arrow will be registed in the azimuthal sector 2.

The following table displays the  $\phi$  values at the beginning, the middle and the end of each sector.

It also indicates the value of  $\vec{u}_{X_sZ_s}$  coming in the middle of each sector.

Sector	Begin	Middle	End	$\vec{u}_{X_sZ_s}$ (*)
0	90.00	78.75	67.50	(-0.195,-0.981)
1	67.50	56.25	45.00	(-0.556, -0.831)
2	45.00	33.75	22.50	(-0.831, -0.556)
3	22.50	11.25	0.00	(-0.981,-0.195)
4	0.00	348.75	337.50	(-0.981, 0.195)
5	337.50	326.25	315.00	(-0.831, 0.556)
6	315.00	303.75	292.50	(-0.556, 0.831)
7	292.50	281.25	270.00	(-0.195, 0.981)
8	270.00	258.75	247.50	$( \ 0.195 \ , \ 0.981 \ )$
9	247.50	236.25	225.00	$( \ 0.556 \ , \ 0.831 \ )$
10	225.00	213.75	202.50	$( \ 0.831 \ , \ 0.556 \ )$
11	202.50	191.25	180.00	(0.981, 0.195)
12	180.00	168.75	157.50	(0.981, -0.195)
13	157.50	146.25	135.00	(0.831, -0.556)
14	135.00	123.75	112.50	$( \ 0.556 \ , \ -0.831 \ )$
15	112.50	101.25	90.00	$( \ 0.195 \ , \ -0.981 \ )$

## 3 Main Unit

#### 3.1 Main Unit orientation

Main Unit (MU) is the common frame for four sensors : ELS, NPI, NPD1 and NPD2.

Main Unit (MU) can turn around  $Y_s$  axis.

To describe the instance attitudes of each sensor, we have to introduce a new referee frame  $X_{mu}Y_{mu}Z_{mu}$  attached to MU.

We define  $X_{mu}Y_{mu}Z_{mu}$  as a system equivalent to  $X_sY_sZ_s$  when MU is in a *parking postion* shown in *figure 8*.



Figure 8: MU location



Figure 9: MU location in  $x_{mu}y_{mu}$  plane



Figure 10: MU location in  $y_{mu}z_{mu}$  plane

#### 3.2 the spacecraft coordinates

*Figure 12* shows MU position onto the spacecraft. Here, main Unit is in a **parking position**.



Figure 11: MU parking position in  $x_s y_s$  plane



Figure 12: MU parking position in  $y_s z_s$  plane



Figure 13: MU parking position in  $x_{mu}y_{mu}z_{mu}$  plane

#### 3.3 Main Unit variables

The following variables are used to determine DVV of particles measured by MU.

 $Y_{mu} = Y_s$ 

 $\theta$  is the scanner angle in the  $X_s Z_s$  plane of the satelite frame. We define  $\theta$  as the angle between  $Z_s$  and  $X_{mu}$ . When MU turns around  $Y_s$ ,  $\theta$  is vareing from 0 to 180 degrees.

At parking position  $\theta = 90$ . Then, for  $\theta = 90$  degrees :

$$X_{mu} = X_s$$
  
 $Y_{mu} = Y_s$   
 $Z_{mu} = Z_s$ 

Figure 14 represents  $X_{mu}$  and  $Y_{mu}$  in the  $X_s Z_s$  plane:



Figure 14:  $X_{mu}$  and  $Z_{mu}$  in the  $X_s Z_s$  plane

#### 3.4 Rotation matrix

In  $X_s Z_s$  system,  $X_{mu}$  and  $Z_{mu}$  are defined by:

$$X_{mu} = \cos\theta \ Z_s \ + \ \sin\theta \ X_s$$
$$Z_{mu} = \sin\theta \ Z_s \ - \ \cos\theta \ X_s$$
$$Y_{mu} = Y_s$$

so:

$$\begin{bmatrix} X_s \\ Y_s \\ Z_s \end{bmatrix} = \begin{bmatrix} \sin\theta & 0 & -\cos\theta \\ 0 & 1 & 0 \\ \cos\theta & 0 & \sin\theta \end{bmatrix} \cdot \begin{bmatrix} X_{mu} \\ Y_{mu} \\ Z_{mu} \end{bmatrix}$$

The rotation matrix to translate from the MU system to the satellite system is :

$$M = \left[ \begin{array}{ccc} \sin\theta & 0 & -\cos\theta \\ 0 & 1 & 0 \\ \cos\theta & 0 & \sin\theta \end{array} \right]$$

#### 3.5 DVV definition in the Main Unit system

 $\phi$  is the **azimuthal angle** counted from the  $+X_{mu}$  axis towards the  $+Y_{mu}$  axis.

 $\vec{u}_{mu}$  is an unity vector corresponding of DVV of the incident particle.



Figure 15: DVV in  $X_{mu}Y_{mu}$  plane

 $\vec{u}_{mu}$  follow the direction of  $\overrightarrow{NO}$ :

$$\vec{u}_{mu} = rac{\overrightarrow{NO}}{|NO|} = rac{\overrightarrow{NO}}{r}$$

note, that  $u_{z_{mu}} = 0$ 

Thus,  $\vec{u}_{mu}$  coordinates in the  $X_{mu}$ ,  $Y_{mu}$ ,  $Z_{mu}$  plane are:

$$\vec{u}_{mu} = \begin{bmatrix} -\cos\phi \\ -\sin\phi \\ 0 \end{bmatrix}$$

#### $3.6 \quad DVV$ definition in the satellite system

 $\vec{u}_s$  defines the particle direction in the satellite system.

To obtain  $\vec{u}_s$  we have to apply the rotation matrix M to convert the  $\vec{u}_{mu}$  from the MU system to the satellite system:

$$\begin{bmatrix} u_{x_s} \\ u_{y_s} \\ u_{z_s} \end{bmatrix} = \begin{bmatrix} \sin\theta & 0 & -\cos\theta \\ 0 & 1 & 0 \\ \cos\theta & 0 & \sin\theta \end{bmatrix} \cdot \begin{bmatrix} u_{x_{mu}} \\ u_{y_{mu}} \\ u_{z_{mu}} \end{bmatrix}$$

$u_{x_s}$		$\sin \theta$	0	$-\cos\theta$	$-\cos\phi$
$u_{y_s}$	=	0	1	0	$-sin\phi$
$u_{z_s}$		$cos\theta$	0	sin heta	0

Thus :

$$\vec{u}_s = \begin{bmatrix} -\cos\phi \sin\theta \\ -\sin\phi \\ -\cos\phi \cos\theta \end{bmatrix}$$

Figure 16 shows an interpretation of the  $\vec{u}_s$  in the  $X_s, Y_s, Z_s$  frame, where  $\vec{u}_s$  is equal to  $\frac{\overrightarrow{MO}}{|MO|}$ :





 $\begin{array}{l} \theta: \text{ scanner angle} \\ \phi: \text{ azimuthal angle} \\ \overrightarrow{MO}: DVV \end{array}$ 

#### 3.7 ELS sector looking direction

The next picture defines fields-of-view of 16 ELS sectors in the  $X_{mu}, Y_{mu}$  frame.



Figure 17: ELS sector looking direction in  $X_{mu}Y_{mu}$  plane

 $\phi$ : azimuthal angle

 $\vec{u}$  : unity vector corresponding to DVV

For example, a particle with  $\vec{u} DVV$  shown in *figure 17* by green arrow will be registed by sector 13.

The following table displays the  $\phi$  values at the beginning, the middle and the end of each sector.

It also indicates the value of  $\vec{u}_{X_{mu}Y_{mu}}$  coming in the middle of each sector.

Sector	Begin	Middle	End	$\vec{u}_{X_{mu}Y_{mu}}$ (*)
0	90.00	101.25	112.50	(0.195, -0.981)
1	112.50	123.75	135.00	(0.556, -0.831)
2	135.00	146.25	157.50	(0.831, -0.556)
3	157.50	168.75	180.00	(0.981, -0.195)
4	180.00	191.25	202.50	(0.981, 0.195)
5	202.50	213.75	225.00	$( \ 0.831 \ , \ 0.556 \ )$
6	225.00	236.25	247.50	$( \ 0.556 \ , \ 0.831 \ )$
7	247.50	258.75	270.00	(0.195, 0.981)
8	270.00	281.25	292.50	(-0.195, 0.981)
9	292.50	303.75	315.00	(-0.556, 0.831)
10	315.00	326.25	337.50	(-0.831, 0.556)
11	337.50	348.75	0.00	(-0.981, 0.195)
12	0.00	11.25	22.50	(-0.981,-0.195)
13	22.50	33.75	45.00	(-0.831,-0.556)
14	45.00	56.25	67.50	(-0.556,-0.831)
15	67.50	78.75	90.00	(-0.195,-0.981)

#### 3.8 NPI sector looking position

The next picture defines fields-of-view of 32 sectors of NPI in the  $X_{mu},Y_{mu}$  frame.



Figure 18: NPI sector looking direction in  $X_{mu}Y_{mu}$  plane

- $\phi$  : azimuthal angle
- $\vec{u}$ : unity vector corresponding to DVV.

The following table displays the  $\phi$  values at the beginning, the middle and the end of each sector.

It also indicates the value of  $\vec{u}_{X_{mu}Y_{mu}}$  coming in the middle of each sector.

Sector	Begin	Middle	End	$\vec{u}_{X_{mu}Y_{mu}}$ (*)
0	270.00	275.62	281.25	(-0.098, 0.995)
1	281.25	286.88	292.50	(-0.290, 0.957)
2	292.50	298.12	303.75	(-0.471, 0.882)
3	303.75	309.38	315.00	(-0.634, 0.773)
4	315.00	320.62	326.25	(-0.773, 0.634)
5	326.25	331.88	337.50	(-0.882, 0.471)
6	337.50	343.12	348.75	(-0.957, 0.290)
7	348.75	354.38	0.00	(-0.995, 0.098)
8	0.00	5.62	11.25	(-0.995,-0.098)
9	11.25	16.88	22.50	(-0.957, -0.290)
10	22.50	28.12	33.75	(-0.882, -0.471)
11	33.75	39.38	45.00	(-0.773, -0.634)
12	45.00	50.62	56.25	(-0.634, -0.773)
13	56.25	61.88	67.50	(-0.471, -0.882)
14	67.50	73.12	78.75	(-0.290, -0.957)
15	78.75	84.38	90.00	(-0.098, -0.995)
16	90.00	95.62	101.25	$( \ 0.098 \ , \ -0.995 \ )$
17	101.25	106.88	112.50	$( \ 0.290 \ , -0.957 \ )$
18	112.50	118.12	123.75	(0.471, -0.882)
19	123.75	129.38	135.00	( 0.634 , -0.773 )
20	135.00	140.62	146.25	$( \ 0.773 \ , -0.634 \ )$
21	146.25	151.88	157.50	(0.882, -0.471)
22	157.50	163.12	168.75	( 0.957 , -0.290 )
23	168.75	174.38	180.00	( 0.995 , -0.098 )
24	180.00	185.62	191.25	$( \ 0.995 \ , \ 0.098 \ )$
25	191.25	196.88	202.50	$( \ 0.957 \ , \ 0.290 \ )$
26	202.50	208.12	213.75	(0.882, 0.471)
27	213.75	219.38	225.00	$( \ 0.773 \ , \ 0.634 \ )$
28	225.00	230.62	236.25	$(\ 0.634\ ,\ 0.773\ )$
29	236.25	241.88	247.50	(0.471, 0.882)
30	247.50	253.12	258.75	$( \ 0.290 \ , \ 0.957 \ )$
31	258.75	264.38	270.00	$( \ 0.098 \ , \ 0.995 \ )$

The sectors 14,15,16 and 17 are blocked by satellite body for any values of  $\theta$ . Other sectors can be blocked for certain  $\theta$  values.

#### 3.9 NPD sector looking position

**NPD** consists of two sensors, NPD1 and NPD2. Eanch sensor has 3 detectors in the azimutal plane.



Figure 19: NPD sector looking direction in  $X_{mu}Y_{mu}Z_{mu}$  plane

The following tables display for NPD1 and NPD2 the  $\phi$  values at the beginning, the middle and the end of each sector.

It also indicates the value of  $\vec{u}_{X_{mu}Y_{mu}}$  coming in the middle of each sector.

- Sector Begin Middle  $\vec{u}_{X_{mu}Y_{mu}}$  (\*) End 0 270.00 255.00240.00(0.259, 0.966)(0.707, 0.707)240.00225.00210.001  $\mathbf{2}$ 210.00195.00180.00(0.966, 0.259)
  - $\bullet$  NPD2 table :

• NPD1 table :

Sector	Begin	Middle	End	$ec{u}_{X_{mu}Y_{mu}}$ (*)
0	270.00	285.00	300.00	(-0.259, 0.966)
1	300.00	315.00	330.00	(-0.707, 0.707)
2	330.00	345.00	0.00	(-0.966, 0.259)

Moreover the deflector is declined on  $15^{\circ}$  from rhe start surface plane :



Figure 20: NPD deflection

#### 3.10 Scanner datas

The scanner angle  $\theta$  is determined in the telemetry files for each main unit sensor (ELS, NPI, NPD1 and NPD2).

In the header of this file, we find scanner direction, scanner speed and scanner position.

The following example shows how those information appear into the data file :

```
Scanner_Direction 1
Scanner_Speed 32
Scanner_Position 0
```

Telemetry frames are generated if  $\theta \ge 0^{\circ}$  and  $\theta \le 180^{\circ}$ . Nevertheless, the scanner can move between  $-10^{\circ}$  and  $190^{\circ}$ .

position	CCW	CCW	CW	CW stop
	$\operatorname{stop}$			
deg	$-10^{\circ}$	$0^{\circ}$	$180^{\circ}$	$190^{\circ}$
count	0	0	223	$\leq 231$



Figure 21: Scanner count

There is 3 allowed speeds for the scanner :  $32 \ sec/180^{\circ}$ ,  $64 \ sec/180^{\circ}$  and  $128 \ sec/180^{\circ}$ .

Scanner direction is defined as follows :

- Scanner\_direction  $0: \theta$  is counted up from 0 to 180 degrees.
- Scanner\_direction 1 :  $\theta$  is counted down from 180 to 0 degrees.

#### 4 The VEXLIB

To switch to the VSO (Venus-Sun-Orbit) system, we have to use the **VEXLIB**. VEXLIB is developed by GFI (Daniel Popescu) and is using the SPICE LIB and OASW provided by ESA.

• *initSPICE(&ier, errtxt)* : initialisation of the SPICE lib

errtxt : error message if ier! = 0
ier : error code
0 : Ok
1 : error

- initOrbJ2000(int \*iunit, char \*fname, int iorder, int \*nvars, int \*iframe, int \*ibody ,int \*itscal, double \*tbeg, double \*tend, int \*ifid, int \*ier): open an ESA binary orbit file created with as2bin
  - *iunit* : number of the unit associated to the orbit file.
  - *fname* : name of the orbit file.
  - *nvars* : number of vars in the orbit file.
    - 3: position
    - 6 : position and velocity
    - 42 : position, velocity and derivative
  - *iframe* : default location.
    - 0 : mean equator and equinox of j2000
    - 1 : mean ecliptic and equinox of j2000
    - 2 : mean equator and equinox of b1950
    - 3 : mean ecliptic and equinox of b1950
  - *ibody* : system of reference.
    - 0 : bary-centre of the solar system
    - 2: Venus
    - 3: Earth
    - 11: Sun
  - *itscal* : time ladder.
    - 0 : barycentric dynamic time (*MJD2000* format)
  - tbeg : beginning time of the orbit file.
  - tbeg : ending time of the orbit file.
  - *ifid* : orbit file id.
    - 0 : opening failed
  - *ier* : error code
    - 0: Ok
    - 1 : unable to open file

- 2 : unable to get additional parameters
- CalcStateJ2000(int ifid, double time, double \*state, int \*iframe, int \*ibody, int \*ier) : calculate VEX state vector.
  - *ifid* : orbit file id.
  - time : time (barycentric dynamic time MJD2000 format)
  - *state* : state vector in the *iframe* location and compared to *ibody*.
  - *iframe* : default location.
    - 0: mean equator and equinox of j2000
    - 1 : mean ecliptic and equinox of j2000
    - 2 : mean equator and equinox of b1950
    - 3 : mean ecliptic and equinox of b1950
  - *ibody* : system of reference.
    - 0 : bary-centre of the solar system
    - 2: Venus
    - 3: Earth
    - 11: Sun
  - $\mathit{ier}$  : error code
    - 0: Ok
    - 1 : time to early
    - 2: time to late
    - 3: time in a gap
    - 4 : error getting additional parameters
    - 5 : error can't read block header
    - 6 : invalid identifier
- closeOrbJ2000(int ifid, int \*ier) : close an ESA binary orbit file.
  - *ifid* : orbit file id.
  - *ier* : error code
    - 0: Ok
    - 1 : unable to close file
    - 2 : invalid identifier

- *iunit* : number of the unit associated to the attitude file.
- *fname* : name of the attitude file.
- *iorder* : interpolation order (6 to 12; 8 recommended).
- *nvars* : number of vars in the orbit file.
  - 3: position
    - 6 : position and velocity
    - 42 : position, velocity and derivative
- *ifname* : default location.
  - Only *EMEJ2000* available in this version.
- *itscal* : time ladder.
  - 0: barycentric dynamic time (*MJD2000* format)
- *tbeg* : beginning time of the attitude file.
- *tbeg* : ending time of the attitude file.
- *ifid* : attitude file id.
  - 0 : opening failed
- *ier* : error code
  - 0: Ok
    - 1 : unable to open file
    - 2 : unable to get additional parameters
- CalcAttQuatJ2000(int ifid, double time, double \*state, int \*iframe, int \*ibody, int \*ier) : calculate VEX quaternion attitude and angular velocity.
  - *ifid* : attitude file id.
  - time : time (barycentric dynamic time MJD2000 format)
  - *state* : state vector in the *iframe* location and compared to *ibody*.
  - *iframe* : attitude reference.
    - 0: J2000
  - *ibody* : system of reference.
    - 0 : bary-centre of the solar system
    - 2: Venus
    - 3: Earth
    - 11: Sun
  - *ier* : error code
    - 0: Ok
    - 1 : time to early
    - 2: time to late
    - 3: time in a gap

- 5 : error can't read block header
- 6 : invalid identifier
- CalcAttMatJ2000(int ifid, double time, double amat[3][3], double omega[3], int \*iframe, int \*ier): calculate the angular velocity and the

rotation matrix form the satellite location to the EMEJ2000 location.

- *ifid* : attitude file id.
- time : time (barycentric dynamic time MJD2000 format)
- *iframe* : attitude reference.
  - 0: J2000
- *ibody* : system of reference.
  - 0 : bary-centre of the solar system
  - 2: Venus
  - 3: Earth
  - 11: Sun
- *ier* : error code
  - 0: Ok
  - 1 : time to early
  - 2: time to late
  - 3: time in a gap
  - 4 : error getting additional parameters
  - 5 : error can't read block header
  - 6 : invalid identifier
- closeAttJ2000(int ifid, int \*ier) : close an ESA binary attitude file.
  - *ifid* : attitude file id.
  - *ier* : error code
    - 0: Ok
    - 1 : unable to close file
    - 2: invalid identifier

• CalcJD2000( double \*mjday, int year, int month, int day, int hour, int minute, double second): convert a calendar date into a julian day.

- mjday : Julian day modified.

• CalcDJ2000( double mjday, int \*year, int \*month, int \*day, int \*hour, int \*minute, double \*second): convert a julian day into a calendar date.

- mjday : Julian day to modify.

- eme2000vso( double date, double pmat[3][3], double pmatt[3][3], int\* ier, char \*errtxt): changeover matrix of the EME2000 towards VSO.
  - *date* : barycentric dynamic time (*MJD2000* format)
  - pmat: changeover matrix (3 \* 3) EME2000 to VSO
  - *pmatt* : transposed matrix of *pmat*
  - *ier* : error code
    - 0: Ok
    - 1: error
  - errtxt : error message if ier! = 0
- eme2000uai(double date, double pmat[3][3], double pmatt[3][3], int\* ier, char \*errtxt): changeover matrix of the EME2000 towards UAI.
  - *date* : barycentric dynamic time (*MJD2000* format)
  - pmat: changeover matrix (3 \* 3) EME2000 to Venus fixed
  - *pmatt* : transposed matrix of *pmat*
  - *ier* : error code
    - 0: Ok
    - 1: error
  - errtxt : error message if ier! = 0
- eme2000gse(double date, double pmat[3][3], double pmatt[3][3], int\* ier, char \*errtxt): changeover matrix of the EME2000 towards GSE.
  - *date* : barycentric dynamic time (*MJD2000* format)
  - pmat: changeover matrix (3 \* 3) EME2000 to GSE
  - *pmatt* : transposed matrix of *pmat*
  - *ier* : error code

- MxV(double matrix[3][3], double vin[3], double vout[3])
  - : Multiplication of a vector (3) by a matrix (3x3).
  - matrix : Matrix (3 \* 3)
  - vin : incoming vector (3)
  - *vout* : result of the multiplication; vector (3).
- calcStateGSE( double date, int target, double \*state, int\* ier, char \*errtxt) : position and velocity of an object in GSE.
  - date : barycentric dynamic time (MJD2000 format)
  - *target* : id NAIF of the object
  - state : state vector in the *iframe* location and compared
  - *ier* : error code
    - $0:\, Ok$
    - 1: error
  - errtxt : error message if ier! = 0





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# APPENDIX 8. ASPERA-4 CALIBRATION REPORT







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# ASPERA – 4 CALIBRATION REPORT

	Name and function	Date	Signature
Prepared by:	Stas Barabash	2005-05-30	
Verified by:			
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#### **CHANGE RECORD**

Ver	sion	Date	Changed Paragraphs	Remarks
Issue	Rev			
1	0	2005-5-30	All	New document







keV

 $65 \text{ ms} - \overline{128 \text{ s}^3}$ 

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#### SCOPE AND STRUCTURE OF THE DOCUMENT 1

The document provides calibration reports on four ASPERA-4 individual sensors, ELS (Electron Spectrometer), NPI (Neutral Particle Imager), NPD (Neutral Particle Detector), and IMA (Ion Mass Analyzer). In the calibration overview the sensor performance is summed up vs. proposal "Venus Express. Response to ESA's Call for Ideas for the Re-Use of the Mars Express Platform". Four Appendixes contain the individual calibration reports. The calibrations have been performed at

- Mullar Space Science Laboratory, UK ELS:
- NPI: Swedish Institute of Space Physics, Kiruna, Sweden
- NPD: Swedish Institute of Space Physics, Kiruna, Sweden
- CESR /CNRS, Toulouse, France IMA:

#### 2 **CALIBRATION RESULTS OVERVIEW**

Four tables below shows the instrument performance vs. proposal. Note that for the sensors mounted on the scanner, ELS, NPI, NPD the full 3D resolution is provided by the fastest scanning speed which is 32s per 180° scan.

Table 1. NPI performance (see Appendix 1)					
Parameters	As proposed	As calibrated			
Energy range, keV	≈0.1 - 60	$0.2^1 - 60^2$			
Energy resolution, $\Delta E/E$	No	No			
Mass resolution	No	No			
Intrinsic field if view	9° x 344°	9° x 344°			
Angular resolution (FWHM)	4.6° x 11.5°	3.5° x 13°			
G-factor/pixel, cm <sup>2</sup> sr (w/o effic.)	$2.5 \times 10^{-3}$	2.5 x 10 <sup>-3</sup>			
Efficiency,	10 <sup>-2</sup>	$10^{-5} - 6 \cdot 10^{-3} (0.2 - 5)$			

N/A

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#### Т

Time resolution for 3D, s (\*) not in the proposal

1 - at efficiency  $10^{-5}$  for oxygen and 2.47 kV MCP bias

 $^{2}$  – Cut-off deflector at 5 kV

Time resolution / spectrum (\*)

 $^{3}$  – Commandable

#### Table 2. NPD (see Appendix 2)

Parameters	As proposed	As calibrated
Energy range, keV	0.1 - 10	$0.006 - 18 (H)^{-1}$
		$0.19 - 10 \text{ keV} (\text{O})^2$
Energy resolution, $\Delta E/E$	80	50
Mass resolution	H, O	H, O
Intrinsic field if view	9° x 180°	9° x 180°
Angular resolution (FWHM)	5° x 30°	NPD1 NPD2
		Dir0 3.5° x 34.1° 3.7° x 32.5°
		Dir1 4.3° x 51.7° 4.6° x 60.8°
		Dir2 4.5° x 40.0° 4.0° x 41.3°
G-factor/pixel, cm <sup>2</sup> sr (inc. effic.)	$(0.62 - 15.5) \ge 10^{-4}$	$(0.024 - 3.8) \times 10^{-4} (H)^{-3}$
		$(0.03 - 10.7) \times 10^{-4} (O)^{-3}$
Efficiency, %	1 - 25	0.013 - 6.0 (H) <sup>3</sup>
		0.005 - 11.8 (O) <sup>3</sup>
Time resolution / spectrum (*)	N/A	$65 \text{ ms} - 128 \text{s}^4$
Time resolution for 3D	32	32

(\*) not in the proposal







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 $^{1}$  – based on the 50 ns – 2400 ns TOF window. Calibrated efficiency for 100 eV H is  $10^{-3}$ .

 $^{2}$  – based on 2400 ns upper TOF limit and calibrated efficiency (8.5 – 10.3)·10<sup>-2</sup> for 10 keV O.

 $^{3}$  - for all directions and for the energy range 0.3 - 10 keV for O and 0.1 - 5.0 for H.

 $^4$  – Commandable

#### Table 3. ELS (see Appendix 3)

Parameters	As proposed	As calibrated
Energy range, keV	0.001 - 20	0.001 - 20
Energy resolution, $\Delta E/E$	7%	6% - 10%
Mass resolution	No	No
Intrinsic field if view	10° x 360°	10° x 360°
Angular resolution (FWHM)	5° x 22.5°	5° x 22.5°
G-factor/pixel, cm <sup>2</sup> sr (inc. effic.)	$3 \times 10^{-4}$	TBD, close to MEX
Time resolution / spectrum (*)	N/A	4s (128 steps)
Time resolution for 3D	32	32

(\*) not in the proposal

#### Table 4. IMA (see Appendix 4)

Parameters	As proposed	As calibrated
Energy range, keV	0.01 - 40	0.03 - 31.8 <sup>1</sup>
Energy resolution, $\Delta E/E$	10%	4%
Mass resolution, $M/\Delta M$	5	M/q: 1, 2, 16, 32 (see Appendix4)
Intrinsic field if view	90° x 360°	90° x 360° <sup>2</sup>
Angular resolution (FWHM)	5° x 22.5°	$5^{\circ} \times 22.5^{\circ}$ (programmed) <sup>2</sup>
G-factor/pixel, cm <sup>2</sup> sr eV/eV (inc.	$3.5 \times 10^{-4}$	$(0.6-2)\cdot 10^{-4}$ (at 600 eV, for the
effic.)		other see Table 1 in Appendix $4$ ) <sup>2</sup>
Time resolution / spectrum (*)	N/A	196s / energy – elevation sweep
Time resolution for 3D	32	196

(\*) not in the proposal

1 – lower limit is extrapolated from calibrations at the lower limit at 300 eV

2 – function of energy and mass (see report)

#### **3** CONLCLUSION

The instrument performance is in line with Proposal.





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# APPENDIX 1. NPI CALIBRATION REPROT

## ASPERA-4 NPI Calibration Report

K. Brinkfeldt, S. Barabash, A. Grigoriev, K. Asamura, B. Sandel, C. Curtis

May 26, 2005

#### Abstract

This report treats the functional test and calibration of the Neutral Particle Imager (NPI), which is a part of the instrument ASPERA-4 to be flown on Venus Express. For the functional test the detector MCP (Micro Channel Plate) saturation voltage and dark current are measured. For the calibration part the sensor efficiency and response to azimuth and elevation scans are presented. The NPI was also calibrated against Lyman- $\alpha$  photons ( $\lambda = 121.6$  nm). The results of these measurements are included. The ASPERA-4 NPI is the flight spare of the ASPERA-3 NPI on Mars Express.

#### 1 Introduction

The ASPERA-4 instrument will investigate plasmaneutral interactions near Venus as part of the Venus Express mission scheduled for launch 2005. ASPERA-4 includes the Neutral Particle Imager (NPI) which is will image energetic neutral atoms (ENA) with an angular resolution of  $9^{\circ} \times 11.25^{\circ}$ . The NPI is a cylindrical tophat type instrument with 32 apertures. A high voltage deflection system will remove charged particles from the measured flux so that only neutral particles can pass and impact a tilted target block. Secondary and reflected particles are converted to a current pulse with a Multi Channel Plate (MCP) chevron configuration. At the MCP output a sectioned anode is connected to front end electronics.

#### 1.1 Description of the Calibration Facility at IRF

The system in the IRF laboratory is the Model 2751 50 keV Ion Source from Peabody Scientific. It is capable of producing a parallel and even ion beam with an energy of up to 50 keV/q. The system can be run in three different modes to be able to achieve the three energy ranges 0 - 1 keV/q, 1 - 15 keV/q and 15 - 50 keV/q. Ions are produced in the duoplasmatron from arcing between an anode and an oxide coated mesh filament. There is a funnel-shaped electrode constricting the gas and generated plasma cloud to a volume that is converging toward the axial aperture exit. This restricts the plasma to a narrow beam emerging from the aperture. To increase the ionization efficiency, a strong magnetic field is applied in the axial direction of the duoplasmatron. Electrons generated will then spiral along the magnetic field lines towards the anode and produce longer ionization tracks. The ion beam is then extracted through an extraction gap by an extraction electrode and then accelerated through a three-element Einzel focusing lens, which also helps to collimate the diverging ion beam into a parallel beam. The focal length can be optimized by adjusting the lens voltage. The ions then enters an ExB filter. This consists of a perpendicular magnetic and an electrical field. The electrical field strength can be varied to filter out the desired ion mass according to the formula: The electrode voltage is divided between the voltage on the top electrode  $(V_{ExB}^+)$  and the voltage on the bottom electrode  $(V_{ExB}^{-})$ . These are not perfectly symmetrical. After exiting the ExB filter the ions are accelerated in an acceleration gap to achieve the final beam energy. The beam is then further filtered through the electrostatic analyzer, which is a 90 degree spherical electrode with a radius of 5 ". Ions with energies different from the energy selected by setting the electric field inside the analyzer will not make the turn. The electrostatic analyser at the IRF facility has an energy resolution of 1 %. To permit widening of the ion beam emerging from the electrostatic analyser, a defocus lens first diverges the beam and then a focus lens collimates the diverging beam into a parallel beam leaving the system. Both lenses are three-element Einzel lenses of different size. The retractable Faraday cup provides measurements of the beam intensity and because of this also indirectly the beam location. It is mounted inside the vacuum tank.

#### **1.2** Measurement configuration

Fig. 1 shows the instrument measurement configuration for the particle calibration used in this report. The UV calibration set up was similar. The sensor electrical configuration was identical for the UV calibration.

## 2 Functional Test of the NPI Flight Model

The functional test of the NPI sensor was designed to verify the basic functionality of the sensor, measure the MCP-bias saturation voltage and measure the sensor dark response. The functionality of the sensor was satisfactory. The sector priority effect with increasing MCP bias observed in the ASPERA-3 NPI was found to be negligible in the ASPERA-4 NPI.



Electrical configuration:



Figure 1: Calibration configuration of the sensor.

Table 1: Beam parameters for the saturation measurement.

QIIIOII0.	
Species:	$H_2O^+$
Energy:	$4.8 \ keV$
Intensity:	$0.097 \cdot 10^{-11} A$
Sector:	4
Sampling time:	1 s (averaged over 60 s)



Figure 2: Measured total count rate with MCP bias voltage. This measurement was made with a 4.8 keV,  $H_2O^+$  beam.

#### 2.1 MCP Saturation

Micro channel plates have a saturation bias, at which the count rate from the plate no longer increase with bias. The optimal operation bias is just prior to the saturation bias. This measurement was done to find the optimal operation bias. The measurement setup for the saturation measurement is in Fig. 1. The measurement beam parameters are in Table 1: A

plot of the measured total count rate with increasing MCP bias voltage is in Fig. 2. From the figure the optimal operating MCP bias voltage should be in the shoulder region of 2420 - 2520 V. The nominal operating MCP bias voltage is set to 2430 V.

#### 2.2 MCP Dark Current

MCPs have a dark current associated with them. A plot of the NPI dark count at nominal MCP bias is in Fig. 3. There is a clear anomaly in sector 22. Another dark current measurement was made after the calibration and the anomaly had decreased some. It is therefore believed to be caused by some impurity on, or within the MCP plates at the position corresponding to sector 22. The effect is reduced after operation effectively during several hours in the calibration. It is believed that the anomaly will continue to reduce and eventually disappear. The instrument setup for the dark count measurement is in Fig. 1. No beam was used in this measurement. The sampling time was 1 s and the measurement was averaged over 60 samples. Table 2 lists the total dark count for each NPI sector during 60 seconds for different MCP bias.

#### 3 Particle Calibration of the Flight Model

#### 3.1 Calibration Plan

The calibration plan of the NPI sensor includes a full investigation of the response of one sector only and then an investigation of the relative response of the other sectors. Thorough investigation of all 30 open sectors would be too time consuming. An investigation of one reference sector should include the angular response (scans of azimuth and elevation angles) at different beam energies. Also, the efficiency should be calculated for different energies Suggested beam energies are 0.5, 0.75, 1.0, 5.0 and 10 keV.

When the response from the reference sector is known, a relative response of the other sectors is found from a  $360^{\circ}$  azimuth scan with elevation angle fixed at the maximum response of the reference sector.

#### 3.2 Angular response

Full azimuth and elevation scans were performed on sector 4 and responses for nominal MCP bias (2430
	MCP bias	MCP bias	MCP bias	MCP bias
Sector	2340 V	2380 V	2430 V	2470 V
0	0	0	4	5
1	2	3	5	2
2	0	5	5	5
3	0	1	6	10
4	1	2	4	5
5	2	3	2	3
6	1	0	6	4
7	0	2	4	4
8	1	1	3	4
9	1	1	4	6
10	2	2	2	9
11	0	2	2	4
12	1	2	6	5
13	0	0	3	5
14	0	2	2	11
15	0	1	2	3
16	3	0	5	6
17	1	3	4	3
18	1	3	3	7
19	1	3	3	7
20	0	3	4	4
21	0	2	5	5
22	0	4	23	59
23	1	2	2	6
24	2	0	1	4
25	1	3	1	4
26	1	2	1	4
27	1	1	3	3
28	1	2	3	3
29	0	1	5	4
30	2	1	5	6
31	3	4	3	5
Total	29	61	131	215

Table 2: Dark count at different MCP bias. Sampling time is 60 seconds.

E



Figure 3: Normalized dark count for all sectors at different MCP bias.

Table 9. Beam parameters for the angular seams.	Table 3:	$\operatorname{Beam}$	parameters	for	$_{\mathrm{the}}$	angular	scans.
---	----------	-----------------------	------------	-----	-------------------	---------	--------

Species:	$H_2O^+$
Energy:	$4.8 \ keV$
Intensity:	$\approx 0.14 \cdot 10^{-11} - 1.2 \cdot 10^{-11} A$
Sector:	4 (full scan : $\Delta \varphi = 1^{\circ}$
	and $\Delta \theta = 1^{\circ}$ )
Sampling time:	1 s

V) and an additional two MCP bias settings (2380 V and 2470 V) were recorded. The normalized responses are in Fig. 4. The measurement configuration is shown in Fig. 1. The ion beam configurations for these measurements are in Table 4.

#### 3.3 Azimuth scan

The azimuth scan response for the NPI sensor at nominal MCP bias (2430 V) is in Fig. 5. The instrument configuration for this measurement is in Fig. 1 and the beam parameters for this measurement is in Table 5. The relative response of the different sectors are in table 3. It shows the averaged response of the sector centers (azimuth center  $\pm 2^{\circ}$ ) for each sector

Table 5: Beam parameters for the azimuth scans.

Species:	$H_2^+$
Energy:	$4.\overline{8} \ keV$
Intensity:	$\approx 1.5 \cdot 10^{-11} A$
Sector:	0-31 (full scan : $\Delta \varphi = 2^{\circ}$ )
Sampling time:	1 s

relative to sector 4 and should be used to normalize the different sector responses prior to data analysis.

#### 3.4 Efficiency Measurement

The particle efficiency  $\varepsilon$  of the NPI sensor is measured as a count rate C over beam current I for the ratios of the beam profile area  $A_{beam}$  and the effective sector target block area of the NPI,  $A_{eff}$ :

$$\varepsilon = \frac{C \cdot A_{beam}}{I \cdot A_{eff}},\tag{1}$$

Here, the target block area,  $A_{eff}$ , is 0.128  $cm^2$  and  $A_{beam}$  is limited to 10.1 mm using a slit. The beam current is:

$$I = \frac{I_{faraday}}{e},\tag{2}$$



Figure 4: Angular scan of sector 4 at MCP bias 2380 V (top left and right) with corresponding fits (bottom left and right).

			Tab	le 4: 'L'I	he data	points	of the $i$	angular	respor	ise of p:	articles	for MC	$\mathcal{F}$ bias	$2430 \vee$				
16 -14 -1	-14 -1	-1	5	-10	8-	-6	-4	-2	0	2	4	9	8	10	12	14	16	18
000 0.0002 0.	0.0002 0.	Ö	7000	0.0000	0.0002	0.0000	0.0005	0.0003	0.0003	0.0002	0.0000	0.0002	0.0005	0.0004	0.0002	0.0000	0.0002	0.0004
0000 0.0002 0	0.0002 0	0	0000.	0.0004	0.0002	0.0003	0.0009	0.0005	0.0002	0.0002	0.0000	0.0000	0.0002	0.0000	0.0000	0.0002	0.0002	0.0000
0000 0.0002	0.0002		0.0002	0.0002	0.0007	0.0009	0.0000	0.0005	0.0009	0.0007	0.0003	0.0002	0.0003	0.0002	0.0000	0.0000	0.0005	0.0000
000 0.0012	0.0012		0.0009	0.0026	0.0061	0.0201	0.0181	0.0408	0.0372	0.0387	0.0449	0.0193	0.0191	0.0052	0.0049	0.0043	0.0016	0.0015
0.0028 0.0028	0.0028		0.0074	0.0182	0.0225	0.0697	0.1340	0.2114	0.2103	0.2221	0.2091	0.0705	0.0703	0.0280	0.0336	0.0255	0.0093	0.0038
000 0.0082	0.0082		0.0242	0.0474	0.0494	0.1292	0.3649	0.4605	0.4929	0.5073	0.3778	0.2071	0.1438	0.0695	0.0760	0.0657	0.0414	0.0082
000 0.0184	0.0184		0.0522	0.0778	0.0780	0.2418	0.6249	0.7563	0.7948	0.7526	0.7042	0.3733	0.2420	0.1415	0.1208	0.1062	0.0726	0.0191
000 0.0240	0.0240		0.0645	0.0954	0.0811	0.3209	0.7612	0.9349	1.0000	0.9382	0.9249	0.4656	0.3023	0.1618	0.1548	0.1399	0.0929	0.0298
000 0.0238	0.0238		0.0641	0.0756	0.0564	0.2954	0.6589	0.7473	0.7932	0.7691	0.7675	0.5990	0.2427	0.1367	0.1252	0.1138	0.0875	0.0218
000 0.0196	0.0196		0.0473	0.0522	0.0470	0.2354	0.4610	0.4919	0.5309	0.5321	0.5058	0.4438	0.2001	0.0878	0.0806	0.0691	0.0648	0.0241
000 0.0182	0.0182		0.0296	0.0258	0.0243	0.1277	0.2660	0.2694	0.2857	0.2949	0.2888	0.2496	0.1209	0.0514	0.0412	0.0346	0.0421	0.0143
0000 0.0059	0.0059		0.0074	0.0065	0.0094	0.0228	0.0615	0.0716	0.0784	0.0817	0.0737	0.0549	0.0371	0.0074	0.0098	0.0089	0.0085	0.0045

2430 V	10
P bias	0
for MC	e
articles	V
se of p	c
respon	0
ngular	
of the a	V
points	9-
ne data	0
le 4: Th	-10
Tabl	-12
	⊢

$\operatorname{Sector}$	0	1	2	3	4	5	6	7	8	9	10
Relative											
sensitivity	0.45	0.60	0.74	0.88	1.00	0.95	0.41	0.28	0.41	1.0.23	0.22
Sector	11	12	13	14	15	16	17	18	19	20	21
Relative											
sensitivity	0.27	0.46	0.46	0.44	0.00	0.00	0.52	0.47	0.49	0.49	0.47
Sector	22	23	24	25	26	27	28	29	30	31	
Relative											
sensitivity	0.47	0.29	0.36	0.26	0.40	0.39	0.37	0.63	0.48	0.58	

Table 6: Response (measured count/s) to particles for all sectors relative to the response of sector 4.

where  $I_{faraday}$  is the Faraday cup reading and e is the elementary charge.

The measurement configuration is found in Fig. 1. Efficiency measurements were made for different MCP bias using  $H_2O^+$  and  $H^+$  ions of different energies. An efficiency measurement with blocked neighboring sectors were also made. The measurement beam parameters were:

Species:	$H_2O^+$
Energy:	$0.29, 0.48, 0.96$ and $4.8 \ keV$
Intensity:	$\approx 1\cdot 10^{-14}$ - $7\cdot 10^{-11}~A$
Sector:	4
Sampling time:	$30 \ s$

Fig. 6 is a plot of the efficiency to  $H_2O^+$  and  $H^+$  ions with and without neighboring sectors blocked.

#### 3.5 Estimation of geometrical factor

The response of each sector on the NPI is defined as a count rate C = counts/s. If the effective area (area of the target block visible from the sector aperture) of one NPI sector is  $A_{eff}$  the The measured geometrical factor G is defined as:

$$G = \frac{A_{eff}(\theta_0, \varphi_0)}{C_{meas}(\theta_0, \varphi_0)} \int_{\varphi} \int_{\theta} C_{meas}(\theta, \varphi) \cos \theta d\theta d\varphi, \quad (3)$$

where  $A_{eff}$  is the effective areal size, C is the measured count rate,  $\theta$  is the elevation angle and  $\varphi$  is the azimuth angle. The calibration data from sector

14 on MEX NPI was used for the geometrical factor calculation. From the calibration measurements in the center of sector 14  $C(0,0) \approx 68$  and the effective target area of one sector in the NPI is  $A_{eff} =$  $0.128 \ cm^2$ . Calibration measurements of instrument elevation and azimuth response gives:

$$\int_{\varphi} \int_{\theta} C(\theta, \varphi) \cos \theta d\theta d\varphi = 1.46$$

and from equation 3 this results in a geometrical factor of:

$$G_{sector} \approx \frac{0.128}{68} \cdot 1.46 = 2.7 \cdot 10^{-3} cm^2 sr$$

# 4 UV calibration of the flight model

An MCP is also a good detector of photons in the UV range. The response efficiency is a function of UV wavelength with a higher efficiency towards lower wavelenghts. This is a problem when operating the sensor in space because the UV output of the Sun. The predominately abundant wavelenght from the the Sun in the UV range is the hydrogen Lyman- $\alpha$  (L<sub> $\alpha$ </sub>) line at 121.6 nm. For photons in this region the sensitivity of the MCPs is about 1 percent. To estimate the effect of the Solar UV contamination on the particle measurements we measured the response from the sensor to L<sub> $\alpha$ </sub>. As for the particle calibration the approach was to find the detailed UV response of only one of the 32 sectors of the NPI. Then make a relative measurement of the central position of the

other 31 sectors. Also the response linearity with UV intensity was checked. Only the VEX NPI was calibrated against UV.

To be able to produce a count in the NPI a photon will have to get through a number of steps. First, obviously, it has to hit the aperture within a specific angular range. The deflection plate surfaces are coated with copper sulfide. It creates a powdery surface that is uneven on a small scale to prevent reflections. Assuming that it impacts the NPI target block it may be absorbed, in which case there will not be any count associated with the photon, or reflected towards the MCP stack. The target block is coated with DAG-213, which is resin based graphite solution. The VEX NPI UV calibration is, to our knowledge, the first time DAG-213 UV reflection efficiency is measured. Expected efficiency  $(\varepsilon_{tb})$  is around  $10^{-5}$ . There could also be small variations in the coating over the area of the target block of the NPI. The efficiency of the MCP itself for UV of the Lyman-alpha wavelenght  $(\varepsilon_{Ly})$  is  $\approx 1$  %. So the combined expected efficiency of the NPI for  $L_{\alpha}$  photons is

$$\varepsilon = \varepsilon_{tb} \cdot \varepsilon_{Ly} = (10^{-5}) \cdot (10^{-1}) = 10^{-6}$$
 (4)

We estimate the UV-intensity in the calibration beam using an absolutely calibrated channeltron. A beam map (Fig. 7) was aquired using the channeltron and the result is then compared to the continous measurements with the beam monitor. This way we can get an estimate of how many photons are entering the NPI aperture at different readings of the beam monitor (the scaling factor turned out to be k = 386). This is only a rough estimation, in which the beam map in Fig. 7 has been approximated to a linear rise, a plateu and linearly decrease. During the measurements a common beam monitor reading was  $C_{bm} = 18$  kHz. Applying our rather gross approximation gives a number for the estimated count rate of the NPI when the beam is pointed into an aperture:

$$R_{UV} = C_{bm} \ k \ \varepsilon = (18 \cdot 10^3) \times (386) \times (10^{-6}) = 7 \ s^{-1}$$

The linearity of the UV response is important to understand the UV contamination measured in space.



Figure 7: The measured beam map with the aperture used during the UV calibration of VEX NPI.

Table 7: Recorded count rate for different intensities.

R <sub>BeamMonitor</sub> [kHz]	$I [s^{-1}]$	$C_{NPI} [s^{-1}]$
3.4	$1.4 \cdot 10^{6}$	5.5
9.0	$3.5\cdot 10^6$	18.0
18.0	$6.9\cdot 10^6$	31.9

If we know that the response is more or less linear within certain intensities we can scale the response against what is present in space to determine how much Sun contamination we can expect. Measurements were made at three different  $L_{\alpha}$  intensities. The beam monitor read out, UV intensity and NPI count rate recorded are in Table 2 and the result is shown in Fig. 10a.

It is also important to know what the UV response is at different incident angles to an NPI aperture. The angular scan reveals how wide the UV response is, but also if there are any reflections off of the deflection plates or the spokes in the deflection system that can reach the MCP. Because of limited space and the movement of the control yoke in the calibration tank, the angular scan was made with respect to the aperture plane of the NPI (sector 4). We should thus expect not to see any counts in any other sector than number 4. If we do, this must be a result of internal reflections since all photons from the beam is directed into sector 4 for all angles. The result of the angular scan is shown in Fig. 8 and listed in Table 8.

The response to  $L_{\alpha}$  photons in sector 4 response of other sectors was measured only in the centeraperture of each sector. The geometry of the calibration tank allowed only six sectors to be measured at a time. Then the vacuum had to be broken and the NPI remounted. Measurements of all 32 sectors required six remountings with pumping time in between. The relative measurements was thus a rather lengthy process. The beam intensity varied somewhat between mountings. The intensity is compensated for in Fig. 9. Compensation is based on continuous beam monitor read outs during the measurements.

Fig 10b shows the sum of all counts during the angular scan in alla sectors. There are visible counts in sectors 3,4, and 5. However, the total count into the neighboring sectors are less than ten percent of that in sector 4.

To ensure that there are no reflections from the spokes of sectors other than the sector in the direction of the UV source a translation measurement was made. Sector aperture number 4 was centered on the UV beam and the NPI was then horisonally translated according to Fig. 10c. The space in the tank limited the translation to less than the full diameter of the NPI. However, reflections from aperture spokes further away than the translation range is highly unlikely as it would require a multitude of reflections to reach even the target block. The resulting count in sector 4 is shown in Fig. 10d.

In conclusion the UV efficiency of the VEX NPI sensor is around  $10^{-5}$ .

		· · · · · · · · · · · · · · · · · · ·		-	)						
	-10	°∼	9-	-4	-2	0	2	4	9	8	10
4	0.0000	0.0071	0.0000	0.0000	0.0357	0.0143	0.0071	0.0000	0.0071	0.0000	0.0071
7	0.0000	0.0000	0.0430	0.1434	0.4230	0.4158	0.1936	0.0860	0.0215	0.0143	0.0072
0	0.0000	0.0216	0.0504	0.4101	0.8705	1.0000	0.5540	0.1295	0.0216	0.0072	0.0000
-2	0.0000	0.0000	0.0361	0.2743	0.4187	0.5414	0.2888	0.0505	0.0072	0.0000	0.0072
-4	0.0000	0.0072	0.0000	0.0507	0.1376	0.1087	0.0797	0.0072	0.0000	0.0072	0.0000
-9	0.0000	0.0073	0.0073	0.0073	0.0073	0.0073	0.0000	0.0073	0.0145	0.0000	0.0073

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Sector	0	1	2	3	4	5	6	7	8	9	10
Relative											
sensitivity	1.18	0.84	1.014	1.03	1.00	0.88	0.53	0.54	0.78	0.69	0.84
Sector	11	12	13	14	15	16	17	18	19	20	21
Relative											
sensitivity	0.77	0.77	0.62	0.88	0.00	0.00	1.00	0.87	0.77	0.84	0.74
Sector	22	23	24	25	26	27	28	29	30	31	
Relative											
sensitivity	0.67	0.50	0.68	0.57	0.81	0.98	0.96	1.05	0.93	1.50	

Table 9: Response (measured count/s) to UV for all sectors relative to the response of sector 4.



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Figure 5:  $360^{\circ}$  azimuth scan of normalized sector response. The sector numbers are displayed. Measurement was made with MCP bias of 2300 V and a deflector voltage of 1000 V.



Figure 6: (Left) Efficiency using  $H_2O^+$  ions with neighboring sectors open. (Right) Efficiency using  $H_2O^+$  and  $H^+$  ions with neighboring sectors mechanically blocked.



Figure 8: Angular scan of sector 4.



Figure 9: Response with the UV beam directed into the centers of all sectors.



Figure 10: (a) UV intensity versus the NPI count rate. (b) The total sum of the angular scans. (c) Translation measurement set up with  $\Delta x = 3$  mm. (d) Count during translation measurement.





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# APPENDIX 2. NPD CALIBRATION REPROT

# Calibration report on NPD1 / NPD2 ASPERA-4 Venus-Express Ver 1.0

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May 24, 2005

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# **1** NPD general description

- NPD sensor is developed for VenusExpress mission ASPERA-4 experiment
- Calibrated: 2004
- Launch date October, 2005 (launch to Venus)
- Integrated into ASPERA-4. NPD1 closer to the Digital Processing Unit (DPU), NPD2 outermost one.

4

Neutral Particle Detector (NPD) developed for the ESA Mars-Express and Venus-Express missions is a compact low weight (650g) high efficiency sensor to image low Energy Neutral Atoms (ENA) resulted from the solar wind interaction with the Martian exosphere. NPD provides measurements of the ENA differential flux over the energy range 100 eV - 10 keV resolving H and O with a coarse  $5 \times 30^{\circ}$  angular resolution and total efficiency  $1 \div 50\%$ . The sensor consists of two identical detectors each with a  $9 \times 90^{\circ}$  intrinsic field of view placed on a scanning platform which performs  $180^{\circ}$  scans to cover a hemisphere. The measurement principle is based on surface interaction technique.

Principle design of the NPD sensor, see Figure 1

ENA incident on a start surface at a grazing angle of  $15^{\circ}$  are reflected under approximately a mirror angle and cause secondary electron emission in the Start Surface. The secondary electrons are transported to an Start MicroChannel Plate (MCP) assembly, which gives the START signal. The reflected ENA hit the stop surface and again produce the secondary electrons used to generate the STOP signal in the Stop MCP assembly. The Time-of-Flight (TOF) measurements give ENA velocity, the STOP signal is also used to identify mass (H or O). Coincidence technique as well as properties of the START and STOP surface coating provide Ultra-Violet (UV) suppression to the level sufficient to achieve the required signal-to-noise ratio.

# 2 NPD calibration setup. Coordinate system. Technical details.

## **2.1** Technical details

As it is seen on the Figure 1, the sensor has 3 detectors in the azimuthal plane. The detector directions definition are presented on the Fig. 2. The basic position of the NPD sensor, integrated into ASPERA-4 is such, that its long side is placed in the horizontal



Figure 1: The principle design of NPD sensor.

plane, along the scanner platform. While scanning it will scan in the NPD's elevation plane.

Figure 2 describes the directions of view of each of NPD detectors. The "zero" direction is set to correspond to the detector placed in the vertical plane, which is along the short side of the chassi. The direction 2 corresponds to the detector placed in the horizontal plane with the pinhole position. The detector 1 is the detector in-between the 0 one and the number 2.



Figure 2: The Instrument directions definition.

The cross-section of the sensor along the plane "pinhole – Detector 1" is shown on Figure 3. The deflector is declined on  $15^{\circ}$  from the Start Surface plane. The incoming beam comes though the collimator slit, between deflector electrodes, through a pinhole and incident on a Start Surface. The collimator slit has dimensions  $4.5 \times 70.0 mm^2$ . The distance between deflector electrodes is 4.5mm. They are biased with +/-5kV to deflect charged particles with energy less than the deflector energy cut-off 60 keV. Deflector provides field of view of the sensor  $9^{\circ} \times 90^{\circ}$ . Pinhole has dimensions  $3.0 \times 4.5mm^2$ . On the sensor cross-section on the Figure 3 Deflector, Start Surface, Stop Surface and the middle Stop MCP detector are clearly seen.



Figure 3: The Instrument's cross section.

# 2.2 Calibration facilities

Each NPD sensor has been calibrated in the Swedish Institute of Space Physics (IRF, Kiruna).

# 2.3 Calibration setup

Each sensor has been calibrated in a stand-alone configuration.

On the Figure 4 NPD calibration mechanical setup is shown. NPD is placed into the vacuum chamber on the turntable at the distance  $\sim 1.7m$  from the output aperture of the ion beam source. It can be sweeped in both azimuthal and elevation directions in the wide range of angles,  $> 90^{\circ}$  in both directions with an accuracy better than 1°. Also the turntable can be translated across the incident beam in the vertical and horizontal directions to align the sensor's aperture and the ion beam. The ion source aperture diameter is 36 mm.

A Faraday cup is used to measure the ion beam intensity. As the Faraday cap entirely covers the aperture it is not possible to monitor the ion beam intensity continuously. The beam intensity is measured before and after measurement cycle. The system produces quite stable ion beam with intensity variation time scale larger than a measurement cycle. During the calibration period the parallel ion beam is to be used. But sometimes to de-

-7



Figure 4: NPD calibration mechanical set up.

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crease its density or to make a beam profile smoother (means more homogenious ion beam) the ion beam focusing/defocusing could be done. The maximum beam divergence is estimated to be less than 2%. Therefore the ion beam spot at the NPD location can vary about 36 to 60 mm in cross section. The scanning across the ion beam spot procedure is invented to take the ion beam spot diameter variation into account. The procedure is describe in details later on.

Sensor calibration is done under next conditions:

- Beam intensity in general case is set to keep a count rate on the StartMCP about  $(1 \div 3) \times 10^3$  count/sec.
- Integration time: 1 sec
- Deflector electrodes are grounded. So the sensor is calibrated using the charged ion beam. It is done to provide the proper beam current. Note: the neutral part of the ion beam is about a few procent of the initial beam current. The results are comparable with the measurements with ENA beam.
- The pressure in the vacuum chamber was kept approximately  $4 \times 10^{-7} mbar$

During the measurements NPD sensors produced data in RAW and BIN matrix modes. Details about NPD modes can be found in 'DigTOFinASPERA/NPD' document (see  $'NPD\_description03.pdf'$ ).

# 2.4 Calibration plan

In order to get the relative and absolute characteristics of the instrument the next calibration procedure has been developed:

- 1. MCP characterization to obtain the nominal bias.
- 2. Efficiency measurements.
- 3. Angular response measurements.
- 4. Geometrical Factor calculation.
- 5. TOF distributions and Pulse Height (PH) distributions analysis.
- 6. Energy and Mass resolution.
- 7. Heater test. Temperature sensor response.
- 8. Noise of the NPD sensors integrated with ASPERA-4 instrument.



Figure 5: The count rates of Start, Stop0, Stop1, Stop2 detectors (MCP) in dependency on MCP bias for NPD1 (left panel) and NPD2 (right panel) are shown.

# **3** Calibration of the VEX NPD1 / NPD2 Flight Models.

Calibration of NPD units has been done in order to estimate the different parameters of the sensor, such as efficiency, geometrical factor, angular and energy resolution. The calibration results fully correspond to the specified performance.

# 3.1 MCP characterization

To find out the nominal bias for all detectors the MCP characterization is done for the next conditions:

- Ion beam:
  - > Species:  $H_2O^+$  ions
  - > Energy: 5 KeV
  - > Intensity: Beam intensity is set to keep count rate on Start MCP about  $\sim (1\div3)\times10^3\,{\rm count/sec}$
- The MCP bias range 2.3 to 2.9 kV. Count rate measurement at every 50 V steps
- Integration time:  $\sim 1 sec$
- The full count of Start and Stop counters without TOF validation is taken into account

Figure 5 shows the count rates of Start, Stop0, Stop1, Stop2 detectors (MCP) in dependency on MCP bias for both NPD1 (left panel) and NPD2 (right panel). The count of counters without TOF correlation is presented. Start, Stop0, Stop1, Stop2 counters are color-coded by dark-blue, green, yellow and red colors correspondingly.

## NPD1

Calibration of the NPD1 sensor is done at nominal bias voltages on MCP detectors. Nominal Start MCP bias is set to 2750V, Stop MCP bias is set to 2750 V. MCP gain degradation compensation margin is about 250 V.

## NPD2

Calibration of the NPD2 sensor is done at nominal bias voltages on MCP detectors. Nominal Start MCP bias is set to 2800V, Stop MCP bias is set to 2800 V. MCP gain degradation compensation margin is about 200 V.

# 3.2 Efficiency

### 3.2.1 Results

The absolute efficiency of the NPD1 and NPD2 sensors is measured during the calibration process. Measurements are done for the different ion species H and O, for a set of ion beam energies 0.1 to 10.0 KeV, for every NPD direction.

The efficiency of the NPD1 and NPD2 sensors for different ion mass, energy and for every direction are shown in the Table 1 and Table 2 correspondingly. — means no data. Efficiency graphs for NPD1 and NPD2 are presented on Figure 6 and Figure 7. Least-square polynomial fit of a next function 1 is performed.

$$\varepsilon = exp(\sum_{k=0}^{3} a_k \cdot ln^k(E)) \tag{1}$$

where

 $\varepsilon$  – efficiency E – ion energy, KeV  $a_k$  – coefficients

Function to calculate NPD efficiency is valid within the next energy range: 0.1 to 5.0 KeV for H and 0.3 to 10.0 KeV for O.



Figure 6: The figure shows the NPD1 sensor absolute efficiency curves in dependency on ions mass and energy for different directions.

	$\varepsilon,\%$								
	E, KeV	10.0	5.0	3.0	1.3	0.7	0.5	0.3	0.1
	Dir0	10.3	8.2	6.4	1.4	0.27	0.13	—	_
$O^+$	Dir1	11.8	8.9	5.1	1.7	0.48	0.17	0.034	_
	Dir2	8.5	6.5	2.7	0.8	0.12	0.07	_	_
	Dir0	—	4.1	6.1	2.7	1.1	0.78	0.23	—
$H^+$	Dir1	_	4.2	6.2	2.8	1.6	1.1	0.41	0.026
	Dir2	_	2.9	3.5	1.3	0.7	0.48	0.15	-

Table 1: NPD1 efficiencies in dependency on ion mass and energy and direction.

	$\varepsilon,\%$							
	E, KeV	5.0	3.0	1.3	0.7	0.5	0.3	0.1
	Dir0	6.63	4.5	0.85	0.15	0.037	0.005	—
$O^+$	Dir1	6.1	4.6	0.95	0.25	0.08	0.014	—
	Dir2	10.7	8.9	2.2	0.49	0.14	0.019	—
	Dir0	3.6	3.4	1.62	0.59	0.31	0.092	—
$H^+$	Dir1	3.9	3.6	2.1	0.86	0.48	0.16	0.013
	Dir2	6.0	6.3	3.4	1.55	0.82	0.3	_

Table 2:	NPD2	efficiency
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Table shows the NPD2 efficiencies in dpendency on ion species and energy and direction



Figure 7: The figure shows the NPD2 sensor absolute efficiency curves in dependency on ions mass and energy for different directions.

### 3.2.2 Measurements process

Absolute efficiencies had been calculated using BINning array data (coincidence flag equals 0).

NPD sensor efficiency depends on a set of factors such as ion species mass and energy, MCP bias voltage, azimuthal and elevation angles, so on.

Beam Energy: 10.0, 5.0 keV, 3.0 keV, 1.3 keV, 0.7 keV, 0.5 keV Species:  $H^+$ ,  $H_2O^+$ Direction: Dir0, Dir1, Dir2

To measure the sensor's absolute efficiency the next conditions should be fulfilled:

- Count rate measurement at  $\alpha_0, \beta_0$  angles at which the detectors count rate has a maximum value.
- Ion beam is parallel and stable
- Ion beam spatial distribution is homogeneous.
- MCP bias voltage is stable.

The default position of NPD sensor during efficiency measurements is  $\alpha = 0$ ,  $\beta = 0$ . But as it is seen from angular response measurements, the maximal count rate is achieved at  $\beta_e = 1.5^\circ$ . The ratio between detector's count rate at  $\alpha, \beta$ : C( $\alpha, \beta$ ) and count rate at  $\alpha, \beta_e$ : C( $\alpha, \beta_e$ ) is  $K_e$ :

$$K_e = \frac{C(\alpha, \beta_e)}{C(\alpha, \beta)}$$

where

 $K_e$  - elevation coefficient

The efficiency values are to be corrected by using the  $K_e$  coefficient.

Measurements by the detector Dir1 are performed at  $\alpha = 0^{\circ}$ . Measurements by the directions Dir0 and Dir2 are performed at  $\alpha = +/-40^{\circ}$  for NPD1 and  $\alpha = +/-35^{\circ}$  for NPD2 (see Figure 4). For the azimuthal angle  $\alpha$  equal to  $45^{\circ}$ , count rate drops drastically. The maximum azimuthal response is achieved with the next  $\alpha$  angles:

Dir0  $\alpha_a = -35^\circ$ Dir1  $\alpha_a = 0^\circ$ 

Dir2  $\alpha_a = +35^{\circ}$ 

The ratio between detector's count rate at  $\alpha, \beta$ :  $C(\alpha, \beta)$  and count rate at  $\alpha_a, \beta$ :  $C(\alpha, \beta)$  is  $K_a$ :

$$K_a = \frac{C(\alpha_a, \beta)}{C(\alpha, \beta)}$$

where

 $K_a$  - azimuthal correction coefficient

The efficiency values are to be corrected by using the  $K_a$  coefficient also.

The table 3 and table 4 show the values of elevation and azimuthal correction coefficients for each of NPD sensors.

NPD1	$K_e$	$K_a$
Dir0	1.0	1.0
Dir1	1.0	1.0
Dir2	1.0	1.0

Table 3: Table shows the values of elevation and azimuthal correction coefficients for each of NPD1 detectors.

NPD2	$K_e$	$K_a$
Dir0	1.0	1.0
Dir1	1.0	1.0
Dir2	1.0	1.0

Table 4: Table shows the values of elevation and azimuthal correction coefficients for each of NPD2 detectors.

To minimize the ion beam not uniform spatial distribution effect on efficiency measurements all ion beam particles have been counted by performing the scan of the area larger than the ion beam spot at the NPD location. Scan procedure is shown on Figure 8. First of all by scanning along x-axis and/or y-axis beam borders had been found. Meanwhile it was checked if beam is homogeneous. Beam profile could be tuned if necessary. Sensor was translated along the vertical and horizontal axes by steps dV = 3.0mm, dH = 4.5mm. Pinhole zigzagged covering the spot area A equals to:

$$A = 60 \times 63mm^2$$

Pinhole should cover whole beam spot area, therefore steps are chosen according to the pinhole sides lengths. This is valid for all snesors and every direction. The integration time at each measurement point is about 1 sec. Figure 9 shows the number of beam profile images got by the instrument for different ion masses and energy by sensor's detector Dir1. Finally the integral count rate is calculated. Beam intensity was checked before and



Figure 8: The upper part of the figure shows a scan procedure for NPD sensor during calibration. The lower rectangulars show the pinhole open area in dependency on azimuthal and elevation angles.

after each scan. If beam intensity values has been different arithmetic mean was taking into account. Then efficiency has been calculated according to the Eguation 2:

$$\varepsilon = \frac{C \cdot q_e}{J \cdot T_{int}} \tag{2}$$

where

 $\varepsilon$  - calculated efficiency,

C - measured integral count rate,  $\frac{1}{sec}$ 

 $q_e$  - electron charge,

 $T_{int}$  - integration time, s

 $\boldsymbol{J}$  - beam intensity, A

Also it is necessary to take into account the pinhole area during measurements. The pinhole area dependency on the azimuth and elevation angles is shown on the Figure 8 lower panel. The corresponding coefficients are shown in the Table 5.

- NPD is elevated on  $15^{\circ}$ , therefore the pinhole area is decreased by  $K_1 = \frac{1}{\cos 15^{\circ}}$
- For  $\alpha = +/-40^{\circ}$  pinhole area is decreased by  $K_2 = \frac{1}{\cos 40^{\circ}}$ . For  $\alpha = 40^{\circ}$  scan steps should not be changed, but we have to take into account covered pinhole area coeffi-



Figure 9: The figure shows the beam images as its are seen by NPD sensor.

cient  $K_2$  to maintain the scan procedure. Otherwise it would require more steps for each scan, therefore much longer. In that case beam intensity long-time variations can take place.

	NPD1	NPD2
$K_1$	1.04	1.04
$K_2$	1.31	1.22

Table 5: Table shows the correction koefficients  $K_1$  and  $K_2$  which describes the pinhole normal declination from the ion beam direction for NPD1 and NPD2 detectors.

Finally the corrected efficiency formula is shown by Equation 3

$$\varepsilon_{corr} = \varepsilon \cdot K_{meas} \tag{3}$$

where

 $\varepsilon_{corr}$  – the corrected absolute efficiency of a detector

 $K_{meas}$  – efficiency correction total coefficient (equation 4)

$$K_{meas} = K_e \cdot K_a \cdot K_1 \cdot K_2 \tag{4}$$

where

 $K_1$  - declination coefficient 1/cos (15),

 $K_2$  - (optional) pinhole open area coefficient for side directions,

 $K_e$  - elevation correction coefficient

 $K_a$  - azimuthal correction coefficient

In the table 6 the correction coefficient  $K_{meas}$  for both NPD1 and NPD2 sensors are presented.

	NPD1	NPD2
$K_{meas}$	1.36	1.27

Table 6: Correction koefficients  $K_{meas}$  to correct efficiency calculations for both NPD1 and NPD2 sensors.

The efficiency measurements has been done for the next ion beam settings:

- NPD1
  - Species:  $H_2O^+$ ; Energy, KeV: 10.0, 5.0, 3.0, 1.3, 0.7, 0.5, 0.3
  - Species:  $H^+$ ; Energy, KeV: 5.0, 3.0, 1.3, 0.7, 0.5, 0.3, 0.1
- NPD2
  - Species:  $H_2O^+$ ; Energy, KeV: 5.0, 3.0, 1.3, 0.7, 0.5, 0.3
  - Species:  $H^+$ ; Energy, KeV: 5.0, 3.0, 1.3, 0.7, 0.5, 0.3, 0.1

## **3.3** Angular response of NPD sensor

Angular response of sensor is obtained under the next conditions:

- The incident beam species:  $H^+$
- The beam Energy: 5 KeV
- Azimuthal scan range  $-50^{\circ}$  to  $+50^{\circ}$  with step  $5^{\circ}$
- Elevation scan range  $-7.5^{\circ}$  to  $+7.5^{\circ}$  with step  $1.5^{\circ}$
- Exposition time at every point:  $\sim 1 \sec \theta$

During the angular responce measurements the valid count rate is measured. Valid count rate stands for the count of any Start MCP signal which is followed by a one of Stop detectors signal within the definite time window. In terms of data that type of count rate has a coinidence flag equal to 0.

Figures 10, 11 show the angular response of NPD1 and NPD2 detectors. The left column shows the measured 2D angular response for all directions Dir0/Dir1/Dir2. The middle column consists of curves of angular response integrated over the elevation angle. The right column shows the curves of the angular response integrated over the azimuthal angle. The Full Width on Half of Maximum (FWHM) of the curves is wider then the theoretical calculations. That can be explained by the properties of the Start surface. The Dir0 and Dir2 detectors peaks are sharp at the outermost sides, that is due to the geometrical constraines like position and shape of the baffles, placed between the Start Surface edges and the Stop surface edges. The elevation response curves are looking similar to each other, because they are defined by the deflector configuration (position of deflector electrodes). Table 7 show the geometrical constats  $G_0$  of the instruments.

## **3.4 Geometrical Factor calculation**

Geometrical factor of the instrument is an integral of the entrance effective area over solid angle as shown by Equation 5.

$$G = \int_{\theta} \int_{\varphi} A_{eff}(\theta, \varphi) cos\theta d\Omega$$
<sup>(5)</sup>

In our case that formula looks as below (Equation 6):

$$G = \int_{\alpha} \int_{\beta} A_{eff}(\alpha, \beta) \cos\alpha d\alpha d\beta \tag{6}$$

where

 $A_{eff}(\alpha,\beta)$  - effective area of the sensor's aperture, depends on both azimuthal and elevation angles



Figure 10: Angular response of the NPD1 sensor. The left column shows the measured 2D angular response for all directions Dir0/Dir1/Dir2. The middle column consists of curves of angular response integrated over the elevation angle. The right column shows the curves of the angular response integrated over the azimuthal angle.

 $\alpha$  - azimuthal angle, deg

 $d\alpha$  - displacement in an azimuthal plane, deg

 $\beta$  - elevation angle, deg

 $d\beta$  - displacement in an elevation plane, deg

Effective area of a sensor's aperture is a measured count rate over ion beam density

$$A_{eff}(\alpha,\beta) = \frac{C(\alpha,\beta)}{P}$$
(7)

where

 $C(\alpha, \beta)$  - sensor count rate (depends on azimuthal and elevation angle)

P - ion beam density,  $[cm^{-2}s^{-1}]$ 

P can be expressed by ion beam current measured by a Faraday cup and ion source aperture area (Equation 8)

$$P = \frac{J}{q_e \cdot S_s \cdot t} = \frac{C_s}{S_s},\tag{8}$$

 $q_e = 1.6 \times 10^{-19} C$ J – Faraday cup current, A


Figure 11: Angular response of the NPD2 sensor. The left column shows the measured 2D angular response for all directions Dir0/Dir1/Dir2. The middle column consists of curves of angular response integrated over the elevation angle. The right column shows the curves of the angular response integrated over the azimuthal angle.

 $S_s = 10.18 \ cm^2$  – ion source aperture area,  $cm^2$ t – integration time, sec  $C_s$  – ion source output count rate,  $s^{-1}$ 

$$C_s = \frac{J}{q \cdot t}$$

Substitute  $A_{eff}$  for Equation 6

$$G = \int_{\alpha} \int_{\beta} \frac{C(\alpha, \beta)}{P} \cos\alpha d\alpha d\beta \tag{9}$$

P – a constant, so it goes out of an integral sign. Let's divide and multiply the Equation 9 by  $C(\alpha_0, \beta_0)$ 

$$G = \frac{C(\alpha_0, \beta_0)}{P} \int_{\alpha} \int_{\beta} \frac{C(\alpha, \beta)}{C(\alpha_0, \beta_0)} cos\alpha d\alpha d\beta$$
(10)

where

 $\alpha_0, \beta_0$  - azimuthal and elevation angles at which the count rate of a sensor is maximal for

the corresponding detector,

 $C(\alpha_0,\beta_0)$  – sensor's count rate, measured at the position  $(\alpha_0,\beta_0)$ 

Here an integral part of an Equation 10 is a constant  $G_0$  describing the angular properties of the sensor.

$$G_0 = \int_{\alpha} \int_{\beta} \frac{C(\alpha, \beta)}{C(\alpha_0, \beta_0)} cos\alpha d\alpha d\beta$$
(11)

Equation 11 shows a geometrical constant of the sensor. The geometrical factor equation looks now as follows:

$$G = \frac{C(\alpha_0, \beta_0)}{P} \cdot G_0 \tag{12}$$

Then I substitute the beam density P in Equation 9 by the Equation 8

$$G = \frac{C(\alpha_0, \beta_0) \cdot S_s}{C_s} \cdot G_0 \tag{13}$$

Now let me set the sensor efficiency into geometrical factor calculation. The sensor efficiency can be expressed by Equation 14

$$\varepsilon = \frac{C(\alpha_0, \beta_0)}{C_s} \cdot \frac{S_s}{S_p}$$
(14)

where

 $S_p$  =0.135  $cm^2$  – sensors pinhole area,  $cm^2$  $\varepsilon$  - detector's efficiency, calculated by Equation 2

Now ion source output count rate  $C_s$  at Equation 13 is to be substituted by the  $C_s$  expression from Equation 14. Finally,

$$G = G_0 \cdot S_p \cdot \varepsilon \tag{15}$$

where

G - geometrical factor of an instrument,  $[sr^{-1}cm^{-2}s^{-1}]$ 

Calculated geometrical constants of NPD1 and NPD2 detectors are presented in the Table 7

The table 8 and table 9 show the geometrical factor G of the NPD1 and NPD2 sensors correspondingly in dependency on incident ion beam energy and ion species mass. The efficiency  $\varepsilon$  is included.

$G_0$									
	Dir0	Dir1	Dir2						
NPD1	0.044	0.067	0.051						
NPD2	0.046	0.082	0.051						

Table 7: Table shows the geometrical constants of all detectors of NPD1 and NPD2 instruments

	$G, \times 10^{-4}$													
	E, KeV	10.0	5.0	3.0	1.3	0.7	0.5	0.3	0.1					
	Dir0	6.12	5.02	3.92	0.87	0.17	0.08	_	—					
$O^+$	Dir1	10.67	8.05	4.61	1.54	0.43	0.15	0.03	_					
	Dir2	5.85	4.48	1.86	0.55	0.08	0.05	_	—					
	Dir0	—	2.44	3.62	1.60	0.65	0.46	0.14	—					
$H^+$	Dir1	_	3.80	5.61	2.53	1.45	1.0	0.37	0.024					
	Dir2		2.0	2.41	0.90	0.48	0.33	0.10	—					

Table 8: Table shows the NPD1 sensor geometrical factor G dependency on ion species mass and energy.

## 3.5 ToF spectra

The Figure 12 shows the TOF distributions for the ion beam of one specific mass H of different energies taken by NPD1 sensor Dir1 detector. The different curves are color coded. The covered energy range is 0.1 to 5.0 KeV. The displacement of curves reflects the energy loss of about 34% during the reflection from the START surface. The Figure 13 shows the TOF distributions for the O ion beam of different energies covering the range 0.3 to 10.0 KeV. The energy losses are the same as for *H* beam. Measurements are done in RAW mode.

	$G, \times 10^{-4}$													
	E, KeV	5.0	3.0	1.3	0.7	0.5	0.3	0.1						
	Dir0	4.12	2.80	0.53	0.09	0.023	0.003	—						
$O^+$	Dir1	6.75	5.09	1.05	0.28	0.09	0.015	—						
	Dir2	7.37	6.13	1.52	0.38	0.09	0.013	_						
	Dir0	2.24	2.11	1.01	0.37	0.19	0.057	—						
$H^+$	Dir1	4.32	3.99	2.33	0.95	0.53	0.18	0.014						
	Dir2	4.13	4.38	2.34	1.07	0.57	0.21	_						

Table 9: Table shows the NPD2 sensor geometrical factor G dependency on ion species mass and energy.



Figure 12: The figure shows the TOF discribution curves for NPD1 dir1 for H in dependency on beam energy

## **3.6** Energy resolution

Summarizing the TOF measurements the TOF dependency on incident ion energy for the NPD1 sensoris presented on Figure 14. The X-axis – is ion beam energy in log scale. The Y-axis – is particles ToF in log scale. The position of ToF peaks for the set of ion beam energies are plotted by color-coded dots. Error bars show the FWHM of ToF peaks. The lower line (blue) stands for  $H^+$  ions and the upper line (red) stands for  $O^+$  ions. The dashed lines show the theoretical dependence corresponding to the 33% energy loss in the Start Surface. Water molecules produced in the source break-up during the impact but the residual components carry the same initial velocity corrected for the energy loss in the target. This figure shows that within 1 - 10 KeV the TOF measurements give reliable mass identification.

These curves can be expressed by the next equations:

$$T(H) = exp(5.31 - 0.48 * ln(E))$$
$$T(O) = exp(6.94 - 0.48 * ln(E))$$

where

E – ion particles energy, keV



Figure 13: The figure shows the TOF discribution curves for NPD1 dir1 for *O* in dependency on beam energy

T – ion particles ToF number, ns

Curves are valid for NPD1 Dir1 detector.

One of the important results can be formulated as follows: for the definite energy range (0.1 KeV - 10 KeV) low energy  $O^+$  ions can be distinguished from the high energy  $H^+$  particles by only the ToF values. On the plot (Figure 14) the functions overlap within the TOF window 280 ns – 690ns. So, the particles with ToF more than 690 ns are O type definitely. And the particles with ToF less than 280 ns are H ions. Of course the energy of incoming heavy particles can be more than 10keV, therefore the curves overlapping ToF window can be extended to lower values. The ions (both light and heavy) with ToF that fit that window have comparable velocities. So to distinguish between these species one has to analyze the PHD of the Stop detectors as well as analyze the TOF distribution shape. In case of O species of higher energy than 10 keV the estimation of particles mass based only on the TOF analysis is not very clear. For such cases the PH analysis can be done additionally.

So we can use ToF analysis to resolve energy of ion species in such mass and energy range:

• O ions

E < 1.3 keV ToF > 690 ns

*H* ions
 E > 0.7 keV
 ToF < 280 ns</li>



Figure 14: The figure shows the TOF dependency on beam energy of different ion species  $(H^+, O^+)$  for direction 1

And we have to use the PH analysis for ions species with TOF that fit the TOF window 280ns - 690ns and are within the next mass and energy range:

- TOF window: 280 ns 690 ns
- E(O) = 1.3 KeV less 10 KeV
- E(H) = 0.1 keV 0.7 keV

Lowest limit of light particles energy that can be measured by the NPD sensor is 0.1 keV. For the lower energy ions scattering on the StartSurface is too high as well as ion is not enough energetic to cause a secondary electron yield from the Stop Surface.

By applying the numbers calculated above for the compressed mode data ToF window will have the next values:

- TOF window: 246 ns 610 ns
- Compressed mode: 7 10 steps
- E(O) = 2.4 KeV less 11 KeV
- E(H) = 0.1 keV 1.0 keV

Heating test has been done during calibration. Heater had been switched on for  $\approx 10$  hours. TOF measurements have been done before and after Start Surface heating. TOF distribution didn't vary after heating. That can be explained either by too short heating time period or by too low maximum temperature of Start Surface, reached during heating or by the Start Surface cleanness.

## **3.7** Heater and temperature sensor.

Temperature sensors are calibrated after the NPD integration with the ASPERA-4 instrument. Heater increases temperature of the START unit on 50 degrees over the ambient temperature.

It takes approximately 2 hours to heat a StartSurface to the equilibrium maximum temperature.

## 3.8 Noise

NPD electronics in its most sensitive state is sensitive enough to pick up the electric noise (even without MCP HV bias). So to decrease the electric noise level electronics' discriminators thresholds are set to maximum values, that level in binary form is  $0 \times 00$  and corresponds to 5V on DAC.

Finally the noise at biased MCP detectors is less than 20 c/s. The TOF validation removes that uncorrelated noise count.





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# APPENDIX 3. ELS CALIBRATION REPROT

## Venus Express ASPERA ELS

MULLARD SPACE SCIENCE LABORATORY UNIVERSITY COLLEGE LONDON

Author: Dhiren Kataria

## Venus Express ASPERA ELS Calibration Report

## Volume 1

## DOCUMENT: MSSL/VEX/001

May 26<sup>th</sup> 2005

## **1** Introduction

The raw data from the ELS instrument consists of a matrix of counts N, each for an accumulation time T, from the sixteen anodes and to cover the energy range of interest. This needs to be converted into the phase space density f(v) of the electron distribution and the relation between N and f(v) is given by (Johnstone *et al.*, 1987):

 $dN/dt = [GF]v^4f(v)$ 

where [GF] is the geometric factor of the sensor, obtained from ground calibration, and v is the velocity at the centre of the response of the electrostatic analyzer. f(v) is then used to obtain the moments of the distribution as follows:

$$n = \int_{all \mathbf{v}} f(\mathbf{v}) d^3 \mathbf{v}$$
$$\mathbf{V} = \left(\frac{1}{n}\right) \int_{all \mathbf{v}} \mathbf{v} f(\mathbf{v}) d^3 \mathbf{v}$$
$$\underline{\mathbf{T}} = \left(\frac{m}{n}\right) \int_{all \mathbf{v}} (\mathbf{v} - \mathbf{V}) (\mathbf{v} - \mathbf{V}) f(\mathbf{v}) d^3 \mathbf{v}$$

to provide the density, velocity and temperature. The [GF], in units of  $m^2$  sr eV/eV, is given by

$$[\mathbf{GF}] = ((\mathbf{e} \Delta \mathbf{u}' \Delta \theta \Delta \phi) / \mathbf{T}_{\mathrm{C}}) \Sigma_{\mathrm{l}} \Sigma_{\mathrm{m}} \Sigma_{\mathrm{n}} \mathbf{N}_{\mathrm{lmn}} / \mathbf{I}_{\mathrm{lmn}}$$

where,  $\Delta u$ =Spacing between calibration points in velocity,

 $\Delta \theta$  =Elevation spacing,

 $\Delta \phi$ =Azimuth spacing,

T<sub>C</sub>=Accumulation time,

I=Beam current in ELS aperture per unit area,

N=ELS counts.

This document reports on the ground calibration tests carried out at MSSL for the ELS instrument. Note that [GF] incorporates both the purely geometric response of the instrument as well as the detector response.

As the Venus Express instrument was known to be mechanically imperfect and the absolute QE of the detector was not known, it would not be possible to deconvolve the geometric response from the detector response. Hence, the laboratory calibrations define the integrated instrument response and the relative response of the 16 sectors.

## 2 Calibration details

## 2.1 Calibration facility

The calibration facility [Johnstone et al., 1997], based on the technique described in Marshall et al (1986), provides a wide area photoelectron beam at energies ranging from a few eV to 15 keV with variable beam intensities from a few Hz to several MHz. The system is fully automated facilitating calibration scans over the complete range of polar and azimuth angles at several instrument voltage settings both for the analyser as well as the MCP. A flexible data acquisition system was integrated into the automation to provide simultaneous measurements from the 16 preamplifier channels, coordinated with the instruments position and voltage settings. Before performing the instrument calibration, a profile of the beam output is recorded at each of the calibration energies by means of a channeltron mounted on an X-Y table. During calibrations, the channeltron is mounted as close as possible to the instrument aperture in order to provide a constant reference to the beam intensity.

The setup for the calibration is identical to the one that was used for the calibration of the Mars Express instrument and is described in further detail in the report mex017\_fucal\_setup.doc, attached along with this report.

## 2.2 Details of tests

Tests were carried out to study the following parameters of the instrument:

Analyser: Concentricity, K-factor, Angular acceptance and Energy Resolution Detector: Operational regime, Rate response, Gain uniformity/QE

UV response

## 2.2.1 Energy Angle scans

All the analyser parameters are extracted from the Energy (sweep voltage) – Angle scans carried out at the centre of each anode for beam energies of 10eV, 30 eV, 50eV, 70eV, 100eV, 200eV at the low range of the sweep power supply and of 1 keV, 3 keV, 6 keV, 10 keV, 12 keV at the high range. Table 1 lists the details of the scans and figures 1 to 3 are example plots at 30, 200 and 3 keV respectively. Figure 4 is a plot of the k-factor for the 10 energies and Figure 5 is a plot of the energy resolution across the 16 anodes.

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Table 1. Summary of Energy angle scans carried out with the beam incident on the centre of each anode.

		MCP	DAC	Filter	Pol	ar		Elevation		Sweep		
Date	Energy	voltage	set		Angles	Anode	Step	Angles	Step	DAC set	Step	Range
	10 eV	2358	3.93	1.5	-168.75 to 168.75	0 to 15	22.5	-2.7 to 5.7	0.6	0.16 to 0.28	0.005	Low
26/06/2003	30 eV	2358	3.93	1.5	-168.75 to 168.75	0 to 15	22.5	-2.4 to 3.9	0.45	0.51 to 0.75	0.01	Low
	50 eV	"	"	"	"	"	"	"	"	0.93 to 1.17	0.01	Low
	70 eV	"	"	"	"	"	"	"	"	1.28 to 1.64	0.015	Low
	100 eV	"	"	"	"	"	"	"	"	1.8 to 2.4	0.025	Low
	200 eV	"	"	"	"	"	"	"	"	3.6 to 4.8	0.05	Low
	1keV	"	"	"	"	"	"	-1.5 to 2.7	0.3	0.105 to 0.225	0.005	High
	3keV	"	"	"	"	"	"	"	"	0.43 to 0.55	0.005	High
	6keV	"	"	"	"	"	"	"	"	0.86 to 1.1	0.01	High
	10keV	"	"	"	"	"	"	"	"	1.3 to 1.9	0.025	High
	12 keV	"	"	"	"	"	"	"	"	1.72 to 2.2	0.02	High



Figure 1. Energy Angle scans at 30 eV. Data is taken with the beam incident at the centre of each anode.

Counta per second

Program: Vex\_En\_Ang\_ver\_2.pro

Data file: X:/venusexp/vfaf030a.pdt

1s integrations for MCP 2358 V,filter OD=1.0+0.5, 30 eV, low range

Fri Jul 04 10:16:01 2003



Figure 2. Energy Angle scans at 200 eV. Data is taken with the beam incident at the centre of each anode.

Counts per second

Program: Vex\_En\_Ang\_ver\_2.pro

Data file: X:\venusexp\vfaf200a.pdt

1s integrations for MCP 2358 V,filter OD=1.0+0.5, 200 eV, low range

Thu Jul 03 16:02:57 2003



Figure 3. Energy Angle scans at 3 keV. Data is taken with the beam incident at the centre of each anode.

Counts per second

Program: Vex\_En\_Ang\_ver\_2.pro

Data file: X:\venusexp\vfaf3k0a.pdt

1s integrations for MCP 2358 V,filter OD=1.0+0.5, 3 keV, high range

Thu Jun 26 14:12:59 2003

Figure 4. Plot of k-factor across the 16 anodes for the 10 energies, 30 ev to 12 keV, violet to red.



Figure 5. Plot of the energy resolution across the 16 anodes for the 10 energies, 30 ev to 12 keV, violet to red.



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## 2.2.2 Fine polar scans

The energy-angle scans also provide the peak response of the instrument for each energy. In order to get the relative response of the instrument, a fine scan is carried out at polar steps of 0.25 degrees across the polar range of  $\pm 168.75^{\circ}$  at the peak elevation and voltage. The tests carried out are listed in Table 2 and figure 6 is an example of the response at 100 eV.



Figure 6. Plot of the response at peak elevation and sweep voltage at fine polar steps of  $0.25^{\circ}$ 

Table 2. Summary of tests carried out at fine polar angles of  $0.25^{\circ}$  at the peak elevation and sweep voltage response of the instrument .

		MCP	DAC	Filter	Pol	ar		Elevation	n	Sweep		
Date	Energy	voltage	set		Angles	Anode	Step	Angles	Step	DAC set	Step	Range
26/06/2003	30 eV	2580	4.3	1.5	-168.75 to 168.75	0 to 15	0.25	Peak	-	Peak	-	Low
	100 eV	"	"	"	"	"	"	"	"	"	"	Low
	200 eV	"	"	"	"	"	"	"	"	"	"	Low
	3 keV	"	"	"	"		"	"	"	"	"	High
	10 keV	"	"	"	"	"	"	"	"	"	"	High

#### 2.2.3 MCP voltage response

The next set of tests, summarised in table 3, determine the operational regime of the microchannel plate detector. Tests are carried out with the beam incident on anode 10 and the MCP voltage is raised from 1800V to 2880V. The results for the different energies, normalised to the voltage at 2580V are shown in figure 7.



Table 3. Summary of tests carried out at several voltages at different beam energies





#### 2.2.4 Energy angle scans at 2580V

Figure 7 suggests an operational voltage of 2580 V in order to minimise the difference in the detector response due to the energy of the incident beam. Hence, energy-angle scans were carried out at additionally at 2580V at a few energies to complement the data at 2358V and characterise and energy dependent features in the relative response of the instrument. Table 4 lists the details.

		MCP	DAC	Filter	Polar		Elevation		Sweep			
Date	Energy	voltage	set		Angles	Anode	Step	Angles	Step	DAC set	Step	Range
26/06/2003	30 eV	2580	4.3	1.5	-168.75 to 168.75	0 to 15	22.5	-2.4 to 3.9	0.45	0.51 to 0.75	0.01	Low
	200 eV	"	"	"	"	"	"	"	"	3.6 to 4.8	0.05	Low
	1 keV	"	"	"	"	"	"	-1.5 to 2.7	0.3	0.105 to 0.225	0.005	High

Table 4. Summary of energy-angle scans carried out at 2580V on the MCPs

#### 2.2.5 Detector event rate response

Table 5 summarizes the tests performed to study the response of the detector to a varying incident event rate and provides a measure of the deadtime of the instrument.

		MCP	DAC	Filter		Polar		Elev	ation	Sw	eep	
Date	Energy	voltage	set		Range	Anode	Step	Range	Step	Range	Step	
17/06/2003	100 eV	2358	3.93	1.5	-11.25	#10	-	1.2	-	1.6	2.8	Low
	"	"		1	"	"	"	"	"	"	"	Low
	"	"		2		"	"	"	"			Low
	"	"		1.3		"	"	"	"			Low
	"	"		1.4		"	"	"	"			Low
	"		"	1.6	"		"			"	"	Low

#### 2.2.6 UV response

The response of the instrument to UV light incident on has been studied by shining a Krypton UV lamp. Details of the test set up is given in Chris Alsop et al and a summary of the tests carried out are given in table 6. Figure 8 shows the energy angle response of the 16 anodes to UV with the lamp facing anode 1. As can be seen, most of the counts are observed at very low energies and are primarily due to low energy secondary electrons emitted by the incident light which make it to the MCP.

		MCP	DAC	Filter	I	Polar		Elevation		Sweep		
Date	Energy	voltage	set		Angles	Anode	Step	Angles	Step	DAC set	Step	Range
11/08/2003	UV	2580	4.3	-	-168.75	1	-	-12.5 to 12.5	0.25	0.0 to 0.2	0.005	Low
	UV		"	-	"		-	"	"	"	"	Low
	UV	"	"	-	101.25	5	-	"		"	"	Low
	UV	"	"	-	"		-	"		"	"	Low
	UV	"	"	-	-168.75	1	-	"	"	"	"	Low
	UV	"	"	-	"	"	-	"		"	"	Low
	UV	"	"	-	101.25	5	-	"		"	"	Low
	UV	"	"	-	"		-	"	"	"	"	Low

Table 6. Summary of UV tests. The instrument is set up so the source is facing either anode 1 or anode 5. See explanation in text.

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Counts per 0.1 sec

Figure 8. Energy angle scans for UV light incident on the instrument .

## 3 Note on preliminary results and analysis

Preliminary analysis has been carried out and geometric factors extracted. However, due the complications arising from the mechanical imperfections, a number of discrepancies need to be resolved and further detailed analysis is currently in progress. In addition, the data will need to be corroborated with simulations to reproduce the performance and finally, compared with other instruments in-flight.





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# APPENDIX 4. IMA CALIBRATION REPROT

Venus Express ASPERA-4 IMA Calibration Report. V.1.0 May 30, 2005



Andrei Fedorov Centre d'Etude Spatialle Rayonnement, Toulouse, France

## Contents

- 1. Introduction: principal design, calibration objectives, and terms definition.
- 2. Brief description of calibration facilities
- 3. K, D-Elevation and Azimuthal properties of the sensor.
- 4. Mass position and geometrical factor for different masses.
- 5. Resultant tables.

# 1 Introduction: principal design, calibration objectives, and terms definition.

IMA is a rather complex mass analyzer. Figure 1 introduces the principal design of the sensor. It consists of the electrostatic scanner, spherical top-hat electrostatic analyzer, followed by the magnet mass analyzer. The ions can be accelerated in the gap between electrostatic analyzer and magnet section. Magnet mass analyzer consists of 16 azimuthal sections followed by 16 sectors (low panel of figure 1) of MCP position sensitive detector. Detector measures the radial position and the angular sector number for each incident particle. For the given particle energy, the radial position of the incident particle.

Sensor performance is controlled by scanner voltage  $U_{def}$ , electrostatic analyzer voltage  $U_{an}$ , and ion acceleration between analyzer and magnet section  $U_{PAC}$ . These voltages are produced by high voltage unit controlled by corresponding reference values. Finally the instrument properties are calculated as the functions of high voltage reference values, particle beam direction, particles energy and mass.

## **1.1** Terms definition

Instrument geometry is defined as:

- X, Y, Z frame has an origin in the center of spherical analyzer. Axis directions are shown in figure 1.
- $\Theta$  is the **elevation** angle of the incident ion (see top panel of figure 1) counted from the **XY** plane. Positive direction is shown in figure 1.
- $\Phi$  is the **azimuthal** angle of the incident ion (see bottom panel of figure 1) counted from the middle of the 8<sup>th</sup> sector of the detector in the **XY** plane. Particles coming with  $\Phi = 0$  strike the middle of the sector "0" of the detector. Angle  $\Phi$  is counting anticlockwise.
- S is an azimuthal sector number  $0 \div 15$ .
- $R_M$  is the radial position of the ion on the detector surface which defines the mass of the particle.  $R_M$  is coded by detector as a number  $0 \div 31$ . Low value corresponds to the low  $R_M$  (the central part of the detector surface).

Voltages inside instrument are defined as:

- EAC\_ref is the reference value to control scanner voltage. It is changed from -5000mV up to 5000mV.
- EAC\_U and EAC\_L are top and low scanner electrodes voltages controlled by EAC\_ ref. Range of both is  $\pm 2600V$ .
- $U_{def} = \text{EAC}_U \text{EAC}_L$  is the value which controls  $\Theta$  angle.
- **ESC\_H\_ref** is the reference value to control inner analyzer plate high voltage. Value range is  $0 \div +5000 mV$ .
- **ESC\_H** is the inner analyzer plate voltage. The range is  $0 \div 4000V$ .
- **ESC\_L** is the exterior analyzer plate voltage. The range is  $0 \div 11V$ .
- $U_{an} = \text{ESC}_H \text{ESC}_L$  is the analyzer voltage which defines the energy of the particles.



Figure 1: The principal diagram of the IMA mass analyzer. Terms and coordinate system introduction. Green curve in the bottom panel represents the particle trajectory inside the sensor. See text for details.

 $U_{PAC} = PAC$  is the post acceleration voltage between analyzer and magnet sections. Only 3 values are available: (-39V, -1902V, -3615V).

Physical terms used in the present reports are as follows:

 $E_q = \langle particle \ energy \rangle / \langle particle \ charge \rangle$  measured in V.

 $K = E_q/U_{an}$  "K" factor of the analyzer.

 $K_{ref} = E_q / ESC H_ref$ , this value is useful for calibration tables.

 $D = U_{def}/E_q$ , this value defines scanner properties (see section 3)

 $D_{ref} = EAC\_ref/E_q$ , this value is useful for calibration tables.

 $M_q = \langle particle \ mass \rangle / \langle particle \ charge \rangle$  measured in  $AUM / \langle electron \ charge \rangle$ .

- $G_L$  is the differential geometrical factor measured for given  $\Phi$ ,  $cm^2 rad eV/eV$ .
- $GF = \int G_L d\Phi$  is the total geometrical factor  $cm^2 sr eV/eV$ . Note that the last value is useless in the most of cases. The point is that the temperature of the measured ions is usually small, and angular distribution of the ion flow is narrow in comparison with the width of the azimuthal sector 22.5°. Thus the present report is dealing with  $G_L$  value.

During calibration the following constants and functions should be defined:

 $K_{ref}(\Phi)$  and then  $K(\Phi)$ .

 $\Delta E/E(\Phi)$  - energy resolution of the sensor.

 $\Theta(D, \Phi)$  and  $\Theta(D_{ref}, \Phi)$ .

 $\Delta\Theta(\Theta, \Phi)$  - angular resolution of the sensor.

 $R_M(E_q, M_q, U_{PAC})$  - position of the center of the mass peak

 $\Delta R_M$  - width of the mass peak

 $G_L(\Theta, \Phi, E_q, M_q)$  for each azimuthal sector.

## **1.2** Rough estimation of the theoretical geometrical factor

The standard field of view of the sensor is  $22.5^{\circ} \times 4^{\circ} = 0.027 sr$ . The aperture of the instrument is defined by slit in the acceleration lens between the spherical analyzer and the magnet. For one azimuthal sector it is  $1mm \times 10mm = 0.1cm^2$ .  $\Delta E/E = 0.04$ . In this case very rough estimation of the geometrical factor of one sector is

$$GF_{estim} = 1.0 \cdot 10^{-4} \ cm^2 \ sr \ eV/eV \tag{1}$$

## **2** Brief description of calibration facilities

## 2.1 Mechanical setup

The mechanical set up is shown in Figure 2. The sensor is located at about 2.5 m from the ion source. The turnable platform allows to change  $\Phi$  in  $\pm 170^{\circ}$  range, and  $\Theta$  in  $\pm 90^{\circ}$  range. Both angles are set with accuracy of 0.01°.

Ion gun allows to choose  $H^+$ ,  $H_2^+$ ,  $O^+$ ,  $O_2^+$  ions in the energy range 500eV - 30 keV. The energy and sort of ions are programmed. To monitor the ion flux one CEM is mounted on the periphery of the beam.

## 2.2 High voltage setup

High voltage control is shown in Figure 3. All reference voltages for IMA HV units and for Ion Gun HV supply are provided by 16 bits DAC with accuracy 0.2mV. The multichannel ADC provides measurements of HV monitor values with accuracy 0.1 mv.

Calibration of high voltage sources provided by IRF is as follows:

$$ESC_H[V] = -1.933 + ESC_H_ref[mV] \cdot 0.6587$$
<sup>(2)</sup>

$$U_{def}[V] = -6.16 + 1.920 \cdot EAC\_ref[mV]$$
(3)

## **3** K, D-Elevation and Azimuthal properties of the sensor

## **3.1** K properties of the electrostatic analyzer

Figure 4 shows measurements of  $H^+$  energy versus  $U_{an}$  reference value in case when ESC\_L is zero. Corresponding formulas are as follows:

$$E_q = 6.37 \cdot (ESC\_H\_ref - 2.93) \tag{4}$$



Figure 2: The mechanical set up of IMA in the vacuum chamber



Figure 3: The electrical diagram of IMA calibration

$$ESC_H_ref = 2.93 + 0.157 \cdot E_q$$
 (5)

$$K = 9.67$$
 (6)

$$K_{ref} = 6.37\tag{7}$$

 $ESC_H_ref$  is measured in mV.



Figure 4:  $E_q$  versus ESC\_H\_ref. Measurements has been made for  $H^+$  ions and for all available PAC values and for all  $\Phi$  values.

Dependence of the K and  $K_{ref}$  values on the  $\Phi$  angle for  $\Theta = 0$  is shown in figure 5. K variation is described as:

$$K_{ref} = 6.37 \cdot \sin(\Phi - 184.0) \cdot 0.11 \tag{8}$$

$$K = 9.67 \cdot \sin(\Phi - 184.0) \cdot 0.11 \tag{9}$$



Figure 5:  $K_{ref}$  versus azimuth angle  $\Phi$ . Measurements has been made for  $H^+$  ions 1100 eV energy. Black numbers correspond to the azimuthal sector S.

## **3.2** D-Elevation properties of the scanner

 $D_{ref}$ 

Measured function of  $\Phi(D_{ref})$  is shown in figure 6. Corresponding formulas are as follows:

$$\Theta[deg] = -3.44 - 182.6 \cdot D_{ref} \tag{10}$$

$$= -1.89 \cdot 10^{-2} - 5.47 \cdot 10^{-3} \cdot \Theta[deg] \tag{11}$$

$$\Theta[deq] = -3.44 - 95.1 \cdot D \tag{12}$$



Figure 6:  $\Theta$  versus  $D\_ref$ . Measurements has been made for  $O^+$  ions and for all available PAC values and for all  $\Phi$  values.

## 4 Mass position and geometrical factor for different masses

IMA calibration was made for 4 types of ions, namely:  $H^+$ ,  $H_2^+$ ,  $N^+$ , and  $O_2^+$ . For each ions type, the peak position and corresponding geometrical factor has been measured for all azimuthal sectors S, in  $E_q$  range [300 ÷ 10000 eV], for  $\Theta = 0$ , and for all possible  $U_{PAC}$  values. Peaks for different  $E_q$  and different  $U_{PAC}$  are shown in figure 7. Vertical axis of each plot is the differential geometrical factor  $G_L$ , corresponding to the fixed azimuthal angle  $\Phi$ . Shown measurements correspond to the centers of each azimuthal sector. Peaks are relatively wide due to the averaging over the all 16 sectors of the sensor.

The differential geometrical factors  $G_L$  in  $cm^2 rad eV/eV$  are given in Table 1. Figure 8 shows  $G_L$  of one sector versus azimuthal angle  $\Phi$ . Values presented in Table 1 correspond to the maximum of the profile.

Finally figure 9 shows interpolation of the mass peak position over entire energy range of the instrument.



Figure 7: Mass peaks of  $H^+$ ,  $H_2^+$ ,  $N^+$ , and  $O_2^+$  for different energies. In the each panel the same color peaks correspond to the different  $U_{PAC}$ . Left peak corresponds to the maximal acceleration.



Figure 8: Geometrical factor (in arbitrary units) of one azimuthal sector versus  $\Phi$ .

$E_q, V$	$U_{PAC}$ index	$G_L H^+$	$G_L H_2^+$	$G_L N^+$	$G_L O_2^+$
310.	0	0.0E+00	0.0E+00	3.0E-05	3.4E-05
310.	1	4.4E-06	6.4E-05	7.2E-05	7.5E-05
310.	2	4.2E-05	7.4E-05	7.4E-05	1.2E-04
603.	0	0.0E+00	0.0E+00	2.7E-05	1.9E-05
603.	1	1.9E-05	1.2E-04	6.8E-05	3.3E-05
603.	2	7.5E-05	2.0E-04	9.7E-05	6.0E-05
1253.	0	0.0E+00	1.8E-05	1.7E-05	8.8E-06
1253.	1	3.5E-05	6.1E-05	4.9E-05	1.8E-05
1253.	2	8.4E-05	9.0E-05	7.5E-05	1.8E-05
2517.	0	1.1E-05	2.4E-05	1.1E-05	9.7E-06
2517.	1	3.4E-05	4.6E-05	1.8E-05	1.3E-05
2517.	2	6.8E-05	8.4E-05	5.0E-05	1.9E-05
5057.	0	4.5E-05	1.8E-05	6.4E-06	1.6E-06
5057.	1	6.1E-05	2.5E-05	8.4E-06	0.0E+00
5057.	2	1.1E-04	3.1E-05	1.6E-05	4.6E-06

Table 1: Differential geometrical factor  $G_L$  versus  $E_q$  and  $U_{PAC}$ .



Figure 9: Interpolation of the position of the mass peaks of  $H^+$ ,  $H_2^+$ ,  $N^+$ , and  $O_2^+$  for entire energy range.







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# APPENDIX 9. IMA TM / TC DESCRIPTION

## The ICA-IMA-VIA TC/TM data formats

# and related software aspects.

Issue 1.8 2004-10-28 Hans Borg. IRF- Kiruna.
#### Document history.

Date	lssue	Ву	Changes
2002-04-07	Draft	HB	Composed and edited from several partial documents.
2002-04-20	1.2	HB	Added: Related documents.
			Important NOTE for HK-data change.
			Corrected standard header status bit.
2002-05-08	1.3	HB	Added: Mass order for table look up. Command status
			coding.
2003-05-16	1.4	HB	Corrected parameter orders (§5.2.1,§5.2.3)
			Timing and time tagging. (8.0)
2003-09-07	1.5	HB	Added header (§5.5.1) & HK (§6.1) parameters
			descriptions. Extra to timing (§8.2)
2003-11-15	1.6	HB	Corrected sampling time in §3.0
2004-05-08	1.7	HB	Added VIA specific definitions.
			Updated some ICA default settings.
2004-10-28	1.8	HB	Parameter order (§5.2.3 and §5.4).

#### Related documents.

- 1) ICA RPC : the Ion Composition Analyser in the Rosetta Plasma Consortium. O Norberg et. al. Note: "The ICA RPC: ... should basically be applicable on the IMA MU configuration"
- 2) ICA command description. Issue 1.5. H Borg.
- 3) IMA command description. Issue 1.4. H Borg.
- 4) CCSDS 120.0-B-1.
- 5) Basics of ICA/IMA embedded software. Issue: 1.3 H Borg
- 6) ICMA\_ADC\_CAL\_yymmdd.doc (Current: yymmdd=030910 by HB)

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#### 1.0 Scope.

As the ICA (RPC/Rosetta), the IMA (Aspera/Mars Express) and VIA (Aspera/Venus Express) experiments are essentially the same this document treats all three. Differences are explicitly noted. It only briefly describes the operation of the experiments.

It is assumed that the reader has a basic knowledge of the experiments.

The document tries to describe in some detail the tm data return from the experiments.

#### 2.0 Terminology.

If not otherwise stated a byte denotes an 8-bit item and a word a 16-bit item. A nibble is a 4-bit item. Bits are labeled in the power of 2, i.e. 0 (zero) is the least significant bit.

Precaution: ESA uses "octets" for an 8-bit item and "word" for a 16-bit item. ESA also uses 0 as the MS-bit (Mil Std. 1750 convention. Item size dependent).

F8 denotes an experiment 8-bit hybrid floating code used to reduce 32/16 bit parameters to 8 bits. Notations like ICA/IMA/VIA indicates that all instruments is treated differently, typicallydefault values, while ICA/IMA-VIA means ICA is different than IMA-VIA who are the same. Else notations like ICA only, IMA-VIA only are also used.

#### 3.0 Experiment basic operation.

The basic operation consists of stepping through 32 or 96 energy HV deflection steps for each of 16 entrance HV deflection steps (polar angles). A complete cycle (scan) takes 64 seconds (32 levels) or 192 seconds (96 levels) respectively. The sampling time is 120.9 milliseconds. Each sample produces an imager matrix of 32 mass bins times 16 sectors (azimuth angles).

The data acquisition and transmission is synchronized to an acquisition (start) pulse. For ICA that pulse is received once per 32 seconds and for IMA once per 16 seconds.

All data to and from the experiment is transmitted over a serial 1355-link from/to a central unit that in turn interfaces to the spacecraft systems.

Each format starts with a 16-byte long standard header with a 3-byte long synchronization pattern.

Except for the header and some data in the special modes all data is by default converted to an 8-bit hybrid floating code (F8) followed by a loss less bit data compression. Thus, most ICA-IMA data formats will float in the ESA telemetry packets. Some may, however, be synchronized (see §5.4).

For a more detailed description of the experiment see ICA – RPC : the Ion Composition Analyser in the Rosetta Plasma Consortium. (Norberg,O. et al.).

#### 4.0 The commanding system.

#### 4.1 General

With a few exceptions all experiment commands consists of a 16-bit word. The word is subdivided into 4 nibbles n3-n0.

n3 n2	n1	n0
-------	----	----

The commands are divided into 3(4) classes (types) as:

Туре 3	n3 ∴ 0 Capacity: 15 s	n2,n1,n0 represents a 12-bit variable parameter. sets. n3=1-15.
Type 2	n3=0 n2∴0 Capacity: 15	n1,n0 represents an 8-bit variable parameter. sets. n2=1-15.
Type 1/0	n3=n2=0 Capacity: 256	n1,n0 is dynamically used for variable length parameters like 4-bit, 1-bit or no parameter commands. 5 sets. n1,n0=0-255.

Note: The combined command words = 0xFFFF or 0x0000 are not used for safety.

The basic experiment internal interpretation of the 16-bit word is given below (§4.2).

For further details about commanding, see ICA/IMA Command Description. Issue 1.4. (H Borg).

#### 4.2 Detailed command list.

The list below gives all the commands in terms of a short description, type, fixed part, parameter mask, acceptable parameter range and when applicable the default value. Note that this is the internal interpretation.

Prm: below stands for parameter. A "-" below indicates not applicable or not defined.

Short description	Туре	Fixed part	Prm. mask	Prm. range	Default
Main +28 volt switch	1/0	0x0002	0x0001	0-1	0
Opto +28 volt switch	1/0	0x0004	0x0001	0-1	0
Mcp +28 volt switch	1/0	0x0006	0x0001	0-1	0
Post acc. HV switch	1/0	0x0008	0x0001	0-1	1
Grid LV switch	1/0	0x000A	0x0001	0-1	1
Entrance HV switch	1/0	0x000C	0x0001	0-1	1
Deflection LV switch	1/0	0x000E	0x0001	0-1	1
Deflection HV switch	1/0	0x0010	0x0001	0-1	1
Direct command switch	1/0	0x0012	0x0001	0-1	0
Watch dog enable/disable	1/0	0x0014	0x0001	0-1	1
Gas pressure HV control. ICAonly	1/0	0x0016	0x0001	0-1	0
Thruster firing HV control. ICA only	1/0	0x0018	0x0001	0-1	0
Compression enable/disable	1/0	0x001C	0x0001	0-1	1
Alternating post acc. enb/dis	1/0	0x001E	0x0001	0-1	0
Post acc. level high/low	1/0	0x0020	0x0001	0-1	1
Auto reduction change enb/dis	1/0	0x0022	0x0001	0-1	1
Shadow masking enb/dis	1/0	0x0024	0x0001	0-1	1
Bad HV masking enb/dis	1/0	0x0026	0x0001	0-1	1
Bad mass clearing enb/dis. VIA only	1/0	0x0028	0x0001	0-1	0
Next command direct	1/0	0x0040	-	-	-
Energy deflection stepping	1/0	0x0041	-	-	-
Entrance deflection stepping	1/0	0x0042	-	-	-
Release V-cal format	1/0	0x0043	-	-	-
Activate debugger. Bench only	1/0	0x0046	-	-	-
Gas-HV timeout test. ICA only	1/0	0x0047	-	-	-
Trigger machine error. Bench only	1/0	0x0048	-	-	-
Test Watch dog reset.	1/0	0x004A	-	-	-
Empty TM fifo	1/0	0x004B	-	-	-
Flush TM fifo	1/0	0x004C	-	-	-
Boot PROM	1/0	0x004D	-	-	-
Imager test	1/0	0x004E	-	-	-
Dummy command	1/0	0x004F	-	-	-
Set HV ref. Range bits. VIA only.	1/0	0x0050	0x0003	0-3	-
Set bad mass index bit MS. VIA only	1/0	0x0060	+ 2:nd wrd	0-0xFFFF	0
Set bad mass index bit LS. VIA only	1/0	0x0070	+ 2:nd wrd	0-0xFFFF	0
Boot EEPROM incl. Context	1/0	0x00B0	0x000F	0-15	-
Set imager test pattern	1/0	0x00C0	0x000F	0-15	-
Boot EEPROM excl. Context	1/0	0x00D0	0x000F	0-15	-
Set ICA/IMA-VIA SID number	1/0	0x00E0	0x000F	0-5/0-6	5
Set EEPROM default boot section	1/0	0x00F0	0x000F	0-15	0

Short description	Туре	Fixed part	Prm. mask	Prm. Range	Default
Set energy deflection level	2	0x0100	0x00FF	0-95	-
Set entrance deflection level	2	0x0200	0x00FF	0-15	-
Set ICA/IMA/VIA solar wind start index	2	0x0300	0x00FF	0-64	29/24/22
Set Gas pressure low level. ICA only	2	0x0400	0x00FF	0-255	0x16
Set Gas pressure high level. ICA only	2	0x0500	0x00FF	0-255	0x15
Set data reduction mode	2	0x0A00	0x00FF	0-39	0
Reprog. all EEPROM sections *)	2	0x0C00	0x00FF	0-16	-
Reprog. EEPROM section *)	2	0x0D00	0x00FF	0-255	-
Set ICA/IMA/VIA Opto reference	3	0x1000	0x0FFF	0-7	7/6/6
Set ICA/IMA/VIA Mcp reference	3	0x2000	0x0FFF	0-15	12/13/12
Set ICA/IMA Grid reference	3	0x3000	0x0FFF	0-7	7/7
Set ICA/IMA/VIA post acc. low reference	3	0x4000	0x0FFF	0-7	3/4/3
Set ICA/IMA/VIA post acc. hgh reference	3	0x5000	0x0FFF	0-7	6/7/6
Set energy defl. LV reference	3	0x6000	0x0FFF	0-4095	-
Set energy defl. HV reference	3	0x7000	0x0FFF	0-4095	-
Set entrance defl. HV reference	3	0x8000	0x0FFF	0-4095	-
Set noise reduction level	3	0x9000	0x0FFF	0-4095	0
Set ICA/IMA-VIA Fifo low (min) water mark	3	0xA000	0x0FFF	0-4095	40/20
Set ICA/IMA-VIA Fifo high (max) water	3	0xB000	0x0FFF	0-4095	80/40
mark					
Set ICA/IMA-VIA Fifo force water mark	3	0xC000	0x0FFF	0-4095	120/60
Set ICA/IMA-VIA Fifo clear water mark	3	0xD000	0x0FFF	0-4095	320/320
Set IMA Tm scaling factor. IMA-VIA only	3	0xE000	0x0FFF	0-4095	180
Start command (combined)	3	0xF000	0x0FFF	0-4095	-

\*) Requires a second word reading 0xFEED (security lock key).

#### 5.0 Telemetry/Science modes.

#### 5.1 Telemetry modes.

The experiments have to their disposal a number of telemetry modes (here named Sid, Science ID). The Sid defines the TM rate available. The Sid numbers below are the internal ICA-IMA numbers that is also used in commanding. Note that direct (near real time) TM is mostly not available. The TM data is buffered onboard the S/C. The TM rate below then describes the reasonable amount to create to stay within the buffer allowance allocated for the planned S/C session before tapping to a ground S/C tracking station.

Sid	Mnemonic	Exp. Pkt. size in bytes	ICA rate	IMA rate
0	Min (Minimum)	618	5.15 bps	10.3 bps
1	Nrm (Normal)	2478	103.25 bps	206.5 bps
2	Bst (Burst)	4092	1023 bps	2046 bps
3	Cal (Calibration)	1074	268.5 bps	537 bps
4	Spc (Special)	3198	799.5 bps	1599 bps
5	Tst (Test)	600	75 bps	150 bps
6	lma (lma)	3996 *	NA	3996 bps
ΗK	Housekeeping	24	6 bps	12 bps

#### Telemetry modes (Sid+HK).

\*) For IMA-VIA 2 such packets are sent every acquisition period.

#### 5.2 Data reduction modes general.

The H/W operation of the experiment is always the same but for the 32 or 96 energy level step modes. The number of energy levels is strictly tied to the science mode selected. The experiment produces too much data to be transmitted (~ 80 000 bps). The parametric space measured are 32 mass bins (not true M/q) for 16 azimuths, 16 polar angles and 96 (32) energy levels. To cope with the high production rate versus the available Tm rate capacity the data is first reduced by integrations in the measured parametric space. The resulting (32/16 bit parameters) are then converted to a hybrid 8 bit floating code (F8). The size of the data set (format) is after this mostly still too big. The data therefore passed via a loss less bit compression routine before feeding it to the tm output FIFO.

The tm FIFO can take a certain backlog of data due to its size. The backlog is watched by low and high watermarks. When appropriate, the S/W will change the reduction scheme such as to stay (on average) within the allocated tm rate. Thus the watermarks are scaled against the current telemetry mode. A more detailed description is given in § 5.2.1

#### 5.2.1 Science data processing.

The data is read from the imager memory, shadow masked and fed to a data reduction module. The reduction is performed by integrations in the parametric space azimuth\*mass\*energy\*polar-angles. When a full data set is acquired a 32/16 bit to a hybrid 8 bit floating code further reduces the data. The resulting data set is then compressed by a loss less method and fed to the telemetry FIFO for transmission. The TM-FIFO can take a certain backlog with respect to the current TM-rate (SID). The size of the compressed data will vary due to the characteristics of the actual data. For the *Normal* and *Burst* modes the TM-FIFO filling is controlled by analyzing the data set size with respect to the TM-FIFO filling and the actual TM-rate. When appropriate, a feedback is made to the reduction module to change the reduction scheme. The TM-FIFO filling is guided by watermarks. For the *Minimum* modes that create several data sets during the duration of a format, the reduction is fixed but instead the number of sets to transmit is adjusted to match, on the average, the TM-rate (SID). The automatic data reduction change and data compression can be disabled by commands. It affects both *Minimum* and *Normal/Burst* modes.

#### Principle data flow.



#### 5.2.2 Shadow and bad HV masking.

It is just the fact that the anticipated field of view of the experiments is not clean. Due to the mounting there are other S/C obstacles in the field of view. The current S/W has built in tables to simply clear out (set to 0) imager sectors that are more or less obscured. This has a two-folded motivation.

- a) A clear knowledge of what data is included (partly obscured may give "funny" effects).
- b) Zeroing out may (not for sure) give a better compression efficiency.

Like wise, due to HV limitations (capacity or accuracy) all polar angles cannot be reached for all energies. They are treated as for shadowed sectors above.

#### 5.2.3 Parameter orders.

Apart from the Special modes (5.4), Science data are always delivered as a matrix

azimuth\*mass\*energy\*polar, where azimuth (the first) is the fastest varying one.

For masses above or equal to 8, the integration is simply done by adding adjacent mass bins. E.g. 8 mass bins integrate them 4 by 4 from the 32 available.

Note that the Imager addressing is such that the heavier masses comes first and the lighter ones last.

For masses below 8 (i.e.<= 6), the mass bins are integrated according to lookup tables and supposed to represent true M/q. The transmission order of the M/q masses is defined by the lookup tables.

The mass order for ICA and IMA is: H+ >O+ O+ He+ He++ O++

and for VIA: H+ O+ He+ >O+ He++ O++

If less than 6 masses, masses at the end are skipped.

Azimuth, energy and polar angles always come in the same order.

#### 5.3 The data modes.

The data modes are divided into 5 groups: Min, Nrm, Har, Exm and Special.

#### 5.3.1 The minimum modes.

The duration of the Minimum mode data formats is 16 minutes.

Mode	Index	Masses	Azimuth angles	Energies	Polar angles	Max sets
Idle *	0					
Void	1					
Mspo	2	2	1	32	1	15
Void	3					
Msis	4	6	1	96	1	5
Mexm	5	32	1	96	1	5
Void	6					
Void	7					

\*) The Idle mode produces no scientific data and is described under the Special modes.

#### 5.3.1.1 Minimum spectra only (Mspo).

The energy deflection is stepped through 32 levels starting at the solar wind start index.

For each scan all data for the two masses protons and alpha (table look up) are integrated over the sunward facing sectors. This produces a maximum of 15 sets of 2 masses \* 32 E-levels spectra. As many as can be fitted (on the average to stay within the TM capacity) in the current SID block size are transmitted.

#### Layout: 1 header

n 2\*32 spectra (Compressed F8)

#### 5.3.1.2 Minimum selected ion species (Msis).

The energy deflection is stepped through all 96 levels for each of the 16 entrance steps.

For each scan all data for 6 selected ion species (table look up) are integrated over all angles (azimuth and polar). This produces a maximum of 5 sets of 6 masses \* 96 E-levels spectra. As many as can be fitted (on the average to stay within the TM capacity) in the current SID block size are transmitted.

Layout: 1 header

n 6\*96 spectra (Compressed F8)

#### 5.3.1.3 Minimum energy-mass matrix (Mexm).

The energy deflection is stepped through all 96 levels for each of the 16 entrance steps.

For each scan all data for 32 mass bins are integrated over all angles (azimuth and polar). This produces a maximum of 5 sets of 32 mass-bins \* 96 E-levels spectra. As many as can be fitted (on the average to stay within the TM capacity) in the current SID block size are transmitted.

Layout: 1 header

n 32\*96 spectra (Compressed F8)

#### 5.3.2 The normal modes (Nrm).

The duration of the Normal mode format is 192 seconds. The energy deflection is stepped through all 96 steps for each of the 16 entrance steps.

The normal mode (group) is subjected to an automatic change of the data reduction scheme (if enabled) in order to adapt to the current TM capacity (SID).

The order of the reduced data matrix is always Mass-Azimuth-Energy-Polar with Mass being the fastest varying index. The masses are integrated by means of energy dependent lookup tables.

#### The reduction scheme.

Mode	Index	Masses	Azimuth angles	Energies	Polar angles
Nrm-0	8	6	16	96	16
Nrm-1	9	6	16	96	8
Nrm-2	10	6	16	96	4
Nrm-3	11	6	16	96	2
Nrm-4	12	6	8	96	2
Nrm-5	13	6	4	96	2
Nrm-6	14	3	4	96	2
Nrm-7	15	3	4	96	1

Layout: 1 header

1 data set (Compressed F8)

#### 5.3.3 The burst high angular resolution modes (Har).

The duration of the burst high angular resolution mode format is 192 seconds. The energy deflection is stepped through all 96 steps for each of the 16 entrance steps.

The burst high angular resolution mode (group) is subjected to an automatic change of the data reduction scheme (if enabled) in order to adapt to the current TM capacity (SID). The order of the reduced data matrix is always Mass-Azimuth-Energy-Polar with Mass being the fastest varying index.

#### The reduction scheme.

Mode	Index	Masses	Azimuth angles	Energies	Polar angles
Har-0	16	16	16	96	16
Har-1	17	16	16	96	8
Har-2	18	16	16	96	4
Har-3	19	8	16	96	4
Har-4	20	4	16	96	4
Har-5	21	2	16	96	4
Har-6	22	2	8	96	4
Har-7	23	2	8	96	2

Layout: 1 header

1 data set (Compressed F8)

#### 5.3.4 The burst energy-mass matrix modes (Exm).

The duration of the burst energy-mass matrix mode format is 192 seconds. The energy deflection is stepped through all 96 steps for each of the 16 entrance steps.

The burst energy-mass matrix mode (group) is subjected to an automatic change of the data reduction scheme (if enabled) in order to adapt to the current TM capacity (SID).

The order of the reduced data matrix is always Mass-Azimuth-Energy-Polar with Mass being the fastest varying index.

#### The reduction scheme.

Mode	Index	Masses	Azimuth angles	Energies	Polar angles
Exm-0	24	32	16	96	16
Exm-1	25	32	16	96	8
Exm-2	26	32	16	96	4
Exm-3	27	32	16	96	2
Exm-4	28	32	8	96	2
Exm-5	29	32	4	96	2
Exm-6	30	32	2	96	2
Exm-7	31	32	2	96	1

Layout: 1 header

1 data set (Compressed F8)

#### 5.4 The special modes.

The special modes are mainly aimed for ground testing and calibration, but may well be used also when in orbit. Typically "Test" for commissioning.

As opposed to the science modes, the special modes do not allow any Tm FIFO backlogging. The Test and the Cal1 mode will be synchronized to the ESA packets provided they run in combination with the Telemetry modes Tst and Cal respectively. The Fake mode is always synchronized to the ESA packets.

# The order of the imager data transmitted are of type imager dump (snap shot), i.e. in the order as seen from the imager memory.

For Test and Cal1 modes that is mass\*azimuth and for Cal2 mass\*azimuth\*energy.

Mode	Index	Content
Test	32	H/W close information and an Imager snapshot
Cal1	33	HV information and one Imager in 16-bit uncompressed words
Cal2	34	HV information and 96 Imagers (one per Energy level) in compressed F8
Fake	35	An incremental (by one) 16-bit counter in 16-bit uncompressed words
Void	36	
Void	37	
Void	38	
Void	39	

**5.4.1 The test mode (Test).** The test mode delivers "hard ware close" information and do not contain any compressed data. It is 600 bytes long and will be synchronized to the ESA TM packets if SID=Tst (ICA-IMA nr 5) is used.

It contains th	e following data:		
Byte offset	Length in bytes	Bits	Content
0	16		Standard header. See §5.5
16	2		Command word 0 return
18	2		Command word 1 return
20	20		10 16-bit AD monitor values. See <u>&amp;5.4.6</u>
40	1		Void
41	1		Nos. 1355-link forced resets
42	1		Nos. 1355-link resets seen
43	1		Nos. 1355-link credit failures
44	2		EEPROM programming result
		15-10	Reprogramming counter
		9-8	Failure bits
		7-4	Destination EEP section
		3-0	Source EEP section
46	1		Nos. Watch dog resets
47	1		Nos. machine error resets
48	1		Void
49	3		48-bits S/W switch status. See §5.4.7
52	1		Noise reduction level
53	1		The gas pressure as seen from ROSINA. ICA only
54	2		Copy from HK format
		15	Direct command switch
		14-12	Pacc. low reference level
		11-0	Energy deflection HV reference
56	2		Copy from HK format
		15	Tm overflow flag
		14-12	Pacc. high reference level
		11-0	Energy deflection LV reference
58	2		Copy from HK format
		15	Pacc. current level (high=1 or low=0).
		14-12	Grid LV reference
	-	11-0	Entrance HV reference
60	2		CPU fault register
62	2		CPU fault address
64	1		Gas pressure low level. ICA only
65	1		Gas pressure high level. ICA only
66	2		CPU BIT result
68	2		Current program version running
70	1		Nos. sample overruns
71	1		Nos. sweep overruns
72	1		Nos. post overruns
73	1		Void
74	2		+28V monitor.
76	2		Fifo low water mark (Fmin)
78	2		Fito high water mark (Fmax)
80	2		Fifo force limit (Ffrc)
82	2		Fifo clear limit (Fclr)
84	2		IMA Tm scaling factor. IMA-VIA only
86	1		Image memory test result
		7-6	Test counter.
		5-3	Memory half 1 test result
		2-0	Memory half 0 test result
87	1		E-level for Image snapshot
88	512		Imager snapshot in F8 code

#### 5.4.2 The calibration-1 mode (Cal1).

The calibration-1 mode is specially designed for Imager calibration. It is 1074 bytes long and will be synchronized to the ESA TM packets if SID=Cal (ICA-IMA nr 3) is used.

Byte offset	Length in bytes	Bits	Content
0	16		Standard header. See §5.5
16	2		The digital deflection HV reference
18	2		The digital deflection LV reference
20	2		The digital entrance HV reference
22	1	7-4	The Opto. HV digital reference
		3-0	The Mcp. HV digital reference
23	1	7-4	The digital Post acc. HV reference
		3-0	The Grid LV digital reference
24	20		10 16-bit AD monitors. See §5.4.6
44	2		+28V monitor
46	1		Entrance angle index
47	1		Energy level index
48	2		Void
50	1024		Full Imager in 16-bit words

#### 5.4.3 The calibration-2 mode (Cal2).

The calibration-2 mode is specially designed for Imager calibration. It delivers Imagers for a full 96 E-level sweep. The data is in compressed F8 code.

Byte offset	Length in bytes	Bits	Content
0	16		Standard header. See §5.5
16	2		The digital deflection HV reference
18	2		The digital deflection LV reference
20	2		The digital entrance HV reference
22	1	7-4	The Opto. HV digital reference
		3-0	The Mcp. HV digital reference
23	1	7-4	The digital Post acc. HV reference
		3-0	The Grid LV digital reference
24	20		10 16-bit AD monitors. See §5.4.6
44	2		+28V monitor
46	1		Entrance angle index
47	1		Energy level index
48	2		Void
50	nn		96 energy levels of full Imager in compressed F8

#### 5.4.4 The faked data mode (Fake).

The Fake mode is specially designed to test the 1355-link for transmissions from the experiment to the PIU/MAIN-unit. It simply delivers a header followed by a word sequential counter as uncompressed data. It automatically adjusts the data size to match the current SID and will therefore always be synchronized to the ESA TM packets. Except for the header missing data can easily be detected.

#### Layout: 1 header.

An incremental counter to fill the current Sid packet.

#### 5.4.5 The Idle mode.

The mode index refers it to the Minimum group, but may as well be regarded as a special mode. This mode does not produce any science data.

The Idle mode may be entered in two ways.

#### 1) By command.

If entered by command the Opto and Mcp HV are regulated down to 0 reference, but the +28V Main switch stays ON. Also all science tm output are inhibited. Data in the tm FIFO are kept for later transmission. Commanding the experiment into the idle mode opens up for memory management activities (patch, dump or check).

#### 2) Automatic (ICA only).

The experiment will enter Idle mode if the gas pressure as delivered by ROSINA excides a predefined upper limit or the experiment receives a thruster fire warning. When entered this way the +28V main switch to the HV supplies is switched off. Data in the tm FIFO, however, will continue to be transmitted.

#### 5.4.6 The 16-bit AD monitors.

The AD monitors are stored in the following order.

Byte offset	Length in bytes	Content
0	2	Opto. HV
2	2	Mcp. HV
4	2	Upper entrance HV
6	2	Lower entrance HV
8	2	Post acceleration HV
10	2	Energy deflection HV
12	2	Energy deflection LV
14	2	Sensor unit temperature
16	2	Grid LV
18	2	DPU temperature

Actual calibration constants will be specified in the ICMA\_ADC\_CAL document.

#### 5.4.7 The switch status bits.

The switch bits are coded as 0=Off and 1=On.

Bit	Content	Туре
0	Mcp. +28V	H/W
1	Opto. +28V	H/W
2	Main +28V	H/W
3	Post acceleration HV	S/W
4	Grid LV	S/W
5	Entrance HV	S/W
6	Energy deflection LV	S/W
7	Energy deflection HV	S/W
8	Direct command	S/W
9	Watchdog	H/W
10	Gas HV control	S/W ICA only
11	Thruster firing HV control	S/W ICA only
12	Void	
13	Compression	S/W
14	Alternating post acceleration	S/W
15	Post acceleration level	S/W.
		Not really a switch
16	Auto reduction changes	S/W
17	Shadow masking	S/W
18	Bad HV masking	S/W
19	Void	
20	Void	
21	Void	
22	Test flag	S/W
23	Internal. Not commandable	

#### 5.5 The standard header.

Each data format starts with a standard header containing the following information

Byte offset	Length in bytes	Bits	Content					
0	3		Sync. Pattern. 0xE3 0x31 0xCA					
3	1	7-6	Unit (1=ICA 2=IMA 3=VIA)					
		5-0	Mode (index)					
4	1		Experiment data format counter (Edf)					
5	1	7	HV ramping in progress					
		6	Tm Fifo emptied					
		5	Checksum 0 failure					
		4	Checksum 1 failure					
		3-0	Number of sets in Minimum modes					
6	1	7	Compression switch					
		6	Auto reduction change switch					
		5	Alternating post acceleration switch					
		4	Post acceleration level					
		3-0	Test pattern					
7	1		Fifo filling. Number of 3-wrd packets in F8					
8	1	7	Post processing overrun					
		6	Sweep processing overrun					
		5	Sample processing overrun					
		4-0	PROM(0)/EEPROM section(1-16) loaded					
9	1	7	Reset due to Watchdog or Machine error.					
		6-0	Solar wind energy start index					
10	3		Format start time in units of 31.25 msec. *					
13	1	7	Bad HV masking switch					
		6	Shadow masking switch					
		5-4	The mass lookup table nr. VIA only					
13	3	19-0	Format length in words					

\*) As the Format start time only consists of 24 bits, the MSB part should be taken from the ESA packet time. The 24 bits covers about 6 days.

5.5.1 Header parameters description.

Sync. Pattern.

The 3 bytes 0xE3 0x31 0xCA marks the start of a new EDF (Experiment Data Format). A search for this is required as the EDF's floats in the tm data stream.

<u>Unit.</u>

This parameter (2 bits) defines the experiment unit as follows:

- 0 Undefined
- 1 ICA
- 2 IMA
- 3 VIA

#### Mode.

This is the data reduction mode index used for the data in this EDF. The corresponding mode acronyms are given in &5.3 and §5.4.

#### Experiment data format counter.

This is an 8-bit running counter incremented by 1 for each released EDF. It swaps over to 0 after 255.

#### HV ramping in progress.

This bit will set if HV ramping has been performed during the data taking for this EDF.

#### Tm Fifo emptied.

This bit will set if the tm fifo is emptied before the start of this EDF. Always forced to and from special EDF's

#### Checksum 0,1 failures.

These bits will set if the corresponding checksum (0 or 1) fails during RAM booting. Sets from both PROM and EEPROM booting.

Number of sets in Minimum modes.

This parameter (4 bits) gives the number of data sets in this EDF for the minimum modes.

Compression switch.

This bit indicates whether data compression is enabled or not. 0=Disabled 1=Enabled.

#### Auto reduction change switch.

This bit indicates whether automatic data reduction change is enabled or not. 0=Disabled 1=Enabled.

#### Alternating post acceleration switch.

This bit indicates the post acceleration mode. If set (1) it is alternating else it is fixed.

#### Post acceleration level.

This bit gives the post acceleration level used for this format. 0=Low 1=High.

#### Test pattern.

For testing purposes a number of imager test patterns can be commanded. This parameter (4 bits) gives the actual test pattern number used. Ensure it is 0 for real scientific data.

#### Fifo filling

This gives the approximate number of 1355 link packets in the tm fifo. To convert to words, unpack the F8 code and multiply by 3.

#### Post,Sweep,Sample processing overrun.

These bits are set if a process overruns, i.e. the current data processing is not finished when a new is requested.

#### PROM(0)/EEPROM(1-16) loaded.

This parameter (5 bits) gives the program code currently loaded and running in RAM. It is coded as: 0=PROM 1-16=EEPROM section 0-15.

<u>Reset due to Watchdog or Machine error.</u> This bit will set if the experiment has rebooted due to a watchdog or machine error reset.

Solar wind energy start index.

This parameter (7 bits) gives the energy start index when in the 32 level energy mode.

Format start time in units of 31.25 msec.

These 3 bytes is the starting time of this EDF. Note that more significant bits must be taken from the ESA packet time. Some attention should be paid close in time when this 3 bytes counter swaps around. That happens at about once per 6 days.

Bad HV masking switch.

This bit indicates if imager data is masked (set to zero) or not for angles/energies that can not be reached due to insufficient or too inaccurate HV. 0=Disabled 1=Enabled.

Shadow masking switch.

This bit indicates if imager data is masked (set to zero) or not for angles that are regarded as obscured by other S/C items. 0=Disabled 1=Enabled.

Mass lookup table nr.

This nr (0-2) indicates the actual mass lookup table used for this format.

Format length in words.

This parameter (20 bits) gives the total length of the format (EDF) in words.

#### 5.6 Telemetry/Data reduction mode combinations.

In principle any Data reduction mode can be combined with any Telemetry mode. All combinations will, however, not optimize the use of the telemetry capacity. There are no precautions or restrictions built into the S/W to refuse some combinations. In the worst case (like a burst mode in the Minimum Sid) no science data at all will be delivered due to Tm FIFO clearing, provided the Auto reduction change is enabled.

The table below gives the anticipated combinations. Other combinations may, however, be used as a result of experiences from in orbit operation. Likewise the Fifo controlling limits may be trimmed.

Telemetry mode	Data reduction modes				
Minimum (0)	Minimum modes				
Normal (1)	Normal modes				
Burst (2)	Burst modes (Har, Exm)				
Calibration (3)	Calibration 1. Tailored				
Special (4)	Calibration 2				
Test (5)	Test. Tailored				
Ima (6). IMA only	Burst modes (Har, Exm)				

The Fake and Idle modes are applicable in all Telemetry modes.

#### 6.0 The Housekeeping format.

The housekeeping format consists of 24 bytes delivered once per acquisition period. This rate is independent of the current Telemetry mode (Sid) in effect.

The ICA-IMA housekeeping format contains the following parameters:

Byte offset	Length in bytes	Bits	Content			
0	1	7-2	Current data reduction mode. For index see §5.3 & 5.4			
		1-0	Last command status where:			
			0=Ok 1=Parameter out of range			
			2=Invalid 3=Erroneous opcode			
1	1		HV switch status. The first 8 switches. See §5.4.7			
2	1	7	The new command received toggle bit			
		6-4	The current Sid number			
		3	Post acceleration mode (Fixed/Alternating).			
		2	+28V Main HV present *			
		1	+28V Opto HV present *			
		0	+28V Mcp HV present *			
3	1		Fifo filling in terms of internal packets (words/3) in F8			
4	2		The first word command return.			
6	1		The Opto. HV monitor			
7	1		The Mcp. HV monitor			
8	1		The Energy deflection HV monitor			
9	1		The Energy deflection LV monitor			
10	1		The Post acceleration HV monitor			
11	1		The Grid LV monitor			
12	1		The Sensor unit temperature			
13	1		The DPU Temperature			
14	2	15	The direct command switch			
		14-12	Post acceleration low level reference			
		11-0	Energy deflection HV reference			
16	2	15	Tm Fifo overflow			
		14-12	Post acceleration high level reference			
		11-0	Energy deflection LV reference			
18	2	15	Post acceleration level (high or low)			
		14-12	Grid LV reference. ICA-IMA only.			
		13	The Dfl. HV range bit. VIA only.			

		12	The Ent. HV range bit. VIA only.					
		11-0	Entrance HV reference					
20	2	15-13	Opto. HV default reference					
		12-9	Mcp. HV default reference					
		8-0	Entrance upper HV monitor					
22	2	15-13	Opto. HV current reference					
		12-9	Mcp. HV current reference					
		8-0	Entrance lower HV monitor					

\*) For an explanation of the present status, See ICA/IMA Command Description Issue 1.4.

The monitor calibration constants will be specified in the ICMA\_ADC\_CAL document.

Important NOTE. Byte 2, bit 3 was intended to be the HV safety plug status (HV enabled/disabled). This status had to be taken out for technical reasons. The bit is now used to indicate the post acceleration mode of operation (Fixed or Alternating).

#### 6.1 HK parameters description.

#### Current data reduction mode.

This gives the data reduction mode index (6 bits) currently running. The corresponding mode acronyms are given in &5.3 and 5.4.

Last command status.

This parameter (2 bits) gives the status of the last received command. The coding is0=Ok1=Parameter out of range2=Invalid in current context3=Erroneous opcode

HV switch status.

This gives the status of the HV switches (the first 8 from the switch register), where 0=Off and 1=On. The bit and switch relations are given in §5.4.7

#### New command received toggle bit.

This bit will toggle 0/1 each time a new command is received and the command status and the command return is fed to the HK transmit buffer.

#### The current Sid number.

This parameter (3 bits) gives the currently used Sid (tm mode). The acronyms and average bit rates are given in §5.1

#### Post acceleration mode.

By default, the post acceleration runs on a fixed HV setting. In can, however, be commanded to alternate between the preset high and low level HV. This bit is encoded as 0=Fixed, 1=Alternating.

#### +28V Main,Opto,Mcp HV present.

These 3 bits indicates the actual presence of the +28V after respective switch. 0=No and 1=Yes. See §6.0 for the bit switch-relations.

#### Fifo filling in terms of internal packets.

This gives the approximate number of 1355 link packets in the tm fifo. To convert to words, unpack the F8 code and multiply by 3. For F8 code, see § 7.0.

The first word command return.

This holds the first word (16 bits) of the last command received.

#### The HV,LV and temperature monitors at offsets 6-13.

These are 8-bit unsigned ADC readings for HV,LV and temperature monitors. Calibration factors will determine the sign. See §6.0 for the relation between offset and corresponding monitor.

#### The direct command switch.

ICA/IMA commands are of two types, direct or synchronized. The synchronized ones are executed at the end of format only. Setting the direct command switch ON (1) will turn synchronized commands to be direct.

<u>Post acceleration low level reference.</u> This is the default digital low level post acceleration reference (3 bits).

Energy deflection HV reference.

This is the digital HV reference value associated with the monitor reading in this format (12 bits).

Tm Fifo overflow.

This bit is set to one if a tm fifo overflow has occurred. That is 0=No overflow 1=Overflow.

Post acceleration level.

This bit indicates the current post acceleration level. 0=Low 1=High.

Energy deflection LV reference.

This is the digital LV reference value associated with the monitor reading in this format (12 bits).

<u>Grid LV reference (ICA-IMA only).</u> This is the digital grid LV reference value associated with the monitor reading in this format (3 bits).

<u>The Dfl. And Ent. Range bits (VIA only).</u> This gives the HV range bit settings at the time of the monitor sampling.

Entrance HV reference.

This is the digital HV reference value associated with the monitor reading in this format (12 bits).

Opto. HV default reference.

This is the default digital Opto. HV reference value. That is the target value for ramping (3 bits).

Mcp. HV default reference.

This is the default digital Mcp. HV reference value. That is the target value for ramping (3 bits).

Entrance upper HV monitor.

This is a 9-bit unsigned ADC reading for the upper entrance HV monitor. Calibration factors will determine the sign.

Opto. HV current reference.

This is the current digital Opto. HV reference value associated with the monitor reading in this format (3 bits).

Mcp. HV current reference.

This is the current digital Mcp. HV reference value associated with the monitor reading in this format (3 bits).

Entrance lower HV monitor.

This is an 9-bit unsigned ADC reading for the lower entrance HV monitor. Calibration factors will determine the sign.

#### 7.0 Special data characteristics.

The experiment uses some special tools to handle data. They are briefly described below.

#### 7.1 The F8 code.

In order to reduce the number of bits to transmit, the S/W normally converts 32/16 bit items into a hybrid 8-bit floating code. The maximum capacity is numbers up to 507903. If greater (32-bits only) the number is set to the maximum. It is regarded as a hybrid due to the fact that numbers less or equal to 32 are transmitted as integers. The layout is:



where Exp is the Exponent and Man the Mantissa. Numbers less or equal to 32 are used as is, that is they will be coded as 0x00 - 0x20. If greater the real mantissa part will be used with the MSB stripped of (always a one, not transmitted) and the next four MSB bits set into "Man". The Exp part will be the real exponent adjusted for the new bias (32) and set into Exp.

This is a simple C routine to unpack the F8 coded data:

```
int unpack_f 8(int acc)
{
    int exp;
    exp=(acc >> 4) & 0x0F;
    if(exp > 1)
        { acc=(acc & 0x0F) | 0x10;
        acc=acc << (exp-1);
      }
    return acc;
}</pre>
```

#### 7.2 Data compression.

The ICA-IMA compression consists of two functional parts: a preprocessor and an adaptive entropy coder.

The preprocessor first converts a 16 or 32 bit word to a hybrid floating 8-bit byte (F8-code). It then uses the delayed predictor technique (to calculate  $\delta$ 's) for the mapping process.

The bit compression uses Rice's adaptive coding (CCSDS 121.0-B-1). From above (F8-code) the implemented compression software works with 8 bit length data only (Types=0-7).

#### 7.2.1 Compressed data layout.

The compressed data layout consists of records subdivided into blocks. With exception for type 0, sub 1 each record holds compressed data for 128 bytes. The layout is a variant of the CCSDS 121.0-B-1 recommendation.

The differences are:

- 1) A Record always starts with a record length in bytes and if required a bit padding field at the end to ensure whole bytes. This way the next record may me located (except for some special situations) if the decompression fails in a record.
- 2) The order of Fundamental sequences (Fs) and Split bits (Sb) are Fs+Sb,Fs+Sb.... instead of Fs,Fs....,Sb,Sb... Again if a decompression fails in a block, the already decompressed bytes may be correct. This also allows for short blocks, short records at the end of a fully compressed data area.
- 3) The number of zero run blocks is given as a fixed binary 3 bit field instead of a Fs code.
- 4) The type 0 second extension (sub=1) do not use the CCDS one. Instead a special zero run record is introduced for the ICA-IMA experiments. The reason is that both experiment have large areas in shadow. When in shadow all data are zeroed out giving rise to long sequences of records with zero run blocks. Instead of counting zero run blocks, zero run records are counted. Example record: 0x03,0x00,0x17 would decompress to 128\*8=1024 bytes of 0x00.

For details see CCSDS-121.0-B-1.

#### Record.

Length Reference Block 0 Block 1 ...... Block N Pad

Block (Type 0.0). Type = 0 Sub=0 Block count-1

Block (Type 0.1).								
Type = $0$	Sub=1	Record count-1						

Block (Type 1-6).								
Type=1-6	Fs0+Sb0	Fs1+Sb1		FsN+SbN				

Block (Type 7). Type = 7 Byte 0 Byte 1 ...... Byte N

Fields

Name	Bits	Short description
Length	8	The total length in bytes of the record
Reference	8	The uncompressed reference value for the record
Block	Variable	A block of bits holding compressed data for 16 bytes *)
Pad	Variable	Bit padding to ensure whole bytes for a record
Туре	3	The compression type (0-7)
Sub	1	The type 0 subtype extension (0-1)
Block count-1	3	Number of zero run blocks –1
Record count-1	4	Number of zero run records – 1
FsN+SbN	Variable	The Fundamental sequence + the Split bits for byte N
Byte	8	Un uncompressed byte

\*) Block 0 only holds data for 15 bytes. The Reference gives the 16:th byte.

#### 8.0 Timing and time tagging.

#### 8.1 General.

Disregarding any clocks like DPU master, the experiment operation (measurement) is governed by the imager sampling time (120.9 msec). The imager supplies a mass \* azimuth matrix for a given energy and elevation (polar angle) per sample. The energy and elevation is controlled by changing electrostatic HV deflection systems. The energy cycle always starts at the maximum energy and is then stepped down to the minimum level. The cycle is then repeated by forcing the HV to its maximum. The change from low to high is allocated one sample period to ensure proper HV relaxing. The maximum number of energy levels are 96. There are, however, modes that use 32 consecutive levels only out of the 96. They also require a sample period for HV relaxation. Thus for a proper coherent operation, the 32 level mode requires 33 sampling periods leading to 99 sampling periods for the 96 level energy modes. The "dead" HV transition period is always placed in front of each energy scan (1 sample for 32 energy levels and 3 for 96 energy levels). The figure below shows the principles.



Symbolic sketch of the ICA/IMA energy stepping for 96 and 32 E-levels. They are organized to always be in synchronism.

#### 8.2 Time tagging.

The term time tagging here refers to the Iscience format (EDF=Experiment Data Format) time transmitted in the header of each EDF. This time always refer to the start of the first sample in the data collection scheme for the current format. That is, any HV relaxing period is NOT included, but may have to be taking into account for subsequent cycles (energy and/or elevations). The EDF time is composed of the time delivered by S/C and an internal timer. What ever, the accuracy of the S/C timer the is scaled down to 31.5 msec accuracy. Also note that the EDF time is 3 bytes wide only. More significant bits must be taken from tm packet times. All times are with respect to S/C time. Any correlation/correction to UTC should be done after the 3 byte time has been complemented with more significant bits from the ESA packet time. Bee observant that when the 3 byte ICA/IMA timer swaps around, the packet MSB may already have been updated by one prior to be applicable for the time. This is due to the tm fifo saving of tm data. This will not happen very often and can always be corrected for. The reason for only 3 bytes time tagging is to reduce the overhead by the header in the low rate tm modes. The timer will swap around about once per 6 days.

#### 9.0 Data reduction considerations.

The experipents utilizes an automatic way of adjusting the data reduction in order not to produce too much data for tm down load. This is accomplished by integrating "adjacent" samples together. There is no attempt onboard to divide down the counts by number of samples integrated Mostly not advisable for "Poission" counting statistics. The number of samples can, however, be obtained on ground by the knowledge of the onboard steering tables. This is not a subject of this manual.







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# APPENDIX 10. IMA: CONVERSION TO PHYSICS UNITS

# Venus Express ASPERA-4 IMA BIBLE V.1.0 January 26, 2006



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# **1 IMPORTANT NOTE**

This text is supplied with a number of files that are the generic parts of "The Bible".

# 2 Internal IMA data array and associated physical terms.

Internal representation of IMA data is an array  $(32 \times 16 \times 96 \times 16)$  or

(*AzIndex*, *RmIndex*, *EnIndex*, *ElIndex*). Each value of this array is a count of the corresponding cell. The first index of array varies faster. Here:

 $RmIndex = 0 \div 31$  - radial position of the cell along one sector of the detector. It codes M/Q of the particle. (M is the mass of the ion and Q is the ion charge).

 $AzIndex = 0 \div 15$  - number of azimuthal sector that this cell belongs. It codes the azimuthal angle  $\Phi$  of the incident particle.

 $EnIndex = 0 \div 95$  - corresponding number of the energy step. It codes E/Q of the incident ion. Here E is the particle energy.

 $ElIndex = 0 \div 95$  - this index codes elevation angle  $\Theta$  of the incident particle.



Figure 1: IMA data accumulation diagram. Red arrows in the top panel show the order of filling of the **IMA\_Image**.

Data accumulation process is shown in Figure 1. IMA\_Image consisting of an array (AzIndex, RmIndex)

is accumulated for each energy step and each polar angle. It is real exposition of 16 \* 32 = 512 independent counters (cells) working in parallel. Exposition time is 120.9ms. 96 consequence **IMA\_Image**(EnIndex) creates one **IMA\_Energy\_Spectrum**. One image follows the previous image with period = 125.0ms. Thus one **IMA\_Energy\_Spectrum**is accumulated in 12.0s. Sequence of 16 of **IMA\_Energy\_Spectrum**(ElIndex) taken with different polar angles creates a **IMA\_Full\_Spectrum**. **IMA\_Full\_Spectrum** is generated each 192.0s.

### **3** Telemetry modes

This section describes conversion a **IMA\_Full\_Spectrum** to an array transmitted to the telemetry. Section introduces *TRmIndex*, *TAzIndex*, *TEnIndex*, and *TElIndex* values.

Not implemented yet. TBD

## 4 Energy table.

Energy table establish relation between E/Q of the ion and EnIndex value. This table is in "EnTable.txt" file. The format of this file is described in the file header. The resume of IMA energy steps is given in Table 1.

EnI	E/Q														
0	29999.9	1	27629.1	2	25444.8	3	23431.6	4	21581.6	5	19871.5	6	18301.3	7	16855.5
8	15526.2	9	14298.1	10	13163.2	11	12121.6	12	11165.5	13	10287.1	14	9470.9	15	8724.7
16	8032.9	17	7395.5	18	6812.5	19	6276.1	20	5778.7	21	5320.0	22	4900.3	23	4511.6
24	4155.7	25	3828.1	26	3524.6	27	3246.5	28	2989.7	29	2753.1	30	2535.1	31	2334.6
32	2150.0	33	1980.2	34	1823.8	35	1679.4	36	1547.0	37	1424.0	38	1311.7	39	1208.7
40	1112.5	41	1024.2	42	944.0	43	869.1	44	800.9	45	736.7	46	679.2	47	625.8
48	576.3	49	530.8	50	488.0	51	449.3	52	414.5	53	381.1	54	351.7	55	323.6
56	298.2	57	274.1	58	252.7	59	232.7	60	213.9	61	197.9	62	181.9	63	167.1
64	153.8	65	141.7	66	131.0	67	120.3	68	111.0	69	101.6	70	93.6	71	86.6
72	79.8	73	73.5	74	67.6	75	62.3	76	57.4	77	52.8	78	48.7	79	44.8
80	41.3	81	38.0	82	35.0	83	32.2	84	29.7	85	27.4	86	25.2	87	23.2
88	21.4	89	19.7	90	18.1	91	16.7	92	15.4	93	14.1	94	13.0	95	12.0

Table 1: VEX IMA Energy table, V.1.0, Apr 20 2004

### 5 Elevation table.

Elevation table gives correspondence between  $\Theta$  and EnIndex and ElIndex. Appropriate file is "ElTable.txt". The format of the file is described in its header. The summary of IMA elevation table is shown in Table 2. Value less than -50.0 means that given **IMA\_Energy\_Spectrum**absents in the telemetry data flow (BUT not in the **IMA\_Full\_Spectrum** !).

Table 2: VEX IMA Elevation table, V.2.0, 11 Oct 2005

ElIndex	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
EnIndex																
0	-100.0	-100.0	-100.0	-100.0	-100.0	-14.0	-8.4	-2.8	2.8	8.4	14.0	-100.0	-100.0	-100.0	-100.0	-100.0
1	-100.0	-100.0	-100.0	-100.0	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	-100.0	-100.0	-100.0	-100.0
2	-100.0	-100.0	-100.0	-100.0	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	-100.0	-100.0	-100.0	-100.0
3	-100.0	-100.0	-100.0	-100.0	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	-100.0	-100.0	-100.0	-100.0
4	-100.0	-100.0	-100.0	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	-100.0	-100.0	-100.0
5	-100.0	-100.0	-100.0	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	-100.0	-100.0	-100.0
6	-100.0	-100.0	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	-100.0	-100.0
7	-100.0	-100.0	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	-100.0	-100.0
8	-100.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	-100.0
9	-100.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	-100.0
10	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
11	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
12	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
13	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0

Table 2: continued

14	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
15	12.0	26.4	20.9	25.2	10.6	14.0	0.4	20	20	0.4	14.0	10.0	25.2	20.9	26.4	12.0
15	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
16	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-84	-2.8	28	84	14.0	19.6	25.2	30.8	36.4	42.0
10	12.0	30.1	20.0	25.2	19.0	11.0	0.1	2.0	2.0	0.1	11.0	19.0	23.2	20.0	20.1	12.0
17	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
18	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-28	28	8 /	14.0	19.6	25.2	30.8	36.4	42.0
10	42.0	50.4	50.0	23.2	17.0	14.0	0.4	2.0	2.0	0.4	14.0	17.0	23.2	50.0	50.4	42.0
19	-41.9	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
20	42.0	36.4	30.8	25.2	10.6	14.0	8 /	28	28	8 /	14.0	10.6	25.2	30.8	36.4	42.0
20	-42.0	-30.4	-30.8	-23.2	-19.0	-14.0	-0.4	-2.0	2.0	0.4	14.0	19.0	23.2	50.8	50.4	42.0
21	-42.0	-36.3	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
22	42.0	26.2	20.8	25.2	10.6	14.0	9 /	20	20	0 1	14.0	10.6	25.2	20.8	26.4	42.0
22	-42.0	-30.5	-30.8	-23.2	-19.0	-14.0	-0.4	-2.0	2.0	0.4	14.0	19.0	23.2	50.8	50.4	42.0
23	-41.9	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
24	41.0	262	20.7	25.2	10.6	14.0	0.4	20	20	0.4	14.0	10.6	25.2	20.9	264	12.0
24	-41.9	-30.3	-30.7	-25.2	-19.0	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.0	25.2	30.8	30.4	42.0
25	-42.0	-36.4	-30.8	-25.1	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
20	41.0	262	20.7	25.2	10.6	14.0	0.4	20	20	0.4	14.0	10.6	25.2	20.9	264	12.0
20	-41.9	-30.3	-30.7	-25.2	-19.0	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.0	25.2	30.8	30.4	42.0
27	-42.0	-36.4	-30.8	-25.1	-19.5	-13.9	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
20	12.0	26.1	20.0	25.1	10.6	14.0	0.1	2.0	2.0	0.1	14.0	10.5	25.2	20.7	26.1	11.0
28	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.5	25.2	30.7	36.4	41.9
29	-42.0	-363	-30.8	-25.2	-19.6	-14.0	-83	-2.8	28	84	13.9	19.6	25.2	30.8	36.4	419
20	12.0	26.2	20.0	25.2	10.6	11.0	0.5	2.0	2.0	0.1	11.0	19.0	25.2	20.0	26.1	10.0
30	-42.0	-36.3	-30.8	-25.1	-19.6	-14.0	-8.4	-2.8	2.8	8.3	14.0	19.5	25.2	30.8	36.4	42.0
31	-42.0	-36.4	-30.7	-25.1	-19.5	-13.9	-83	-27	28	84	14.0	19.6	25.2	30.8	36.4	419
51	42.0	50.4	50.7	23.1	17.5	15.7	0.5	2.7	2.0	0.4	14.0	17.0	23.2	50.0	50.4	41.9
32	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
33	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-84	-2.8	28	84	14.0	19.6	25.2	30.8	36.4	42.0
55	42.0	50.4	50.0	23.2	17.0	14.0	0.4	2.0	2.0	0.4	14.0	17.0	23.2	50.0	50.4	42.0
34	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
35	42.0	36.4	30.8	25.2	10.6	14.0	8 /	28	28	8 /	14.0	10.6	25.2	30.8	36.4	42.0
55	-42.0	-50.4	-50.8	-23.2	-19.0	-14.0	-0.4	-2.0	2.0	0.4	14.0	19.0	23.2	50.8	50.4	42.0
36	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
27	42.0	26.4	20.9	25.2	10.6	14.0	0 /	20	20	0 /	14.0	10.6	25.2	20.9	26 1	42.0
57	-42.0	-30.4	-30.8	-23.2	-19.0	-14.0	-0.4	-2.ð	∠.ð	0.4	14.0	19.0	23.2	50.8	30.4	42.0
38	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
20	12.0	26.4	20.0	25.2	10.6	14.0	0.4	2.0	2.0	0.4	14.0	10.6	25.2	20.0	26.1	12.0
39	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
40	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-84	-2.8	28	84	14.0	19.6	25.2	30.8	36.4	42.0
10	12.0	50.1	50.0	23.2	17.0	11.0	0.1	2.0	2.0	0.1	11.0	17.0	20.2	50.0	50.1	12.0
41	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
42	-419	-36.4	-30.8	-25.2	-19.6	-14.0	-84	-2.8	28	84	14.0	19.6	25.2	30.8	36.4	42.0
72	+1.7	50.4	50.0	23.2	17.0	14.0	0.4	2.0	2.0	0.4	14.0	17.0	23.2	50.0	50.4	42.0
43	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
44	42.0	36.4	30.8	25.2	10.6	14.0	8 /	28	28	8 /	14.0	10.6	25.2	30.8	36.4	41.0
44	-42.0	-30.4	-30.8	-23.2	-19.0	-14.0	-0.4	-2.0	2.0	0.4	14.0	19.0	23.2	50.8	50.4	41.9
45	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
16	12.0	26 1	20.9	25.2	10.5	14.0	0 /	20	20	0 /	14.0	10.6	25.2	20.7	26 1	42.0
40	-42.0	-30.4	-30.8	-25.2	-19.5	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.0	25.2	30.7	30.4	42.0
47	-42.0	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
40	41.0	26.4	20.0	25.2	10.6	14.0	0.4	2.0	2.0	0.4	14.0	10.6	25.2	20.0	26.4	10.0
48	-41.9	-36.4	-30.8	-25.2	-19.6	-14.0	-8.4	-2.9	2.8	8.4	14.0	19.6	25.2	30.8	36.4	42.0
49	-42.0	-36.3	-30.8	-25.1	-19.6	-13.9	-8.4	-2.7	2.8	8.3	14.0	19.6	25.2	30.8	36.4	42.0
50	10.0	26.4	20.0	25.1	10.6	14.0	0.4		2.0	0.4	10.0	10.6	25.2	20.0	26.2	10.0
50	-42.0	-36.4	-30.8	-25.1	-19.6	-14.0	-8.4	-2.9	2.8	8.4	13.9	19.6	25.2	30.8	36.3	42.0
51	-42.0	-363	-30.8	-25.2	-19.6	-139	-84	-2.8	27	84	14.0	19.6	25.1	30.8	36.4	42.0
51	12.0	50.5	50.0	23.2	17.0	15.5	0.1	2.0	2.7	0.1	11.0	17.0	20.1	50.0	50.1	12.0
52	-42.0	-36.4	-30.8	-25.2	-19.7	-13.9	-8.3	-2.8	2.8	8.4	14.0	19.6	25.2	30.8	36.4	41.9
53	42.0	36.4	30.0	25.1	10.5	14.0	8 /	28	27	83	14.1	10.6	25.2	30.8	36.4	41.0
55	-42.0	-50.4	-30.9	-23.1	-19.5	-14.0	-0.4	-2.0	2.1	0.5	14.1	19.0	23.2	50.8	50.4	41.9
54	-42.0	-36.4	-30.8	-25.1	-19.6	-13.9	-8.4	-2.7	2.8	8.3	14.0	19.5	25.2	30.8	36.5	42.0
55	42.0	26.4	20.8	25.2	10.6	14.0	9 /	20	20	05	14.1	10.7	25.2	20.7	26.2	41.0
55	-42.0	-30.4	-30.8	-23.2	-19.0	-14.0	-0.4	-2.0	2.0	0.5	14.1	19.7	25.5	50.7	50.5	41.9
56	-42.0	-36.4	-30.7	-25.2	-19.6	-13.9	-8.4	-2.8	2.9	8.3	14.0	19.7	25.1	30.8	36.5	41.9
57	42.0	26.2	20.0	25.1	10.7	14.0	05	20	2.0	0.4	141	10.5	25.2	20.7	264	41.0
57	-42.0	-30.3	-30.8	-25.1	-19.7	-14.0	-8.5	-2.8	2.9	8.4	14.1	19.5	25.2	30.7	30.4	41.9
58	-41.9	-36.4	-30.7	-25.3	-19.6	-13.9	-8.5	-3.0	2.9	8.4	14.0	19.5	25.2	30.9	36.3	42.0
50	10.0	26.0	20.7	25.1	10.7	14.0	0.4	0.0		0.0	10.0	10.6	25.2	20.0	26.5	41.0
59	-42.0	-36.3	-30.7	-25.1	-19.7	-14.0	-8.4	-2.8	2.9	8.3	13.9	19.6	25.2	30.8	36.5	41.9
60	-42.1	-36.2	-30.7	-25.2	-19.6	-14 1	-8.5	-27	28	84	13.9	19.5	25.3	30.9	36.4	42.0
00	42.1	50.2	50.7	23.2	17.0	14.1	0.5	2.7	2.0	0.4	15.7	17.5	23.5	50.7	50.4	42.0
61	-41.9	-36.5	-30.8	-25.1	-19.7	-14.0	-8.3	-2.9	2.8	8.5	13.9	19.6	25.3	30.7	36.4	42.1
62	-42 1	-36 5	-30.7	-25.2	-197	-13.8	-83	-28	27	85	14.0	19.5	25.0	30.0	36.4	41.9
62	72.1	50.5	50.7	23.2	17.1	10.0	0.5	2.0	2.1	0.5	1 4 -	10.5	23.0	50.7	30. <del>-</del>	11.7
63	-41.9	-36.3	-30.7	-25.1	-19.5	-13.9	-8.3	-2.7	2.9	8.5	14.1	19.7	25.3	30.9	36.5	42.1
64	-41 9	-36.2	-30.9	-25.2	-19.6	-13.9	-82	-29	27	84	14 1	19.8	25.0	30.7	36.4	42.1
	71.7	30.2		23.2	17.0	1.5.5	0.2	2.7	2.1	0.7	1 4 2	10.5	23.0	20.7	30. <del>-</del>	12.1
65	-41.9	-36.2	-30.9	-25.2	-19.5	-14.2	-8.5	-2.8	3.0	8.3	14.0	19.7	25.0	30.7	36.5	42.2
66	-42 2	-36 5	-30.7	-25.0	-197	-14.0	-83	-3.0	27	85	14 2	19.5	25.2	31.0	36.2	42.0
	72.2	50.5	50.7	25.0	17.1	14.0	0.5	2.0	2.1	0.5	10.0	10.5	23.2	51.0	30.2	12.0
67	-42.2	-36.5	-30.8	-25.1	-19.3	-14.2	-8.4	-2.7	3.0	8.2	13.9	19.6	25.3	31.0	36.2	41.9
68	-41.0	-36.7	_30.6	_25.0	_10.3	-14.2	_8.6	_3.0	27	83	14.0	10.6	25.2	30.0	36 5	42.2
00	-+1.7	-30.2	-50.0	-25.0	-17.3	-14.2	-0.0	-5.0	2.1	0.5	14.0	19.0	23.2	50.9	50.5	74.4
69	-41.8	-36.3	-30.8	-25.3	-19.8	-14.2	-8.1	-2.6	2.9	8.4	13.9	19.4	25.0	31.1	36.6	42.1
70	.421	_26.1	_30 %	_25 4	_10.5	_1/ 1	_Q )	_ <u></u> 2 °	25	85	120	10 9	25.1	31 1	36 /	117
70	-42.1	-30.1	-30.8	-23.4	-19.3	-14.1	-0.2	-2.0	2.3	0.0	13.0	17.0	23.1	51.1	50.4	+1./
71	-42.1	-36.3	-30.5	-25.5	-19.7	-13.9	-8.9	-3.1	2.7	8.5	14.3	19.3	25.1	30.9	36.6	41.7
70	41 7	26.2	20.9	25.2	10.9	14.2	0 0	26	20	0 /	12.0	10.4	24.0	21.0	261	10.1
12	-41./	-30.5	-30.8	-23.3	-19.8	-14.3	-8.0	-2.0	2.9	ð.4	13.9	19.4	24.9	31.2	30.0	42.1
73	-41.9	-36.0	-30.9	-24.9	-19.8	-13.8	-8.7	-2.8	3.2	8.3	14.3	19.4	25.3	30.4	36.4	42.3
74	41.0	26.0	20.7	25.2	10.7	1 4 1	0 4	2.0	2.5	0.1	12.0	10.0	25.0	21.0	267	40.2
/4	-41.8	-30.3	-30.7	-25.2	-19.7	-14.1	-8.6	-3.0	2.5	ð. l	13.6	19.2	25.6	31.2	30.7	42.5
75	-42.4	-364	-30.4	-25.4	-193	-14.3	-8.3	-3.3	2.7	8.8	13.8	19.8	24.8	30.9	35.9	41.9
	44 -	20.7	20.7	20.7	10.0	1 1		2.5		0.0	12.0	10.0	21.0	20.2	22.2	40.0
76	-41.7	-36.2	-30.8	-25.3	-19.9	-14.5	-/.9	-2.5	3.0	8.4	13.9	19.3	24.8	30.2	36.8	42.2
77	-417	-35.8	-31 1	-25.2	-19 2	-14 5	-8.6	-27	37	8.0	13.0	19.8	257	30.5	36.4	423
11	· <b>- 1</b> ./	55.0	51.1	23.2	17.4	17.5	0.0	-2-1	5.2	0.0	13.7	17.0	23.1	50.5	50.4	-4.5
78	-41.4	-36.3	-31.2	-24.8	-19.6	-15.8	-8.0	-2.9	2.2	8.7	13.8	20.2	25.4	30.5	36.9	42.1
70	. 12 2	_26.6	_21 1	_25.5	_10.0	_1/ 2	_2 7	27	21	80	12.6	10.2	210	30.2	35.0	11 5
17	-42.2	-50.0	-51.1	-25.5	-17.7	-14.3	-0.7	-3.2	2.4	0.0	15.0	17.4	24.0	50.5	55.9	<b>T1.</b> J
80	-41.3	-36.8	-30.7	-24.6	-20.1	-14.0	-8.0	-3.4	2.6	8.7	13.2	19.3	25.4	31.4	36.0	42.0
01	41.6	266	20.0	25.1	20.2	12 (	07	2.1	20	7.0	144	10.2	25.0	20.0	25 0	12.4
81	-41.0	-30.0	-30.0	-23.1	-20.2	-13.0	-ð./	-2.1	2.9	1.8	14.4	19.5	23.9	50.8	33.8	42.4
82	-41.6	-36.2	-30.8	-25.5	-21.9	-14.8	-7.6	-2.3	3.1	8.5	13.8	19.2	24.5	29.9	37.1	42.4
02	41.0	25.4	21.5	25.5	10.0	14.4	0.0	2.5	2.1	0.0	12.1	10.0	24.7	20.5	26.4	42.2
83	-41.2	-35.4	-31.5	-25.7	-19.9	-14.1	-8.3	-2.4	3.4	9.2	13.1	18.9	24.7	30.5	36.4	42.2
84	-42.7	-364	-30.0	-25.8	-19 5	-13.2	-9.0	-2.7	3.7	7.9	14.2	20.5	24.7	31.1	37.4	41.6
0.5	12.7	20.7	20.0	20.0	17.5	1.2.2		2.7			10.1	20.5		21.1	01.7	
*5	-41.8	-51.2	-30.3	-28.0	-18.9	-14.3	-1.5	-2.9	1.7	8.6	13.1	20.0	24.6	31.4	36.0	42.9

86	-42.9	-35.4	-30.5	-25.5	-20.5	-13.1	-8.1	-3.1	1.8	9.3	14.3	19.2	24.2	31.6	36.6	41.6
87	-41.2	-35.8	-33.1	-25.0	-19.6	-14.2	-8.8	-3.4	2.0	7.4	12.8	20.9	26.3	31.7	37.1	42.5
88	-41.8	-35.9	-30.1	-24.2	-18.3	-15.4	-9.6	-3.7	2.2	8.0	13.9	19.7	25.6	31.5	37.3	43.2
89	-42.2	-39.0	-29.5	-26.3	-19.9	-13.6	-7.2	-4.0	2.4	8.7	15.1	18.3	24.6	31.0	37.3	40.5
90	-42.3	-35.4	-32.0	-25.1	-18.2	-14.7	-7.8	-4.4	2.6	9.5	12.9	19.8	26.7	30.2	37.1	40.5
91	-46.0	-34.7	-31.0	-23.5	-19.7	-12.2	-8.5	-1.0	2.8	6.5	14.0	17.8	25.3	29.0	36.5	40.3
92	-41.8	-37.7	-29.6	-25.5	-21.4	-13.3	-9.2	-1.1	3.0	7.1	15.2	19.3	23.4	31.5	35.6	43.7
93	-40.9	-36.5	-32.1	-23.3	-18.8	-14.4	-10.0	-1.2	3.3	7.7	12.1	21.0	25.4	29.8	34.2	43.1
94	-39.7	-34.9	-30.1	-25.3	-20.5	-15.7	-6.1	-1.3	3.5	8.3	13.1	17.9	27.5	32.3	37.2	42.0
95	-43.1	-37.8	-32.6	-27.4	-17.0	-11.8	-6.6	-1.4	3.9	9.1	14.3	19.5	24.7	29.9	35.1	40.3

Table 2: continued

# 6 Azimuth table.

Azimuth table (file "AzimTable.txt") shows central directions of each azimuthal sector  $\Phi(AzIndex)$ . This table also shown in Table 3. Angles in degrees are counted from  $X_{SC}$  to  $Z_{SC}$ . here  $XYZ_{SC}$  are Venus Express spacecraft axis.

Table 3: VEX IMA Azimuthal table, V.1.0, 20 Jan 2006

0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
78.8	56.3	33.8	11.3	348.8	326.3	303.8	281.3	258.8	236.3	213.8	191.3	168.8	146.3	123.8	101.3

Thus the unit vector corresponding to the central direction of the azimuthal sector if  $\Theta = 0$  $XY_{sect}(AzIndex)$  is:

$$X_{sect} = cos(\Phi(AzIndex))$$
$$Z_{sect} = sin(\Phi(AzIndex))$$

And the unit vector corresponding to the **real** direction of the corresponding sector XYZ(AzIndex, EnIndex, ElIndex) is:

$$\begin{split} X &= cos(\Phi(AzIndex)) \cdot cos(\Theta(EnIndex,ElIndex)) \\ Y &= sin(\Theta(EnIndex,ElIndex)) \\ Z &= sin(\Phi(AzIndex)) \cdot cos(\Theta(EnIndex,ElIndex)) \end{split}$$

### 7 Mass table.



Figure 2: Definition of Rm and Dm values.

Ions of the given mass and the given energy creates a Gaussian peak distributed along the radius of the azimuthal sector of the instrument. Figure 2 clarifies this statement and defines the properties

of the mass peak. The figure shows one column of IMA\_Image corresponding to fixed AzIndex. Counts are distributed around central position Rm as follows:

$$Counts(RmIndex) = Cmax \cdot e^{-0.5\frac{(RmIndex-Rm)^2}{Dm^2}}$$

Here Cmax is the counts at the Rm point, and Dm represents a width of the distribution.

PaccIndex	Pacc, V	#	GfitP	GfitD	Kpacc	Kmass
0	39.	0	-2.95160	-0.02483	1.00000	-0.59430
0	39.	1	2.17791	0.32915	-0.00000	1.42718
0	39.	2	-0.00941	-0.01229	0.00000	-0.01472
3	1902.	0	-4.51042	0.85391	0.96520	0.00000
3	1902.	1	2.50365	0.29801	0.12167	1.00000
3	1902.	2	-0.02667	-0.01468	-0.08778	-0.00000
6	3615.	0	-7.25836	0.86668	0.77036	-0.11609
6	3615.	1	2.88211	0.27801	0.51016	1.09303
6	3615.	2	-0.04061	-0.01184	-0.28072	-0.01449

Table 4: VEX IMA Mass table, V.1.0, 20 Jan 2006

Table 4 and corresponding file "MassTable.txt" provide information of about Rm and Dm as functions of PaccIndex and EnIndex. PaccIndex is an internal IMA constant defined by telecommand. (See section IMA Telemetry Format). PaccIndex can be 0, 1,... 7. But calibration information exists for PaccIndex = 0, 3, 6 only. Rm and Dm are calculated as follows (PI = PaccIndex):

$$\begin{split} M_{eff} &= Kmass_0(PI) + Kmass_1(PI) \cdot M/Q + Kmass_2(PI) \cdot (M/Q)^2 \\ Pacc_{eff} &= Pacc(PI) \cdot (Kpacc_0(PI) + Kpacc_1(PI)/M_{eff} + Kpacc_2(PI)/M_{eff}^2) \\ G_{eff} &= 10^3/\sqrt{(E/Q(EnIndex) + Pacc_{eff}) \cdot M_{eff}} \\ Rm &= GfitP_0(PI) + GfitP_1(PI) \cdot G_{eff} + GfitP_2(PI) \cdot G_{eff}^2 \\ Dm &= GfitD_0(PI) + GfitD_1(PI) \cdot G_{eff} + GfitD_2(PI) \cdot G_{eff}^2 \end{split}$$

Here M/Q is Mass per a Charge of the ion (1 for  $H^+$ , and 44 for  $C0_2^+$  for instance), and E/Q(EnIndex) is an Energy per Charge of the ion (see Energy table section).

### 8 Common NetCDF file.

You can find all information described above in the common file **ima\_info.nc**. This file is written in NetCDF standard. Format of this file is the same for IMA MEX and IMA VEX. One can found NetCDF standard in http://www.unidata.ucar.edu/software/netcdf/. IDL provides a set of functions to manipulate with NetCDF files. The header of **ima\_info.nc** is as follows:

```
netcdf ima_info {
  dimensions:
      ImaModeDim = 40 ;
      ImaParDim = 4 ;
      ImaEnerDim = 96 ;
      ImaElevDim = 16 ;
      ImaAzimDim = 16 ;
      ImaAzimSize = 2 ;
      ImaPacDim = 8 ;
```

```
ImaKFSize = 4 ;
        ImaKFN = 4;
variables:
        short ImaModes(ImaModeDim, ImaParDim);
        float ImaEner(ImaEnerDim) ;
        float ImaElev(ImaEnerDim, ImaElevDim);
        float ImaAzim(ImaAzimDim, ImaAzimSize);
        float ImaMassKF(ImaPacDim, ImaKFN, ImaKFSize);
// global attributes:
                :DateOfCreation = "Fri.Jan.20.2006" ;
                :Mission = "VEX" ;
                :Experiment = "ASPERA-4" ;
                :Instrument = "IMA" ;
                :EnVersion = "1.0";
                :ElVersion = "2.0";
                :AzVersion = "1.0";
                :MassVersion = "1.0";
                :ProgVersion = "6.1";
                :Program = "ima_info.pro";
                :Author = "Fedorov" ;
```

Names of arrays in this file are self described. Contents of each array is as follows:

- 1. Each line of **ImaModes**, corresponding to fixed telemetry mode (see **Operational Modes** section) is: *TRmIndex* size, *TAzIndex* size, *TEnIndex* size, *TElIndex* size.
- 2. Format of ImaEner array is obvious.
- 3. ImaElev gives the  $Y = sin(\Theta(EnIndex, ElIndex))$  values. Value "-1000.0" means that this point is skipped in the telemetry array.
- 4. ImaElev contains  $X_{sect}$  and  $Z_{sect}$ .
- 5. Each line of **ImaMassKF** corresponding to fixed PaccIndex = ImaPacDim and fixed ImaKFN is Pacc,  $A_0$ ,  $A_1$ ,  $A_2$ . For ImaKFN = 0, A = GfitP, for ImaKFN = 1, A = GfitD, for ImaKFN = 2, A = Kpacc, and for ImaKFN = 3, A = Kmass.